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Highlights

Cover: Architecture is key in 32-bit mini, 98
The 32-bit VAX-11 minicomputer family maintains compatibility with PDP-11 software, yet reflects future needs in such features as a 4-gigabyte virtual address space. Its architecture achieves both of these goals.

Cover is by Don Carroll.

Help wanted in California, please, 52
The big electronics firms in southern California are going to unusual lengths to fill their demand for engineers, including higher salaries, cash bonuses, and other incentives.

Winchester-drive use grows, 90
Winchester disk-drive technology is spreading from mainframe computers to smaller systems. Makers of disk drives see the technology as a way of providing systems builders with eight times the storage capacity of cartridge drives.

C-MOS saves power in erasable PROM, 106
P-channel floating-gate complementary-metal-oxide-semiconductor technology gives a 4-K erasable programmable read-only memory its superior speed-power product. What's more, the new chip needs only a single-ended voltage supply.

Keep an eye on ICs' thermal resistance, 121
For the best possible performance, reliability and yield of integrated circuits, knowledge of thermal-design considerations, especially thermal resistance, is a must. Just as important is an appreciation of the measurement techniques available.

And in the next issue . . .
A hybrid isolation amplifier with a built-in flyback transformer . . . a proposed bus standard for microprocessors . . . software for the 8022 single-chip microcomputer.
While developing his story on the new consumer electronic telephones (p. 81), New York bureau manager Bruce LeBoss naturally took the opportunity to try the latest units soon to go on sale. The new generation is certainly different, Bruce relates.

"Actually all the new phones are feature-oriented, not just replacements for the traditional home instrument. One company, for instance, is selling the sound. Instead of a nerve-jangling ring, this one has a pleasant warble."

The main interest is in what the new phones can do that the traditional instrument can’t. Yet the new models do not appear too complicated for consumers despite the raft of features tucked inside. "People are used to keyboards, programming, and digital displays from previously accepted products such as calculators and digital watches," Bruce says. "But, unlike the calculators and watches, there doesn’t seem to be much possibility that cheap and dirty telephones will be introduced, because they have to meet performance standards in order to be compatible with the telephone systems."

Among the various features offered, the one that attracted Bruce was the ability to program the length of calls and disconnect at the end of the time limit. "For people with teen-aged kids or other long-winded relatives, it’s nice to be able to cut them off," he chuckles.

Some designers are already beginning to think up new ones for the telephone. It will soon be possible for a consumer to call his or her own phone and turn on household accessories, such as air conditioners or ranges, before returning. Another plan calls for turning the telephone into a security alarm capable of processing information from smoke detectors or intrusion sensors and automatically placing a special alarm call to the fire or police station.

The possible investment by the United Kingdom’s National Enterprise Board in a new semiconductor production venture has caused mixed feelings in England, as London bureau manager Kevin Smith reports on page 86. Both supporters and critics agree that the project is risky. But, as Kevin says, the British semiconductor industry has a strong position in electron-beam technology, which would put any new government-sponsored firm into a keen competitive position.

"The key words mentioned in all the talk about the project have been electron-beam technology," he says. "It’s the one point that fits the UK strategy of leaping past the Japanese and U.S. companies going into 64-k random-access memories."

In contrast to the total cooperation that the Japanese government has been able to obtain in its semiconductor and computer-development projects, not everyone in Great Britain supports this scheme. Essentially, a main criticism is that such a project would have to attract a talented engineering and marketing team and this type of talent is in short supply these days—not only in England, but worldwide.
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Readers' comments

Taking account of counters

To the Editor: I would like to add that solutions to some of the problems mentioned in van der Windt and Ericsson's otherwise fine article ["Making accurate measurements with counters and timers," March 30, p. 83] do exist and have been implemented successfully.

The article stated a requirement that the repetition rate in a time-interval average measurement must not be synchronous with the internal clock. This restriction is eliminated either by using a random phase-modulated time-base clock, as in our HP5345 and HP5328 counters, or by interpolation, as in our HP5360 and HP5370 units.

The article also stated that the resolution of a one-shot time-interval counter is limited by the counter's clock frequency. This statement does not apply to a whole class of interpolating counters such as the El Dorado 796 and 797, Digitec 8330, and our own HP5360 and 5370 counters, to mention just a few.

The one-shot resolution of all these counters is 1 nanosecond or better. None employs a clock faster than 200 megahertz, and some use one as low as 10 MHz. Clearly, the resolution of an interpolating counter is not limited by the internal clock period.

The problem of frequency-resolution loss due to prescaling is overcome by the class of reciprocal-taking counters that measure time for a number of events. A counter that is both interpolating and reciprocal-taking enjoys freedom from both types of limitations mentioned.

David C. Chu
Hewlett Packard Co.
Santa Clara, Calif.

Them that knows, knows

To the Editor: The use of k and K [to stand for 1,000 and 1,024, respectively—Publisher's Letter, March 30, p. 6] is a virtually meaningless differentiation. People in the field know about the extra bits, outsiders don't need to know, and present usage is handy.

M. Coyle
Deer Park, N. Y.
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Get full details on Challenger 200 from your local Kasper office. Or write Kasper Instruments, 749 North Mary, Sunnyvale, California 94086, (408) 733-9800.
News update

A tactical air reconnaissance pod system mounted beneath a Grumman F-14 Tomcat is in flight tests at the Naval Air Test Center at Patuxent River, Md. The tests of the 17-foot-long Tarps, as it is called, are part of a program calling for the modification of about 50 F-14s to accommodate the pod [Electronics, Aug. 18, 1977, p. 36], thus converting the Tomcats into RF-14 reconnaissance aircraft.

According to John Michel, Grumman Aerospace Corp.'s Tarps program manager, three craft have been modified thus far to accept the 1,550-pound pod with a fourth scheduled for this month. Tarps carries three cameras and was developed by the Naval Air Development Center at Johnsville, Pa. The service expects to begin technical evaluation of Tarps within a few days and conclude flight tests in November. Michel estimates the total value of Grumman's F-14 Tarps contract at $20 million to $30 million.

The U.S. Army's Communications and Electronics Material Readiness Command at Fort Monmouth, N.J., has awarded a $361,000-plus contract to International Telephone & Telegraph Corp.'s Electro-Optical Products division in Roanoke, Va., calling for the design and development of ultralow-loss optical-fiber cable assemblies. The development is considered a highly significant step toward the Army's target of replacing copper wires with optical fibers for tactical communications systems by the mid 1980s [Electronics, March 3, 1977, p. 65].

The 27-month contract is to result in 1-kilometer cable assemblies, including connectors, each enveloping six optical fibers. Losses are to be no greater than 6 decibels/km, and repeatable insertion losses for the six-fiber connector are to be held to 1 db or less per connection. The program supplements the Army's plans to award a contract for manufacturing methods and technology for optical-fiber cable assemblies to be used in long-haul communications systems.

Bruce LeBoss

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Electronics / July 6, 1978
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People

Goldman looks to Austin as microcomputer capital

It was probably no accident that Motorola Inc. picked production expert Murray A. Goldman to be its new group operations manager for microcomponents. Goldman, who joined Motorola in 1969, had for the past two years been in charge of manufacturing at the integrated-circuit division's metal-oxide-semiconductor production plant in Austin, Texas. It is under his guidance that Motorola is beginning to churn out the microprocessor parts it is committed to deliver in the tens of millions yearly by the early 1980s to the auto companies and others.

"There is no question that we can meet the [production] demands of the future," says the soft-spoken electrical engineering Ph.D. On July 1, he took over from Colin Crook, who resigned to return to his native England as managing director of Rank-Xerox Precision Industries Ltd.

But as he views his expanded responsibilities, which now include design and marketing, as well as manufacturing, he appears most excited about Motorola's design capabilities. He predicts that Austin will become the microcomputer capital of the world, and that will not be because of numbers of circuits alone.

"Our design group gives us the edge with chips like the 6801 and 6809," he says, referring to two of Motorola's newest products in its 6800 microprocessor family, scheduled to be available in sample quantities during the third quarter of the year. "The 6801 is a third-generation one-chip microcomputer—better performing than the 6800 and not a degradation like Intel's 8048 is to its 8080. The 6809 is a souped-up version of the 6800. Over 20 address modes and the features of a 16-bit microcomputer will make it the most powerful 8-bit microprocessor ever conceived." The real plus, he adds, is that both parts will run 6800 software, something other expansions of basic families cannot do.

Avnet rewards O'Melveny's success with microprocessors

He led Hamilton/Avnet Electronics into the brave new world of microprocessors two years ago when many questioned whether distributors could sell the sophisticated devices. But Richard O'Melveny sold them like crazy, with the result that the Culver City, Calif., division of Avnet Inc. is looking toward $150 million in microprocessor sales by the early 1980s. Moreover, O'Melveny, 42, has a promotion from director of microcomputers to vice president and director of microcomputer marketing.

Despite the mystique that seemed to surround them, O'Melveny saw microprocessors from the start as "essentially a commodity just like other components that a customer wants right now." If there is a single secret to selling microcomputers, he believes it lies with the development system required to write software and debug the design. Early on, he realized an MDS "is a design tool on which the business depends, not an end sales item in itself." Though most engineers understand this, their management may not and "we have to help him convince his boss to spend the $12,000 or so."

And O'Melveny, with six years at Hamilton/Avnet following five years at a competitive distributor, had to convince his bosses to install a demonstration center at each of 36
What a combination! The new S2114 VRAM takes only 50 milliamperes to zip along at 150 nanoseconds. The secret is our patented VMOS technology, created to achieve the industry's best speed/power ratio. Low dissipation reduces your power supply and cooling needs. That means lower system costs and better performance. It's no surprise that this winning combination comes from AMI. Ever since we mass-produced the first MOS back in 1966, we've been coming up with new ways to solve your system problems. Check out our S2114 VRAM at your nearest AMI distributor. The quicker, the better!

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<tbody>
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<td>150 ns</td>
<td>S2114A-1</td>
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<td>S2114-1</td>
</tr>
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<td>200 ns</td>
<td>S2114A-2</td>
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<td>S2114A-3</td>
<td>S2114L-3</td>
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For even faster buffer and cache memory applications, watch for our 70 nanosecond 1K x 4 S2114H, coming in September.

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It's easy to provide manufacturing with a test routine — just record it on tape with DTO-1.

Then technicians simply follow the established test sequence during product checkout. DTO-1's powerful microprocessor compares logic traces with recorded reference traces and activates a "pass" or "fail" light on the probe.

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People

Distributor. Richard O'Melveny is doing nicely with microprocessors as commodities.

locations, complete with an applications engineer and substantial inventory that includes most microcomputer lines. The investment reached multimillion-dollar levels.

Two kinds. Typically, two kinds of engineer-customers come in to the demonstration centers to buy a microcomputer. "One guy walks in with a bias for a particular computer, and then it's a matter of servicing him," says O'Melveny. "But the other one expects to buy it for about $9.90 because of some of the ads. We have to educate him with a learning tool, a microcomputer kit."

He is also surprised that many engineers "are not that aware of board microcomputers; they're ready to design with chips." So the first question his people ask is: "board or chip level?" Then the explanations start.

Concerning the oft-proclaimed microcomputer software bottleneck, O'Melveny sees "the void being rapidly filled." For overall operating software, or firmware, manufacturers are coming on strong, he says, while engineers themselves are doing their own application packages.

Has learning about microcomputers been a perplexing process for veteran design engineers? O'Melveny thinks not. "The individual engineer is coping very nicely," he says. "He is highly motivated and searching for information and alternatives, rather than simply for help in design."
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HMOS, our new memory technology, is the key. Its active speed/power product is just one fourth that of previous processes. So while maintaining the highest performance in its class, the 2141 operates with as little as 40 mA. And automatic power down on deselection cuts standby power to 5 mA. In larger systems, where most devices are deselected at any given time, the combined power savings can reach 90% or more over other fully static 4K x 1 RAMs. That cuts cooling and power supply costs dramatically.

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Both the 2141 and 2147 follow the industry standard 4096 x 1 bit, 18-pin pinout, and can replace conventional 4K static RAMs in both clocked and unclocked systems. Both 2141 and 2147 are directly TTL compatible in all respects: inputs, output and operation from a single +5V supply. And both parts deliver the inherent reliability of HMOS. They've already achieved the same dependability as the 2102A.

For a copy of our HMOS reliability report and data sheets, write Intel, Literature Dept., 3065 Bowers Avenue, Santa Clara, CA 95051.

The 2141 is in production and available now. You can order directly from your distributor, or from your local Intel sales office. Just ask for the new 4K static RAM with everything on it.

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What the learning curve has done for Mostek's 16K RAM.

I. Availability
Production volumes are proving the learning curve again. Mostek has been manufacturing the MK 4116 16K RAM longer than any other supplier. During the first quarter of 1978 we delivered more 16K RAMs than we shipped in all of 1977. Our goal for 1978 is to deliver more than 5 million. With this increasing production momentum, Mostek is quickly solving the industry shortage of 16K RAMs.

2. Performance

Mostek's 4116 has always been the industry standard 16K RAM. Eleven companies have announced intentions to second-source our design, but no one has yet matched Mostek's performance or features.

There are several new features in Mostek 16K RAMs. For flexibility in system design, $V_{BB}$ power supply now operates over the range of $-4.5$ volts to $-5.7$ volts allowing $-5V$ operation with TTL or $-5.2V$ operation with ECL systems. In addition, cycle time has been reduced to 320ns for the 4116-2, improving system operating performance.

3. Reliability

Both the learning curve and our Poly-II™ process are key factors in Mostek's 16K RAM reliability record. Over 12 million circuits have been built using the Poly-II™ and Poly-11 processes. During this time, quality and reliability standards have continued to lead the industry.

Comprehensive performance and environmental testing further ensure reliability in your system. Every 16K RAM we ship is thoroughly tested to rigorous screens and stresses.

Take advantage of Mostek's industry standard performance and reliability now. Call or write: Mostek, 1215 West Crosby Road, Carrollton, Texas 75006; Telephone 214/242-0444. In Europe, contact Mostek GmbH, West Germany; Telephone (49) (0711) 701045.

Circle 23 on reader service card

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Sound and fury of a new product

They’re getting excited again. The people who brought us the portable radio and stereophonic sound and those who gave the world the computer on a board are about to combine for another one of those electronic marvels that periodically have market research people dancing with optimism.

What’s got them going this time is a-m stereo broadcasting (see p. 88). The Federal Communications Commission is inching toward a decision on which of five proposed transmission systems will be selected as the official standard, a flat that could come as early as January of next year. Meanwhile, the makers of radios and of the integrated circuits that will go into them are beating their drums for the new medium.

A-m stereo should turn up first on the highway, with auto makers including sets in their cars and ads, probably by the 1980s. No doubt Detroit is drooling at the prospect of being able to dangle such jewels as lower price and longer range than fm stereo before car buyers’ eyes. After all, in a time of smaller, lighter, less powerful cars, accessories are the green in the bottom line.

After automobiles, the market target will be the American home. In short, what we have here is a can’t-miss product...

But maybe not. A lot of money and effort will go into building and promoting a-m stereo; the technology is sound; and the results should be good. Still, it would be well for the makers of ics and sets and speakers to consider the software.

Has anyone out there tuned in to the average am radio station lately? The overlooked factor in the demand-supply equation might just turn out to be the low intensity of the average consumer’s desire to listen to the Top 40 songs coming from twice as many speakers, and to the roaring machine-gun delivery of the deejays.

The equipment makers ought to think hard about faddism and quick but short-term growth—most recently, the citizens’ band radio boom and bust—before they commit too much time and money to this latest technological marvel.

The right number

Another convenience product spawned by electronic technology, helped along by the Supreme Court, is the feature-laden electronic telephone (see p. 81). Now that the high court has ruled that privately owned instruments may indeed be connected to Ma Bell’s network, a host of companies is busily adding features like memory, calculator capability, and digital timepieces to another endangered species: the plain black telephone.

The new phones make available to the consumer market some of the data-based capabilities of the business phone. Moreover, the price is relatively reasonable and undoubtedly will come down as sales and manufacturing expertise grow.

This new consumer item does make sense. Although it’s hard to tell if anyone really wants to look at the phone to see what time it is or use it to do algebra homework, some of the instrument’s other newfound intelligence might be put to good work. Having a phone at home that remembers the numbers one dials most often is a swell idea. So is having the phone remember the last number dialed, so that the caller may just punch a button to try again after getting a busy signal.

Such phones should find a receptive market. Doubt that? Well, consider the fact that Bell will probably be out with its own version next year. This just could be an idea whose time has come.
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Another breakthrough in cooling extrusion size and cost.

Here is the latest of the "High Fin Density" extrusions from EG&G Wakefield Engineering. Extrusion 5206 is the smallest and most economical of these remarkable cooling devices to be announced thus far. With a price of only $1.00 per inch, this unit is less than half the price of competitive types with the same cooling capacity.

The skyrocketing cost of aluminum is creating a real need for a more efficient extrusion design. That's why Wakefield developed "High Fin Density" extrusions. By reducing the space between fins to as little as 1/10 their height, these revolutionary units have double the cooling efficiency of competitive types using substantially more aluminum.

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Circle 26 on reader service card

Meetings

Fiber Optic Con West, Fiber Optic Communication and Information Society (Boston), San Jose Convention Center, San Jose, Calif., July 19–20.


Wescon/78 Show and Convention, Electronic Conventions Inc. (El Segundo, Calif.), Los Angeles Convention Center, Sept. 12–14.

Sixth Computer-Aided Design and Computer-Aided Manufacturing Conference and Exhibition (CAD/CAM VI), Society of Manufacturing Engineers (Detroit), Hyatt House, Los Angeles, Calif., Sept. 19–21.


Convergence 78—International Conference on Automotive Electronics, Society of Automotive Engineers (Warrendale, Pa.), Hyatt Regency Hotel, Dearborn, Mich., Sept. 25–27.
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Intel introduces the 16-bit evolution of our 8080 and 8085.
From CPU to software,
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8086 is an architectural triumph, etched in HMOS. The standard 8086 delivers 5 MHz speed. And it delivers direct addressability to a full megabyte of memory, with both 8-bit and 16-bit signed or unsigned multiply and divide in hardware. It gives you efficient byte-string operations and improved bit manipulation. Plus it provides capabilities never before supported by a microprocessor, such as dynamic relocation, reentrant code, position-independent programs and instruction look-ahead.

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Electronics / July 6, 1978
HP adds systems to both ends of computer line

A high-end minicomputer, the model HP 3000 series III, and a low-end, floppy-disk—based computer for small businesses, the HP-250, promise to broaden the customer base and performance range of Hewlett-Packard Co.'s flourishing computer family. The new 3000 ranges in price from $115,000 to $175,000 and has quadrupled the memory capacity, twice the throughput, and improved on-line business-transaction processing power compared with the HP 3000 Series II. Moreover, the cost of memory has dropped, allowing HP to supply a megabyte of error-correcting memory for $32,000, or 3.1 cents per byte, according to William Krause, marketing manager at the Santa Clara, Calif., General Systems division. The Fort Collins, Colo., division is the source for the under-$25,000 HP-250. Hardware includes keyboard, cathode-ray-tube display, 128 kilobytes of system memory, 32 kilobytes of user memory, two 1.2-megabyte floppy drives, and a 180-character-per-second impact printer.

IBM scientists report observation of 'light bubbles'

Mobile “light bubbles,” which appear to be electrical analogs to magnetic bubbles, have been generated in magnesium-doped zinc-sulfide thin films, IBM scientists reported at the Electronic Materials Conference in Santa Barbara, Calif. The 1-µm bubbles appear when 10-kHz, 190-v ac current is applied to the film via sets of parallel 1-mm-wide metallic lines orthogonally placed on each side of the film. When voltage is applied to a pair of intersected electrodes, the intersected area will emit light bubbles that appear to move in discrete steps—and move faster when the frequency rises to 50 kHz. The alternating-current thin-film electroluminescence, or actel, lasts as long as an hour and can be used to form images on the film by stimulating different areas with light or an electron beam or by applying voltages across the film. However, before the technique becomes practical, much work needs to be done to direct the bubbles.

TI comes up with fully static 16-K memory

Texas Instruments Inc. says it has developed the random-access memory that microprocessor-system designers dream of—fully static 2,048-by-8-bit RAM that is pin-compatible with 16-K erasable programmable read-only memories like TI's 2516 or single-supply 2716. The 150-ns RAM, which the firm's Houston operation will have available in sample numbers in September, allows designers to partition storage in microprocessor systems any way they would like between fixed and read/write memory. The package has the same Jede-proposed standard 24-pin configuration as the single-supply 16-K electrically programmable ROMs. What's more, the die is super-small: 1.6 mil² per cell.

4-bit processors still doing job for TI, Rockwell

All the talk these days may be in 16-bit words, but the truly pervasive microprocessor uses a 4-bit length. Business has never been better for Texas Instruments Inc.'s TMS1000 and Rockwell International Corp.'s PPS-4 lines, the manufacturers report, and each is continuing to expand. Dallas-based TI has begun building the parts with complementary-MOS logic, which gets the power consumption down to 10 mw. Rockwell is sticking with p-channel MOS and is now using a design scheme that powers down most of the chip so that average dissipation is less than 20 mw. The Anaheim, Calif., company's edge for low-power use, it says, is its processor's wide supply-voltage range, specified at 6.5 to 11 v (versus 3 to 6 v for TI's part) that lets the PPS-4 work with standard 9-v batteries.
**Electronics newsletter**

**Rf circuit on one chip due from TRW**

A single chip that replaces discrete and hybrid components in radio-frequency circuits and equipment is now in sight, according to officials at TRW Inc.'s Microelectronics center, Redondo Beach, Calif. The technology for integrating these analog and rf functions into monolithic form is an Isoplanar variation of high-density bipolar, and the resulting device is called an oxide-aligned transistor. Scheduled for completion late this year, the preliminary demonstration chip uses silicon and operates in the 0.1-to-2 GHz range. Primary target for the circuit is the low-cost receiver required by users of the global positioning satellite. The TRW unit hopes to have one working in two years.

**Help-wanted index hits all-time high**

Demand for technical personnel, as reflected in the Engineer/Scientist Demand Index compiled by consulting firm Deutsch, Shea and Evans Inc. of New York, hit an all-time high of 222.6 in April, surpassing the previous one-month high of 219.0 reached in May 1966. What's more, the average index through the first four months of this year stands at 186.5 and the firm expects the index for all of 1978 to approach, if not surpass, the all-time high annual average of 190.3 achieved in 1966. Although the index covers engineers and scientists in all disciplines, company officials note that it "is very heavily oriented toward the electronics industries, with particular emphasis on microprocessor applications."

**Demise of 400 opens door to other vendors**

The recent decision by Xerox Corp.'s subsidiary, Diablo Systems Inc., to cancel its Series 400 disk drive opens the door to other disk-drive makers that have combination fixed and removable media drives aimed at the capacity gap between the traditional cartridge drives and the larger mainframe units. Introduced in December 1975, the Diablo 400 promised capacities ranging from 13 to 52 megabytes and used a unique inertial actuator mechanism. But Xerox claims the actuator's technical design "proved unfeasible for manufacturing in high volumes."

**New satellites seen triggering change in data distribution**

Though they are years away, there will be changes in the way communications common carriers distribute data-processing power. That is the view of Cambridge, Mass., consultant Arthur D. Little Co., which says the high-frequency satellites proposed by Satellite Business Systems Inc. will have that big an impact. The broad-bandwidth, simultaneous reception provided by the new birds will cause changes in message routing and data-base distribution procedures so that regional centers will be able to serve many local data bases.

**Addenda**

David L. Britton has resigned as president of International Memories Inc. of Santa Clara, Calif., in what is believed to be an internal dispute rather than pressure from 3M Corp., which recently purchased a minority interest in the disk-drive company. Loral Electronic Systems in Yonkers, N. Y., has beaten out Cutler-Hammer Inc.'s Air division in Deer Park, N. Y., for a $2 million contract in the Navy's Compass Sail Clockwise program to provide advanced radar warning receivers for A-7E, A-4, F-4, and F-14 aircraft. The American Electronics Association, which has 975 active members and 200 associates, sees a trend toward more mergers as it counts 40 involving member companies, almost all this year.
Most 2114s are new products with new product problems. Not ours. The SEMI 2114 is a member of the Royal Family of Static RAMs. It is, in fact, a new pin-out of an 18-pin, 5V, 1Kx4 static RAM that we've been delivering in production quantities for a year and a half.

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Electronics / July 6, 1978
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Laser diode operating in single mode yields broad linear output

Mitsubishi produces linear characteristic by holding active region to tiny area in double heterojunction unit.

The Japanese have developed the first laser diode to operate with a single-mode output. This permits modulation over a wide signal-amplitude range.

Also, the small size of the light source produces a narrow spectrum that allows data-transfer rates on the order of gigabits, potentially boosting the efficiency of fiber-optic communications systems. Any non-linearity at the output is due only to the laser driving circuitry and is independent of diode characteristics.

The semiconductor laboratory of Mitsubishi Electric Corp. developed the diode, which its semiconductor manufacturing department in Itami is making available this month in sample quantities. Price is high—between $976 and $1,463, depending on the package. But once it is in mass production, the company says the price could drop to the point where the diode is feasible for fiber-optic communications systems and for video and audio disk players selling for about $500.

Conventional laser diodes now on the market produce an output that is linear with input forward current. But this linear range is much smaller than that of Mitsubishi's device because the output light switches between different types of transverse operating modes. This produces "kinks" in the output radiation characteristic, as shown in the figure.

Mitsubishi eliminates the kinks by constraining the area in which the diode lases. Instead of lasing along the entire gallium-arsenide "sandwich filling," the diode is active in a much smaller region—the area of a p-type stripe that is only 2 micrometers wide and 0.3 \( \mu m \) high. The electromagnetic field here is such that the laser operates in only a single transverse mode.

**Sandwich.** The Japanese build their device around a double heterojunction sandwich, with all n-type doping consisting of gallium aluminum arsenide, gallium arsenide, and gallium aluminum arsenide again. The sandwich is implanted in a semi-insulating GaAs substrate that prevents current flowing vertically. A self-aligned diffusion process produces a narrow stripe with a lasing p region whose width is equal to the diffusion length of minority carriers from the n region. Recombination of carriers in the p region causes it to

---

**Diode.** Active region in the laser diode from Mitsubishi (a) lies in the GaAs "filling" of the sandwich formed by the two GaAlAs "bread" layers. Lasing occurs in the striped p region lying between p+, material to its left and n material to its right. Radiated power is linear with the input forward current (b) over a much greater range than in a conventional diode, which has kinks in its output.
lase, according to the company.

The laser region is delineated by a masked p+ zinc diffusion downward from the upper surface and extending from one edge of the chip to the center. The boundary of the diffusion runs vertically through the double heterojunction structure and into the semi-insulating layer.

The next diffusion drive-in produces a p region 2µm ahead of the p+ region. Thus, the 0.3-µm-thick GaAs layer consists of p+ material followed by the 2-µm stripe of p material, followed by n material.

P-type gallium arsenide has a higher index of refraction than either the adjacent n or p+ types, as well as a higher index of refraction than the top and bottom layers. Therefore, the lasing is restricted by this optical waveguide effect to the 2-by-0.3µm p-type gallium-arsenide stripe. The optical waveguide is essentially cut off for higher-order transverse modes, effectively suppressing mode changes. Second- and third-order harmonics are 40 and 60 decibels down, respectively.

The beam emerging from this active area spreads about 12° in the direction along the wide part of the stripe. Spreading by diffraction in the perpendicular direction is 50°.

Contacts. The construction of the laser diode is completed with ohmic contacts between the upper GaAs and metal layers on the p+ and n sides. Current flows transversely, concentrating in the GaAs layer, because its forward junction voltage drop is about 1.4 volts, compared with about 1.8 V for GaAlAs layers.

Typical output is 3 milliwatts at 40 milliamperes operating current. The cutoff frequency is in excess of 2 gigahertz, permitting modulation at rates above 1 gigabit per second.

Mitsubishi engineers predict a lifetime for the device in excess of 100,000 hours, based on an initial 10,000 operating hours with negligible degradation. They point to the low zinc concentration in the critical optical waveguide region. This allows the zinc atoms to substitute fully for atoms in the gallium-arsenide lattice so that they do not migrate and cause problems.

The question is, however, can Bidfet circuits be made economically? TI says yes, even though it acknowledges that the process is a complicated one, with many more steps than any of the constituent processes alone. It is keeping details of the new process under wraps until the patents come through. It says only that the process is not expensive, that it can make fairly large die sizes, and that the devices will be used in many forthcoming products requiring high-voltage interfacing and large-scale integrated logic at low power.

Panels. But where are the panels? According to Ramesh L. Gidwani, linear marketing manager in the firm's Integrated Circuits division, Japan's Fujitsu Ltd. and Nippon Electric Co., and France's Thomson-CSF are the main manufacturers of the displays. U. S. suppliers are nil. Owens-Illinois Inc. developed a display but is no longer in the business. The display's developers have since left Owens-Illinois and are forming a company in the Toledo, Ohio, area called Electro Plasma Inc. to make the displays.

Despite the current lack of a U. S. supplier, TI is apparently anticipating rapid growth in, and eventual takeover of cathode-ray-tube displays by, plasma displays in data terminals. It is bullish on the new displays for obvious reasons. A plasma display, which gets its name from the ionized gas that causes illumination of phosphors on the screen, is flat; it requires no heater and thus draws little power; and it has no flicker, distortion, or fuzziness, since the dots that make up its images are electrically addressed and sharply defined. Adds Curran, "I've seen some gorgeous colors on developmental displays."

The chips are for use with ac plasma screens, rather than dc types. "Ac types will win out over dc," Curran says, "for two reasons: much lower power and an inherent memory." The memory means that only data that is changing need be sent to the screen—the last message on the screen remains there until it must be changed.
Word processing

Software era opens for office systems

Like manufacturers in the computer industry to which they are related, makers of word-processing equipment are slowing the pace of hardware innovation in favor of adding sophisticated software and communications options and improving the price/performance ratio of their product lines. This was the view at the International Word Processing Association's Syntopicans VI conference in Washington, D.C., last month.

The objective is to overcome sales resistance from potential customers who have hesitated to buy systems they perceived as too expensive, too difficult to understand and operate, and too inflexible.

"We're all reaching the critical mass as far as hardware is concerned," says one of the participants, Jack Gilmore, group product line manager for Digital Equipment Corp.'s word-processing computer systems in Merrimack, N. H. "It's becoming a question of features. Almost all those features are implemented in software, and most of us are hurrying to add new ones."

Many of the new software refinements are aimed at making the manipulation of text easier and doing away with the complex codes that earlier machines used, the vendors agree.

Ned Salisbury, marketing vice president at Chatsworth, Calif.-based Lexitron Corp., says, "Hardware is not the name of the game. It's becoming like computers—dependent on software. With software, you can add features for customers much more inexpensively than you could with new hardware."

Down in price. The System 5 introduced at the conference by Wang Laboratories, Lowell, Mass., typifies the improvements in price/performance ratios. Priced at $9,900 including cathode-ray-tube terminal, dual diskette drives, and a 40-character-per-second daisy-wheel printer, the System 5 comes in some $4,000 under the older System 10A, which it replaces.

As for communications hardware, most vendors today offer some type of link between their own systems, and in some cases to mainframe computers. For example, DEC's Gilmore reports, "Of the stand-alone word-processing stations we ship today, 60% have communications options."

These options are pointing toward the linking of word-processor stations to implement electronic mail systems. But the drawback is that few of the existing communications options can operate simultaneously with an operator entering or editing text. However, refined software that will allow concurrent communications is in the works and will be in the next wave of new-product announcements.

International Business Machines Corp., which started the word-processor ball game with its magnetic-card typewriters, agrees that communications is in the spotlight today—although it will not say how many of its systems are equipped with such features. "Communications accelerates and increases the productivity of the decision-making cycle," says Richard L. Bisk, product marketing manager for communications products at IBM's Office Products division, Franklin Lakes, N. J., who was also at the conference. "You don't lose as much time in the document-transfer process."

Packaging & production

Circuit devilry laid to "hook"

Any circuit designers out there ever bothered by the "hook" effect? You might have been and not even realized it if you have been working at frequencies up to about 10 kilohertz with high-impedance analog circuitry fabricated on epoxy-glass printed-circuit boards. It turns out that the boards may not be as stable as people think they are.

"Hook is the effect on a signal caused by a change in circuit-board capacitance with frequency," says Bill Mark, who is an instrument design specialist at Tektronix Inc., Beaverton, Ore. "It's particularly dangerous in high-impedance attenuators used in scopes and digital multimeters."

Distortion. Board capacitances may vary to the point where an attenuator fails to give an output truly

Cost trend. Part of the move in word processors toward lower-cost systems, Wang's new System 5 stand-alone, CRT-based work station is priced at $9,900, or $11,900 with printer.
proportional to input. In scopes that means, of course, distortion in the waveforms being displayed. Ideally, a square wave would have no undershoot or overshoot. But, as the hook effect increases, the square wave peaks at its leading and trailing edges. In DMMS, accuracy on ac measurements may fall outside of tolerance.

Mark discussed the hook phenomenon last month at the Institute of Printed Circuits' convention in London in a paper he co-authored with his Tektronix colleague, Wallace Doeling, and with Paul Reichenbacher and Thomas Tedwald of the Norplex division of UOP Inc., a leading supplier of pc-board laminates.

**Attenuators.** The hook effect is most apparent in attenuator circuits with resistors larger than 500 kilohms, when the board's capacitance is an appreciable portion of the total circuit capacitance and the accuracy of the circuit must be better than 2% to 5%, Mark says.

Attenuators are frequency-compensated high-impedance voltage dividers built up of discrete resistors and capacitors. The pc-board conductors that connect these discrete devices are separated by the dielectric of the laminate. The resulting unwanted capacitance shunts the attenuator, and this capacitance varies inversely with frequency, as shown in the diagram. Above 100 kHz, the circuit-board capacitance remains constant.

**Variation.** Unfortunately for pc-board users, hook percentage can vary from batch to batch of laminates. "We still don't know exactly what causes this effect, but we're starting to find out what aggravates it," says Reichenbacher, director of research and development for Norplex in La Crosse, Wis. The percentage of resin and the amount of moisture seem to be factors.

Tektronix has been aware of hook for several years, but only recently have ways to measure it accurately been developed and suppliers like Norplex agreed to supply low-hook materials, Mark says. To overcome it, the company uses special materials and construction methods for its attenuator boards. It also had to develop a simple and accurate method of measuring board capacitance, since conventional capacitance bridges are fixed-frequency devices and therefore unsuitable.

Tektronix now measures hook and circuit-board capacitance on its pc laminates with a charge-amplifier circuit. A charge amplifier is an operational amplifier with a low input-bias current that uses capacitors as feedback elements for setting amplifier gain. If the board capacitance acts as the input capacitor and the feedback capacitor is a high-quality device, then voltage gain is a function of the ratio of the two passive elements and the board capacitance can be measured over a range of frequencies.

In their paper, the authors offer some advice to circuit designers for minimizing hook. First, design the circuit and its layout to minimize the stray capacitance caused by circuit interconnects. If necessary, mount all critical components on Teflon standoffs. Also bake epoxy-glass material, like FR-4, at 325°F for 5 hours—insufficiently cured laminate can be noticeably hooky. Finally, ask the laminate vendor to agree to a capacitance specification.
If you want top performance and versatility in frequency analysis, take a look at the plug-in spectrum analyzers from Tektronix.

They cover the spectrum from 20 Hz audio, through television channels, all the way up to 60 GHz in the microwave band. You'll have a hard time finding that much talent anywhere else.

The microprocessor-aided controls of this 7L18 (1.5 GHz-60 GHz) make it easy to operate, plus you get digital storage and signal processing capabilities.

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matters even tougher is the size and complexity of what the Navy calls its new standard "single audio system," which meshes 108 shipboard phone lines into 66 radio trunk circuits at 7,128 duplex cross points.

**Something old.** The key to solving this potential crosstalk headache, it turns out, is an audio-multiplexer integrated-circuit chip employed in hybrid devices as a switching matrix. It was initially developed by Hughes Aircraft Co.'s Microelectronic Products division for simple audio switching in DC-10 and B-1 sound systems. But in 1976, Hughes dusted the chip off, improved it, and won the $1.6 million contract for the Navy's low-crosstalk system.

"The trick of doing a low-crosstalk system obviously is starting out with an intrinsically low-crosstalk audio-switching chip," says James L. Gundersen, senior scientist for microelectronic systems at the Newport Beach, Calif., Hughes division. He directed development of the audio-switching component. Low crosstalk was a secondary consideration in the earlier audio systems, he says, where the main goal was to reduce wiring.

Crosstalk reduction to about 100-dB isolation at 1 kHz in the B-1 was a byproduct. "We knew this could be reduced further by tweaking at the chip, hybrid, and card level."

The layout of functions on the chip separates high-level from low-level signals, which are susceptible to electrostatic coupling. High-level digital audio signals in the 10-volt range are routed on one side; low-level analog signals, down to 0.1-milliamperc, are on the other. "This virtually eliminates sneak crosstalk paths and noise coupling onto audio which are caused by device-to-substrate capacitance," Gundersen explains. Keeping device capacitances small also cuts audio signals on the substrate itself. Overall, the chip design gives control of coupling as small as about 3 by 10^-5 picofarad, he says.

**One on one.** The p-channel chip, 0.130 by 0.78 inch in size, acts as a six-position, double-throw switch. Each handles one phone line and six trunks in full-duplex mode, requiring about 50 milliwatts of power and dissipating 30 mw. Ten chips go into a 1.4-by-2.25-in. hybrid package, six of which are arrayed on a single circuit card. Overall, the Hughes switch consists of 24 cards mounted in a single cabinet, allowing some redundancy with 72 trunks.

Gundersen puts improvement achieved in crosstalk isolation at about 20 to 40 dB over the B-1 chip. "But the real significance is that at the same time we have increased the wiring complexity from the B-1's 10 lines and 30 trunks," he says.
Motorola's 8-bit, 10 ns video DAC explained:

Designed for application in high-speed instrumentation, communication and TV broadcasting, the MC10318 monolithic MECL\texttrademark DAC is—FAST. No other word describes operation at data rates above 25 MHz.

Inputs are compatible with MECL 10K series logic while the complementary current sink outputs feature current of up to 51 mA.

It’s accurate to eight bits (±1/2 LSB) and the outputs settle in typically less than 10 ns.

Availability's quick from stock, too, for things like CRT displays, storage oscilloscopes, radar signal conditioning and medical image processing. And you may not believe the price when we run it by you—$26, 100-999, which may slow down the $150-$250 hybrid joggies that have monopolized the market for too long.

Full scale current's 51 mA typical, output voltage compliance is -1.3 to 2.5 min/max and non-linearity's +0.19% maximum. The 16-pin ceramic package is standard.

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<tr>
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<tbody>
<tr>
<td>MC3410L</td>
<td>10-Bit D/A Converter</td>
<td>$7.95</td>
</tr>
<tr>
<td>DAC-08</td>
<td>8-Bit D/A Converter</td>
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</tr>
<tr>
<td>MC1408L</td>
<td>8-Bit D/A Converter</td>
<td>3.00</td>
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<tr>
<td>MC1403U</td>
<td>2.5 V Voltage Reference</td>
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<td>MC1404-5</td>
<td>5.0 V Voltage Reference</td>
<td>*</td>
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<tr>
<td>MC1404-10</td>
<td>10.0 V Voltage Reference</td>
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<tr>
<td>MC3417L</td>
<td>CVSD Voice Encoder/Decoder</td>
<td>6.95</td>
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components such as amorphous alloys and by implementing smaller radio-frequency-interference filters and substituting ceramic or film capacitors for electrolytes.

Severns admits that regulation at high frequencies is still a problem. But it is attainable, as witnessed by two production supplies developed for military application, he notes.

**Latching.** In the component arena, General Electric Co.'s Semiconductor Products department in Auburn, N.Y., is implementing what GE refers to as the latching transistor. Packaged in a TO-3 metal can, the device exhibits the high turn-on gain of the power Darlington and the high blocking voltage of the thyristor.

The G64LS is a four-layer (pnpn) 800-volt, 25-ampere switching transistor that latches on at 1 A of base drive. Turning the device off is accomplished by a negative base pulse capable of handling 25 A of collector current.

"An extra advantage that the device exhibits is that it can be turned off in the same manner as a gate-assisted thyristor—that is, by using a diode—to produce a turn-off time of 2 microseconds," claims Ralph Locker, consulting application engineer. "This is sufficiently short for operation in 20-kHz resonant power supplies."

He contends that the latching transistor is an economical replacement for the power Darlington transistor, with features of the asymmetrical thyristor. The part will be available in sample quantities in September, competitive with Darlontons in the $7-to-$10 price range for large orders.

**Switching vehicles.** Also discussed at the conference was a significant breakthrough toward fulfilling GE's Government contract for a prototype electric vehicle by May 1979—a new Darlington transistor capable of switching 400 V and 350 A on or off in less than 1 microsecond [Electronics, April 27, p. 51]. Unique to the device is the minimal 0.1-A turn-on current required.

The breakthrough is largely due to GE's proprietary fabrication of the transistor silicon chip in direct contact with the copper package, which is cooled from the top. The device is expected to play the key role in the regenerative braking system, which will recharge the prototype's lead-acid batteries.

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**Solid state**

**PAL bandwagon may be rolling**

A programmable device that reduces the hardware in the design of random-logic systems is stirring interest. Called the programmable array logic, or PAL, by its developer, Monolithic Memories Inc., Sunnyvale, Calif., the device has attracted a second source, Raytheon Corp.'s Semiconductor division. Moreover, two other sources are likely within a year, says John Birkner, the product planner responsible for the chip.

In addition, PAL's developers are getting a big boost from the two biggest names in programmer units for programmable read-only memories, Data I/O Corp. and Pro-Log Corp. PAL can be programmed much like PROMs, and these firms will support it with personality cards that plug into their own machines.

The PAL circuit configuration is a cross between a PROM and a field-programmable logic array (FPLA). It is designed to emulate all the logic functions of over 300 standard 54/74 series transistor-transistor-logic chips. According to how its fusible links are blown, it can shrink the chip count in a random-logic circuit by as much as a factor of four, Birkner says.

**15 members.** The PAL family consists of 15 bipolar products that are arrays of programmable AND and fixed OR gates. Nine are AND-OR gates arrays with different inputs and outputs; four have D flip-flops; and two, for rapid arithmetic operations, have exclusive-OR gates and registers. They come in 20-pin "skinny" dual-in-line packages.

Birkner feels his PAL is borrowing from the best of two worlds: the programmability of PROMs and the versatility of AND plus OR logic of the FPLA. The field-programmable array was an attempt shortly before microprocessors were introduced to produce arrays of logic gates on a chip with programmable interconnections. Its great drawback: because it includes both types of gates, it can not be programmed with PROM programmers. Instead, it needs special expensive programming units.

It is also difficult to design FPLA interconnects because there is a dearth of software aids to make the job simpler. Such an assembler language would accept logic statements as input and produce the format for programming.

Birkner believes he has gotten around these drawbacks. First, although PAL incorporates both AND and OR gates, the OR array is fixed; only the AND array is programmable. This means that the device can be handled on a conventional PROM programmer. This logic arrangement may lose some flexibility, but Birkner feels the loss is of little consequence with the kinds of random-logic applications it is aimed at.

To help in programming, Monolithic Memories has also developed the kind of software aid that the FPLA lacked. Called Palasm, short for PAL assembler, it is a Fortran IV program available through the National CSS Timeshare Inc. system. As for the personality cards for the PROM programmers, Data I/O of Issaquah, Wash., already has one ready for $575 to cover the 15-member family. A card for Pro-Log's programmer line will be ready by the fourth quarter of the year from the Monterey, Calif., company's production line.

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**Software**

**Patent issue called a matter for Congress**

Writers of software seeking to patent their work should look to Congress and not the courts for help, says the U.S. Supreme Court. In a 6-3 decision at the end of June, the Court
Memory retention at 2.5 volts Vcc — the 2114LV. 125mW stand-by vs. 350mW operating. Think of the power you save. And think of the complete 2114 family from Synertek. All fully static. No clocks or triggers using valuable system time. 200, 300 and 450nsec versions. The low power 2114L series — plus power down.

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Court rejects Zenith protection bid

Efforts to assess import tax penalties on consumer electronic products from Japan failed last month when the U.S. Supreme Court unanimously rejected the bid of Zenith Radio Corp. for protection. In a decision written by Justice Thurgood Marshall, the Court ruled that Japan’s remission of its domestic commodity tax on exports is not excessive and therefore does not qualify as a “bounty or grant” requiring assessment of penalties under the U.S. Tariff Act of 1930. The Japanese tax ranges from 13% to 20%, depending on the product.

The Court upheld the view of the Treasury Department that Japan’s remission of the tax is “a reasonable measure for avoiding double taxation of exports—one by a foreign country and once upon sale in this country.” Marshall noted that this interpretation, first made in 1898, is still valid and has since been reenacted five times by Congress in tax laws.

The Carter Administration believes the ruling turns aside the threat of a crisis at world trade negotiations in progress at Geneva. However, House trade subcommittee chairman Charles Vanik (D., Ohio) warned U.S. negotiators that they must now push for an agreement that would preclude foreign subsidies that distort trade if congressional consent to a new agreement is expected.

The high court decision backed a 3–2 decision by the Court of Customs and Patent Appeals. That decision reversed a ruling in Zenith’s favor last year by the U.S. Customs Court in New York [Electronics, April 28, 1977, p. 90]. At that time, the Treasury Department required importers to post bonds covering possible countervailing duties pending a Supreme Court decision. These bonding requirements will now be dropped, the department says. The Zenith case sought penalties on imports of television and radio receivers, phonographs, speakers, tape recorders, and various combinations thereof, as well as color TV picture tubes.

The lack of precedent in the young computer industry is a handicap to the courts, Stevens says. “To a larger extent our conclusion is based on reasoning derived from opinions written before the modern business of developing programs for computers was conceived,” he points out. “The youth of the industry may explain the complete absence of precedent supporting patentability.”

Overturned judgment. The Flook decision overturned an earlier judgment in the case by the Court of Customs and Patent Appeals. It had held that the software was patentable despite earlier rejection by the U.S. Patent Office in line with a six-year-old policy.

Atlantic Richfield applies the software during the catalytic-conversion process in a refinery to update alarm limits on process variables such as temperature, pressure, and flow rates. The Supreme Court rejected the move for a patent because the algorithm, although developed by Flook, was within the boundaries of

Grayhill

I2 and I6 Button

Keyboard Pads

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Electronics review

Grayhill

I2 and I6 Button

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• XY matrix
• single pole/common bus
• 2 out of 7 (or 8) coded output
• choice of 1/4-inch or
  3/4-inch button centers

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**News briefs**

**Nippon Electric to acquire Electronic Arrays**

Electronic Arrays Inc. of Mountain View, Calif., and Nippon Electric Co. of Tokyo, have agreed in principle to the acquisition by the Japanese telecommunications and computer equipment maker of the U.S.-based manufacturer of memories for about $8.6 million in cash. The agreement calls for the purchase of Electronic Arrays' 1,781,000 shares outstanding at a cost of $4.82 per share. The purchase price might increase somewhat if, before the closing of the deal, Electronic Arrays hikes its reserves by selling its 3% interest in Monolithic Memories Inc. of Sunnyvale, Calif.

**Electronics trade surplus up in 1977**

The U.S. trade surplus in high-technology, electronics-oriented products rose 39% last year, reaching a level of $1.2 billion, according to Washington Analysis Corp., a subsidiary of Bache Halsey Stuart Shields Inc. The sharp increase is largely due to net export gains of $449 million in radio and television communications equipment and $658 million in computers and related equipment. These more than offset net import gains of $702 million in consumer electronic products and $203 million in electronic components. Total exports of electronic products for 1977 were 14% above year-earlier levels, while imports for the period increased 11%.

**Exxon unit acquires maker of point-of-sale terminals**

Periphonics Corp. of Bohemia, N.Y., an Exxon Enterprises Inc. affiliate that makes telecommunications and voice response systems, has acquired a producer of point-of-sale terminals, EFTS Corp. of San Carlos, Calif. The terminal maker is unveiling a new family of terminals, the Series 100, designed for check authorization and verification of electronic funds transfers. Based on Intel Corp.'s 8085 single-chip 8-bit microcomputer, the family consists of four terminals ranging in price from $500 to $950, depending on features and quantities.

**Video-cassette recorder sales on display**

First statistics on U.S. sales of home video-cassette recorders to dealers by 11 manufacturers and importers show the market totaled 111,151 units for the first five months of the year, hitting a high of 27,994 in May. The new figures are now being developed monthly by the Electronic Industries Association's Consumer Electronics Group. Compilation of the statistics has just started, so there are no comparable figures for previous years. The monthly breakdown of unit sales shows the market turned up sharply in March (27,415) from levels recorded in January (13,567) and February (14,954).

**Zenith flat panel gets another life**

Former research-and-development men from Zenith Radio Corp. have formed their own company, Lucritron Inc., to develop Zenith's flat panel display. Zenith dropped development of the gas-discharge device, which produces TV-like pictures in color, when it closed its corporate research and development facility last year. Lucritron president Joseph Markin is chary about describing how the panel works. But he hopes to have a 5-inch (diagonal) panel, 3-inch thick, for demonstration shortly. The price of the display, whose details Markin declines to describe, is likely to remain high. Planned for the early 1980s are displays larger than 25 in., measured diagonally, costing upward of $5,000. The two other ex-Zenith officers of the new Northbrook, Ill., company are Alan Sobel and Michael De Jule.

the existing state of the art.

However, the high court's reasoning on this point gave heart to legal specialists in software patentability, since Justice Stevens went on to conclude: "Even though a phenomenon of nature or mathematical formula may be well known, an inventive application of the principle may be patented. Conversely, the discovery of such a phenomenon cannot support a patent unless there
THE WIDEBAND RMS VOLTMETER ONLY FLUKE COULD CREATE.

You’re probably accustomed to using analog meters for audio-to-rf measurements. Maybe you’ve given up hope of going digital at a reasonable price.

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Fluke’s new 8920A wideband true rms DMM is loaded with features—some you can’t buy anywhere at any price, and it sells at an analog price: $995! For starters, 8920A bandwidth is 10 Hz to 20 MHz for sub-audio to video AC measurements. Mid-band accuracy is 0.5%, compliments of an exclusive Fluke designed (and built) micro-electronic rms chip. Accurately measuring noise and non-sinusoidal waveforms is easy since the chip responds only to the heating effect of the waveform. You can select the AC + DC function for non-symmetrical waveforms like pulses that have a DC component.

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is some other inventive concept in its application."

That judgment is being read, says one Washington patent lawyer, "to mean that the 'right kind' of software is patentable—applications software that is inventive. I think there is a great deal of that around. What is needed now is to update patent law to accommodate it. This was a relatively uncomplicated case, yet the Court seems to go out of its way to urge Congress to act."

The disheartening aspect of the decision for software patent advocates is that Congress is unlikely to act quickly. Its legislative plate is already full and members are pressing for an early fall adjournment.

**Employment**

**Southern California desperate for EEs**

The boom for bodies, from beginning electronics engineers to experienced practitioners, is on again in southern California, reminiscent of the hiring explosion that accompanied the space race over a decade ago. Although the demand for engineers has increased sharply across the country, companies in Los Angeles and Orange counties are particularly desperate because they need a large number of EEs at a time when supply is tight and the good life promised by the region has lost much appeal.

As usual, the prime candidates are recent graduates or EEs with only one or two years’ experience. However, some companies are also trying to lure experienced engineers away from other firms.

Thus, for the first time since the downturn at the beginning of the 1970s created widespread layoffs, engineers are in a seller’s market. As a result, southern California companies are taking unusual steps to fill their needs:

- One electronics firm offers a $1,000 bounty to employees who bring in prospects that are hired.
- At another company, EEs who present themselves for an opening get a recruiter’s fee of $5,000 and up after a year on the job.
- To lure engineers away from rivals, electronics manufacturers are offering as much as 20% increases over present salaries.
- The opening salary for BSEE graduates from West Coast engineering schools is now commonly over $17,000, up some $2,000 since the beginning of the year.

**Buildup.** What happened to turn the job market up so sharply in this trend-setter section of the country? The reasons go beyond the general high business level the electronics industries are currently enjoying nationwide.

The head of personnel for an Orange county firm defines it as a classic supply-demand bind. “We’re dealing with a finite market here: there’s simply not enough to go

**It’s a seller’s market again for EEs**

Demand for electrical engineers has been growing across the country, though salaries and recruiting techniques have varied from region to region. While the Southern California electronics firms may have set the pace for innovative enticements, their counterparts in the San Francisco Bay area are no slouches. Competition is so fierce for talent in Silicon Valley that Fairchild, Intel, Intersil, and Memorex have resorted to recruitment commercials for EEs on local television and radio stations.

Opening salaries are also climbing, sometimes as high as $18,000 for a fresh graduate; $19,000 for an engineer with a year's experience. The situation is not much different in New England where the demand for EEs has increased while the supply of freshly minted graduates from the major engineering schools has been static. According to Ray Stata, president and chairman of Analog Devices, engineers are swapping jobs but that is only "robbing Peter to pay Paul," not solving the basic shortage.
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Telex: 932498, 932499

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Product Summary

<table>
<thead>
<tr>
<th>Product Number</th>
<th>Numerical Aperture</th>
<th>Core Diameter</th>
<th>Cladded Diameter</th>
<th>Coated Diameter</th>
<th>Maximum Attenuation (dB/km at 820 nm)</th>
<th>Minimum Bandwidth, MHz @ 1 km (~3 dB optical power)</th>
</tr>
</thead>
<tbody>
<tr>
<td>4080</td>
<td>.21</td>
<td>63 μm</td>
<td>125 μm</td>
<td>138 μm</td>
<td>4</td>
<td>800</td>
</tr>
<tr>
<td>4040</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>4</td>
<td>400</td>
</tr>
<tr>
<td>5040</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>5</td>
<td>400</td>
</tr>
<tr>
<td>6080</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>6</td>
<td>800</td>
</tr>
<tr>
<td>6060</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>6</td>
<td>600</td>
</tr>
<tr>
<td>6040</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>6</td>
<td>400</td>
</tr>
<tr>
<td>8080</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>8</td>
<td>800</td>
</tr>
<tr>
<td>8040</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>8</td>
<td>400</td>
</tr>
<tr>
<td>8020</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>8</td>
<td>200</td>
</tr>
<tr>
<td>10020</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>10</td>
<td>200</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Product Number</th>
<th>Numerical Aperture</th>
<th>Core Diameter</th>
<th>Cladded Diameter</th>
<th>Coated Diameter</th>
<th>Maximum Attenuation (dB/km at 900 nm)</th>
<th>Minimum Bandwidth, MHz @ 1 km (~3 dB optical power)</th>
</tr>
</thead>
<tbody>
<tr>
<td>3081</td>
<td>.24</td>
<td>63 μm</td>
<td>125 μm</td>
<td>138 μm</td>
<td>3</td>
<td>800</td>
</tr>
<tr>
<td>3041</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>3</td>
<td>400</td>
</tr>
<tr>
<td>4101</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>4</td>
<td>1000</td>
</tr>
<tr>
<td>4041</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>4</td>
<td>400</td>
</tr>
<tr>
<td>5101</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>5</td>
<td>1000</td>
</tr>
<tr>
<td>5041</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>5</td>
<td>400</td>
</tr>
<tr>
<td>5021</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>5</td>
<td>200</td>
</tr>
<tr>
<td>7081</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>7</td>
<td>800</td>
</tr>
<tr>
<td>7021</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>7</td>
<td>200</td>
</tr>
<tr>
<td>10021</td>
<td></td>
<td></td>
<td></td>
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<td>10</td>
<td>200</td>
</tr>
</tbody>
</table>

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Electronics review

around," says Jack Coke of Computer Automation Inc. in Irvine.

This shortage became acute around the first of this year, some say, when employers planning expansion found the EE pool virtually exhausted by last year’s upturn. Smaller numbers of graduating EEs resulting from the poor job climate in the 1974-75 recession has also played a part. But the capper has been the reduction in the pipeline of engineers from out of state, whose desire to move to southern California has been the major source of new technical blood. Much-publicized high taxes and housing costs are the villains, recruiters contend.

On the other hand, feelings of veteran engineers who have been through two big recessions in 10 years, are aplenty summed up by J. C. Hoagland, communications engineer at Rockwell International Corp.’s space systems group. “For the first time in a long time, I’m on top of the heap instead of the bottom, and I like it,” he says. Hoagland, also vice chairman of the Los Angeles Council of the Institute of Electrical and Electronics Engineers, sees the imbalance in the EE’s favor continuing for at least five years.

In mid-June, a development occurred that put what may be an unbearable strain on what is already a seller’s market. Hughes Aircraft Co. made known it will need 1,700 engineers, mostly electronics engineers, before the end of the year. With 40,000 employees at eight southern California facilities, the company ranks as the state’s No. 1 electronics employer.

Hughes’s chances of getting this number today are considered slim. “Lots of luck” is the opinion voiced by Clifton R. Huxford, personnel consultant to TRW Inc.’s sprawling Electronics Group. Just one of the firm’s divisions needs 50 engineers for work on digital telephone-switching equipment. Huxford admits paying a minimum of $18,500 a year for new BSEE’s with some experience. But he and other personnel experts think Hughes will not come close to filling its needs without raising salaries much higher.

CORNING
Dreams of using the space shuttle to produce purer and less expensive semiconductor crystals are being challenged by a National Research Council study. After a year's analysis, a special committee made up of 12 leading U. S. materials scientists says it "has not discovered any examples of economically justifiable processes for producing materials in space and recommends that this area of materials technology not be emphasized" by the National Aeronautics and Space Administration. Materials research and development, however, might be useful, the committee concludes, "provided that problems proposed for investigation in space have from the outset a sound base in terrestrial science or technology." NASA's early program, the committee points out, "has suffered from some poorly conceived and designed experiments, often done in crude apparatus, from which weak conclusions were drawn and, in some cases, over-publicized." Chairman of the study group is Bell Laboratories' director of materials science and engineering, William P. Slichter.

Solar-power satellite advocates are optimistic about Senate passage of a proposal to spend $25 million on research and development for the energy craft in fiscal 1979 now that the House has passed a similar measure by an overwhelming vote of 267 to 96 late last month. The concept involves assembling huge arrays of photovoltaic solar cells in space, placing them in geosynchronous orbit, and then converting the electricity they produce into microwaves for transmission to earth stations for power generation [Electronics, April 27, p. 96]. First hearings on S. 2860, introduced by Sen. John Melcher (D., Mont.), are set for mid-July before the energy R&D subcommittee headed by Idaho's Frank Church (D.).

The National Bureau of Standards is proposing a magnetic-tape standard for Government computer users and says it expects to complete a magnetic-disk standard within a year in an acceleration of its lagging standards program [Electronics, Feb. 2, p. 39]. The proposed tape standard may be revised after evaluation by Government users and computer makers before final adoption as a Federal information-processing standard. Two previously published standards covering the interfaces for input/output channels and power control have already been revised. All are subject to revision within three years. The NBS's Institute of Computer Science and Technology expects the three standards will save Government computer users more than $55 million over five years.

The Department of Energy is funding five companies to buy and operate 160 electric vehicles in the first round of a 10-year demonstration program estimated to cost $160 million [Electronics, Nov. 10, 1977, p. 49]. Operators and the number of vehicles they will use include: Long Island Lighting Co., New York, 60 for van pooling, service, and small fleets; New York's Consolidated Edison Co., 40 for field supervision, service, and computing; American Telephone & Telegraph Co., Los Angeles, 20 for repair service; Walt Disney World Co., Lake Buena Vista, Fla., 20 for motor pool and repair service; and Penn Jersey Subaru, Pennsauken, N. J., 25 for individual leasing and sales. The initial cost of $4 million will be split 50–50 by the department and the operators.
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Putting the U.S. on an exports offensive

The U.S. overall trade deficit set another record in the first five months of 1978, reaching $14.8 billion for the first time. It is nearly 80% higher than for the comparable period last year, and no one in the Federal bureaucracy sees any sign that it will diminish significantly, despite the declining value of the dollar relative to stronger foreign currencies. In the face of the Carter Administration's unsuccessful attempts to reduce the deficit by calling for reduced oil imports, an increasing number of American industrialists are urging a more aggressive U.S. posture on exports.

The failure of the Government to develop a comprehensive national export policy to encourage foreign sales of U.S. electronics products and other high technologies is not the fault of President Carter. It is a problem with a long and complicated history. Nevertheless, the Administration has yet to give the deserved priority to the development of an affirmative, flexible export policy, although it does have a task force at work on the matter.

The EIA's new assessment

The Electronic Industries Association is among those calling for such a policy. As the EIA's International Business Council points out in a new position paper aimed at the Administration task force, "maintaining the favorable balance of electronics trade, currently in excess of $2.5 billion, is becoming increasingly difficult. Both foreign and domestic actions have eroded the ability of U.S. companies to match zealous overseas competitors on an equal basis."

In one of the clearest summaries of America's export needs, the EIA calls first for creation of high-priority national policy separate from other national goals, rather than subsidiary or subservient to them. "Its purposes should be its own, not those of foreign political relations or domestic taxation. Its implementation through programs and administration should be consistent, not contradictory," the report says. "Its direction should be steady and continuing, not sporadic or perpetually shifting under the hands and whims of ever-changing administrators and regulators. In short, the policy should be one of firm commitment, appropriately served, to objectives that are reasonable and possible."

Though the association's position represents an ideal, it is not impossible to achieve. However, such a policy needs a relaxation of the traditional adversary relationship on exports between Government and business. To be competitive, American companies must be able to get Federal approval of export licenses and related financing quickly and simply. As the EIA report points out, delays in decisions lose export sales.

Some needed changes

Equally important, electronics manufacturers believe the Commerce Department's export promotion needs more timely intelligence on foreign markets and reorientation away from present programs that emphasize one-time or first-time sales and introductions. Those programs, the EIA contends, "do not and cannot provide the operational framework that is essential to export growth: the continuing organizational presence in a foreign market that provides customer service, applications engineering, sales administration, day-to-day solicitation, and the myriad interface requirements between a U.S.-based manufacturer and an overseas buyer."

The EIA alternative to the Government's weak support for exporters past their first foreign sale has four parts. Two would require relaxation of antitrust laws: permission for companies that compete in the domestic market to jointly own trading companies for export purposes, as well as allowing such companies to engage in trade-related banking operations. Similarly, the association believes that U.S.-owned foreign subsidiaries should be permitted to represent products of other U.S. exporters, even if they are in competing lines of business.

Financial incentives, including better credit programs and short-term financing for smaller transactions, make up the balance of the recommendations. For most exporters, the association maintains, overseas sales are not single-shot opportunities. Successful exporting embraces multiple economic processes. Thus "the best environment for expansion is stability and incentives to growth, both in rule and in economic policy, rather than the stop-and-go, year-to-year approach that is characteristic of present Government programs," the report concludes.

Ray Connolly
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<table>
<thead>
<tr>
<th>Types</th>
<th>VCEV Rating</th>
<th>IC (sat)</th>
<th>IC (max) at IC (sat) μs</th>
</tr>
</thead>
<tbody>
<tr>
<td>2N6671</td>
<td>450 V</td>
<td>5 A</td>
<td>0.4 (25°C)</td>
</tr>
<tr>
<td>2N6672</td>
<td>550 V</td>
<td></td>
<td>0.8 (125°C)</td>
</tr>
<tr>
<td>2N6673</td>
<td>650 V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>2N6674</td>
<td>450 V</td>
<td>10 A</td>
<td>0.5 (25°C)</td>
</tr>
<tr>
<td>2N6675</td>
<td>650 V</td>
<td></td>
<td>0.8 (100°C)</td>
</tr>
<tr>
<td>2N6676</td>
<td>450 V</td>
<td>15 A</td>
<td>0.5 (25°C)</td>
</tr>
<tr>
<td>2N6677</td>
<td>550 V</td>
<td></td>
<td>0.8 (100°C)</td>
</tr>
<tr>
<td>2N6678</td>
<td>650 V</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
International newsletter

Fujitsu plans big addition to IC plant

The ambitious plans of Fujitsu Ltd. to switch its semiconductor division from strictly an in-house supplier to a profitable outside vendor are shifting into high gear. It is about to invest $24.4 million to expand its semiconductor plant in Aizu, Fukushima prefecture, and turn out more 16-k random-access memories and other large-scale ICs for export. The plant will be highly automated and is designed to turn a profit when operating at 80% of capacity. When started up in January, the four-floor building will total about 90,000 ft². At the same time, Fujitsu will beef up its existing facilities, bringing its overall investment in semiconductor facilities during the fiscal year ending next March 31 to about 40% of its total capital investment.

Industry backs UK government's IC strategy

A report by British microcircuit industry and union executives and government representatives broadly endorses the Department of Industry’s low-risk plan to aid the domestic industry [Electronics, May 11, p. 88]. The strategy, to be announced soon in the House of Commons, will cost in the region of $430 million over five years from all sources, including industry. The Department of Industry will furnish $145 million, and $60 million to $100 million will come from the National Enterprise Board in the shape of a new company and plant (see p. 86). Pre-empted by the NEB and Fairchild-General Electric Co. projects (Fairchild-GE talks are in an advanced stage), the National Economic Development Office report nonetheless welcomes a British-owned presence in the volume standard-IC market.

State-owned firm in Yugoslavia buys West German outfit

What industry observers have considered unlikely will take place in August when the state-owned Yugoslav household-equipment maker Gorenje buys West Germany’s privately owned Körtig Radio Werke GmbH, a family-owned 1,300-employee entertainment electronics company on the verge of bankruptcy. The surprise $10 million deal, which still needs the approval of Yugoslavia’s central government, follows months of speculation—and hopes—that Western firms, among them General Telephone and Electronics International Inc. of New York, would come to the rescue of the ailing West German company. By failing to do so, one industry insider says, “they have given yet another outside contender easy access to the lush West European radio and television market.” With a production facility in West Germany, Gorenje, a 17,000-employee, $500 million enterprise, is certain to make an impact on that market.

Japanese look to lateral-channel MOS for voltage

Engineers at Nippon Electric Co. are working all out to develop large lateral-channel MOS devices for a variety of applications. Among them: switching power regulators, audio-frequency amplifiers, and high-frequency amplifiers, including kilowatt-class broadcast transmitters. The devices have a shield plate similar to that of earlier devices developed by Hitachi to achieve a voltage rating several times that of V-groove MOS. With aluminum gates—rather than the polysilicon used by Hitachi—giving them faster response time, the new devices should be particularly attractive for use in switching regulators operating at higher frequencies than are feasible with bipolar devices. This will be especially true when the voltage rating surpasses the present value of 120 v. In the first experimental application, NEC and the technical research laboratories of NHK, Japan’s
Japanese manufacturers of consumer electronics products should find microcomputer control more convenient with the introduction by domestic firms of 4-bit, one-chip models featuring on-board analog-to-digital converters from Mitsubishi Electric Corp. and Nippon Electric Co. Both companies expect good yield and ease of programming because the devices are based on microprocessor series already in production—Mitsubishi’s on its series of 4-bit microprocessors used in calculators and other proprietary products, NEC’s on its general-purpose series of 4-bit microprocessors.

Mitsubishi uses an a-d converter similar to the one on board the Intel 8022 microcomputer but includes a multiplexer for up to 15 analog inputs. In addition to logic drive outputs, there are decoded outputs that can directly drive either fluorescent or light-emitting-diode digital displays. NEC uses a newly developed charge-transfer a-d converter.

The United Kingdom’s Department of Industry is preparing to plow about $1 million over four years into the development of machine-independent packet-switched networks. It will fund a national high-level protocol body at the National Physical Laboratory staffed by industry and the lab. Echoing recent French proposals [Electronics, June 8, p. 69] for a coordinated European-AT&T high-level protocol-development program, the new national body would both coordinate and speed British Post Office standards and manufacturer activities and present a united voice at CCITT and International Standards Organization meetings. The laboratory argues that BPO experience with its EPSS service was a powerful factor in the early definition and rapid implementation of the X-25 interface standard and that, without an equivalent program, partisan manufacturer and national interests could stymie the creation of an international protocol that would allow computers to exchange data regardless of maker.

Fearing a backlash if Japanese penetration of the British television and audio markets continues, a Japanese industry delegation to the United Kingdom, headed by Sony’s Noburo Yoshii, has agreed in principal to the increased use of British electronic components in Japanese goods. Backing its intentions, the delegation brought a shopping list of components to the meeting with the British Radio Equipment Manufacturers Association.

Using an image-converter–microprocessor combination, researchers at Siemens AG are working on a system that could be employed extensively as a checking or positioning tool on production lines. In operation, the image of the object to be positioned is projected through a lens onto the solid-state image converter. The converter’s output signals are digitized and fed to the microprocessor as a bit pattern. Suitably programmed, the processor then determines whether the object is present, and if so, whether bit pattern is identical to the one it has stored.

public-service broadcast network, have used a parallel array of 20 pairs of p- and n-channel devices to fabricate a class D amplifier with 1.37 watts output at broadcast frequencies. They are now designing a pulse-width modulator.
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<table>
<thead>
<tr>
<th>PART NUMBER</th>
<th>INPUT/OUTPUT</th>
<th>ACCESS &amp; CYCLE</th>
<th>POWER DISSIPATION</th>
<th>STATUS</th>
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</thead>
<tbody>
<tr>
<td>93470</td>
<td>TTL-OC</td>
<td>45 ns Max</td>
<td>650 mW Typ</td>
<td>Production</td>
</tr>
<tr>
<td>93L470</td>
<td>TTL-OC</td>
<td>45 ns Max</td>
<td>375 mW Typ</td>
<td>Samples</td>
</tr>
<tr>
<td>93471</td>
<td>TTL-3S</td>
<td>45 ns Max</td>
<td>650 mW Typ</td>
<td>Production</td>
</tr>
<tr>
<td>93L471</td>
<td>TTL-3S</td>
<td>45 ns Max</td>
<td>375 mW Typ</td>
<td>Samples</td>
</tr>
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<td>10470</td>
<td>ECL-10K</td>
<td>35 ns Max</td>
<td>800 mW Typ</td>
<td>Production</td>
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<td>ECL-100K</td>
<td>35 ns Max</td>
<td>800 mW Typ</td>
<td>Production</td>
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Display accesses 7,000 characters of Kanji writing

Japanese system also offers other symbols, alphanumericics at cost low enough to make it attractive to many businesses

Japanese writing consists of thousands of ideographic characters based on Chinese. Thus the problem for designers of terminals and word processors is monumental: while 1,850 characters—which the Japanese call Kanji—is considered enough to write the straight prose section of newspapers and similar nontechnical publications, additional characters are needed for names of persons and places, special fields, or variant orthography. If that isn’t enough, more than 100 phonetic syllabary characters plus about the same number for upper- and lower-case alphanumericics and symbols are also needed.

Now Fujitsu Ltd. has put on the market a display that permits its operator to access 7,000 separate Kanji and other characters, each presented as a 32-by-32-dot matrix, at a comparatively low price. Commercially, such a machine should be a boon to Japanese government agencies and such businesses as financial institutions, insurance companies, and book and newspaper publishers. The financial people would be able to keep more precise records of customers (many Japanese names that are phonetically alike are written differently) and newspapers could use the display for editing.

Guidepost. But the system is perhaps more interesting as an indication of the state of the art in computer input in Japanese and of how close the Japanese are to word processors. The Fujitsu display is a giant step forward because early computers had difficulty adding just the Japanese syllabary (characters similar to the alphabet that represent whole syllables), and it seemed that mechanization of written Japanese in its natural form, including Kanji, as well as syllabary characters, was not in the cards.

The system is designed for as many as 16 individual cathode-ray-tube displays and can be connected to a variety of host computers ranging from Fujitsu’s minicomputers through its largest mainframes. The heart of the system is a 1-megabyte disk with patterns for all characters. In large systems an optional 256-kilobyte random-access memory is loaded with the 2,048 most used characters, making it possible to access an average of 500 characters per second. The access rate for the disk alone is about 100 characters per second, which may make for queues in large systems.

The standard display has 21 lines of 32 characters each, whereas a special unit for newspaper editing has 25 lines of 32 characters each—both on 17-inch CRTs. In either case, characters measure 6 millimeters square. The operator works from a tablet with an electrostatically coupled pen; there are also 20 program-function keys and 20 display-control keys. The tablet shows a matrix of characters available, and the operator touches the pen to the character on the tablet to select it. In this respect, the tablet is similar to digitizers used to convert graphic information to digital input, but much rougher. One version has characters arranged as a matrix 64 wide by 48 high; another has a three-page tablet with 56 by 48 characters on each page.

Easy does it. Although this system permits interactive man-machine dialogue, it imposes virtually no load on the host computer. Editing functions, including character removal and insertion and interchange of

Getting the picture. A display system that can handle up to 16 CRTs has been developed by Fujitsu for the complex Kanji writing of Japan. The system accesses over 7,000 characters.
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change of the position of portions of the text, are performed independently. It is also possible to access the computer and perform tabulation, headline and caption layout, and layout of boxes and the like.

The price in Japan for the basic system, including character generator, Kanji display control, and single CRT display with tablet and keyboard console, is about $3,000 per month for rental, $125,000 for purchase. A similar system configured especially for newspaper editing sells for about $135,000. Semiconductor character memory, 16K card reader, hard-copy output, and up to 15 additional displays are extra. □

**England**

**Microprocessor-based sound deadener cuts low-frequency noise up to 20 dB in tests**

Although electronic amplification of sound may be accused of adding to the world's noise pollution, electronics may also come to the aid in the war against loud noises. A group of researchers at Essex University in England is testing an electronic "hush kit" that can deaden low-frequency sound—the noise element most difficult to combat with standard mechanical silencers—by as much as 20 decibels in a test arrangement simulating 200-to-300-horsepower diesel generators. Moreover, the Essex team contends that its still experimental technique could be extended to silence giant 2,000-hp diesel engines.

Comprising an amplifier-driven loudspeaker, a microprocessor-based sound synthesizer, a microphone, and a magnetic proximity transducer, the system produces a sound of the same magnitude and frequency as the noise source, only in reverse phase, so that the output generated cancels out the fundamental low-frequency components of the noise source.

"There's a nice trade-off between electrical and mechanical silencers at around the 250-hertz point," says Professor G. B. Chaplin, who is running the Essex project. "Above 250 Hz, conventional silencers are very effective, while our technique can silence the lowest exhaust frequencies."

The electronic silencer is not intended as a straight replacement for existing mechanical versions, according to Chaplin. Instead, it will open up new applications such as kits for big standby diesel generators, railway locomotives, or earth-moving machinery. With further refinement, the technique could be used to quiet high-powered diesel truck engines.

Producing contra-sound to silence a noise source has technical difficulties. One problem is generating an accurate noise signature in the presence of both the polluting and the cancelling noises. However, the Essex researchers realized that diesel engines have a fundamental noise signature that changes little from revolution to revolution. This fact enabled the developers to program a noise signature into the microprocessor-based sound synthesizer.

**Quiet.** In the experimental setup, the loudspeaker has an annular outlet surrounding the engine exhaust. The specially designed microphone picks up only the residual engine noise. In addition, the transducer senses the passage of engine flywheel gear teeth for computing revolutions per minute.

These sources provide input to a KIM 1 microprocessor board from Commodore Electronics, which divides the period for each revolution into 32 time slots. The microprocessor generates a noise signature synthetically by building a step wave of the engine sound, setting the noise level in each time slot to 1 of 32 levels. A noise signature for one complete revolution can thus be stored in a 256-bit random-access memory, which provides enough capacity for additional storage should it be required. This information is fed to a digital-to-analog converter and then applied to the cancelling power-amplifier and loudspeaker combination.

The microprocessor in turn builds the cancelling sound wave progressively over several revolutions. First, level one in time slot one is set and its effect on the residual sound determined with the input from the microphone pickup and a linked sample-and-hold circuit. If the noise power is reduced, the level is retained; if it increases, the level is cleared. The sound level is built up step by step over several revolutions until the residual sound power is minimized. During subsequent revolutions, all 32 time slots are optimized.

The result is noticeable. Even on a small laboratory test rig using a 40-watt amplifier, 63-Hz noise is cut by 23 dB, and 125-Hz noise is cut by 18 dB. To silence a 2,000-hp engine would currently require a 1,000-watt installation with speakers of present-day efficiencies, Chaplin says.

**Refinements.** At present, there is a 10-second delay before the cancelling noise signature can be synthesized over several revolutions. For standby engines running at constant speed it is not a problem. But for truck engines where rpm is constantly changing, the Essex team intends to refine the program by storing in read-only memory a noise signature for each engine-speed band. Each signature could be called as required and fine-tuned as described.

So far the Essex group has succeeded in demonstrating only the feasibility of the technique. Much work remains to be done, and additional financial backing must be found to produce a production prototype. In particular, a rugged, high-efficiency loudspeaker will be needed in a production version.

Refinements have already been built into the system, though. Initially, the microphone fed an analog sample-and-hold circuit, but now it feeds with a voltage-to-frequency circuit, the output of which is summed over a revolution and the count stored. A comparison is then
made with the count during the subsequent revolution and the lowest value between the two is retained.

In a parallel project, the Essex team is working with sound attenuators to deaden sound in heating and ventilating ducts. In this case, the sound generated is random, but by recording at one point upstream in the duct and reinjecting the sound further downstream, it may be possible to adapt the silencer.

**Switzerland**

Electronic control system follows the sun to help boost output of thermal collectors

Say “solar energy,” and most electronics engineers will shout “photovoltaics.” But there is more to the field, and more immediate returns at that. In the making is a substantial role for electronic control systems to boost the output of thermal collectors, an application of the sun’s power that looks as if it will prevail over photovoltaics for some time.

A pioneer in this area is the Swiss firm Polisolar AG of Berne. Its hardware is based on paraboloidal mirrors that track the sun during the day. A sister company, Liebi LNC Ltd., took the equipment into the world market last year and has since done well: a $1 million system to heat and cool a factory in Rome is under construction, and a $500,000 pilot desalinization plant to supply 10,000 liters of drinking water daily is slated for Jiddah, Saudi Arabia.

“The electronics for the tracking system run between 2% and 3% of the system cost,” says Peter Ernst, a Polisolar engineer. Nonetheless, the automatic tracking is essential to the operation. The sun’s radiation is absorbed in a tube centered on the focal line of each mirror. So, unless the mirror is pointed right at the sun, its radiation is not concentrated on the tube.

Efficient. With such concentration, the special black, star-shaped absorbers that Polisolar puts inside the tubes are much more efficient than comparable flat-plate collectors. They yield about twice as many kilocalories a day at 50°C outlet temperature for the carrier fluid. At outlet temperatures of 100°C, the yield becomes four or five times better than for flat collectors.

Polisolar mounts its 320-by-58-centimeter mirrors in groups of 6 to 18 with a common rack-and-pinion drive for each group. Also tied into the drive is a fist-sized sensor that develops control signals for the drive motor, which has a 60-watt rating for a six-collector group.

Low profile. Convinced it has a head start on competitors, Polisolar will not talk much about its control circuitry. But Ernst does say that the sensor has two clusters of solar cells separated by a wall and connected in a Wheatstone bridge.

Unless the sensor unit is pointed straight at the sun, one cluster of its cells gets less radiation than the other. The difference in outputs upsets the Wheatstone bridge. Then the control circuitry produces an output about every 50 seconds, so that the motor drives the mirrors to point directly toward the sun. At that orientation, the output from the solar-cell clusters balances again.

Logic in the control circuit compensates for clouds and will defocus slightly if the temperature in the tube gets too high. After dark, when the sensors’ output is nil, the system drives the mirrors all the way back to point fully east, waiting for the sun to rise.

**France**

Naval monitor sorts targets

Navies today are almost as dependent on rapid data communications as they are on sophisticated weapons systems. However, like their civilian counterparts, naval data-collection and broadcasting systems have become more and more complex, and the sheer volume of output seems about to sink the fleets.

Typically, most data collection and processing of enemy vessels and aircraft positions is done on a command ship, which then retransmits the information to the smaller vessels that make up a combat unit. The trouble with this method is that
often the smaller craft on the receiving end of the target-plotting information have no use for it because they are not directly involved. Thus, the many ships that make up a fleet are drowning in unwanted data, and more important, the information that is of use is difficult to sort because of the high volume.

A solution, says Georges Lauvray, sales director of ECA, a French firm based southwest of Paris, is to eliminate part of the information at the receiving-vessel end. "There is no way of processing the high-speed information that is available to the big ship collecting and sending the information," he says. "The answer is to set up criteria to select the information the receiving vessel needs and then present that information in a way the operator can use."

Monitoring. The ECA proposal is a semiautomatic system called Plotaid, costing about 10 times less than a fully automated system and suitable for vessels of approximately 1,500 to 2,000 tons. The Plotaid system is built around two units—a processor that monitors and selects relevant data and a large screen that displays the data using a novel laser approach. With the processor there is also a cathode-ray tube display that gives additional details on the plotting data displayed on the screen. A teletype and a control panel complete the lineup.

The company is cagey about costs but intimates that the system could run less, perhaps significantly less, than $326,000. Dimensions are roughly 180 by 150 by 15 centimeters for the display panel and 80 by 55 by 45 cm for the CRT and processing unit. Plotaid accepts data from any Link 14 data transmission, a widespread naval standard. It will also handle other formats given suitable software modifications.

The screen is made of yellow-green Perspex, an acrylic material, roughly 1 meter square. Its panel carries a double marking—X-Y axis lines and concentric circles. The helium-neon lasers that enable tracking data to be presented on the screen are situated close to the base of the panel on the sides. They are oriented by a step-motor-driven set of cogs that control shutters and mirrors. When the lasers intersect within the panel, a bright point appears that can show, for example, the received position of a given target track. The servo system is of the semiclosed loop type, resetting to zero every 10 operations. There are three 2-milliwatt lasers, two for the plotting and one in reserve.

Programmable. The brains of the system is a Texas Instruments SBP 9900 16-bit microprocessor. The processor has a 2-kilobit 16-bit-word random-access memory to hold incoming tracking data and a 6-kilobit 16-bit-word read-only memory that holds the program. The processing unit receives incoming data from a Link 14 modem, plus information on speed and course from the vessel carrying the Plotaid unit.

Software is split into two parts that correspond in effect to an operating system and an application program. The latter carries out the selection of the information required by the carrying vessel.

Apart from the Perspex display and the processing unit, Plotaid also offers a conventional militarized teletype—a French Sagem unit is supplied, but any CCITT-2 standard international alphabet, five-moment, 75-baud unit would do. Completing the information display is the CIP, or complementary information panel. This unit is a CRT that can display a host of details, including the time, the number of tracks waiting but not yet processed, the number of tracks selected altogether, the scale of the display, and the course and speed of the carrying vessel. Also, for each track displayed on the Perspex screen, the CIP shows whether it is new; the time the data has been computed; the bearing, distance, altitude, and speed; and the identification of the tracked object (whether it is friend or foe).

The system is designed for easy operation. It displays a track automatically, holding the laser position for a preset interval. Then the shutters cut in until the operator calls for either a repeat of the last track or the display of the next selected track.

Lauvray believes that the system has other applications—for example, it could be land-based rather than aboard ship. But for the near future at least, ECA is concentrating on selling the naval version.

Japan

Hybrid IC packs mobile components

Taking advantage of a new technique for producing uncased transistor chips for hybrid circuits, Mitsubishi Electric Corp. has just developed a series of hybrids that includes a majority of the components for the driver and output stages of mobile communications equipment. The single plastic-mold printed circuit board, which measures 66 by 23.5 by 9.8 millimeters, is 20% to 30% smaller than the discrete circuits it replaces. It comes with either four or five leads arranged in a line along one side.

Wideband tuned circuits on thick film that require no adjustment are included in the package so that an equipment manufacturer need only supply a fractional-watt frequency-modulated signal source, a power supply (with decoupling), a 50-ohm stripline connected to a filter circuit and an antenna. The integrated circuits are aimed at mobile communications transmitters in the 150- and 400-megahertz bands.

New chip transistors developed for the hybrid circuits feature high-precision patterns with ion-implanted narrow base and shallow emitter for higher F<sub>T</sub>. As a result, gain is typically 3 to 4 decibels higher than for discrete transistors. The new transistors have multilayer metalization with precious metals, including a top layer of gold for high reliability. The driver transistor chip (two in a cascade for 400-MHz-band units) is mounted on the ceramic hybrid-circuit substrate; the output transistor chip is mounted on a beryllia carrier that is attached directly to a copper heat sink that forms the bottom of the plastic molded package.
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Circle 79 on reader service card
Daisy-chain backplane fixturing

Working wonders with a few wires and a few volts.

Testing backplanes for wiring errors should not be a very big deal. After all, the technology of finding opens and shorts is not the kind of thing you write your doctoral thesis on. Yet, until a few years ago, any backplane with a few thousand points or more was sure to represent hours, if not days, of testing time.

Well, not testing time, really. The problem was less the testing than the getting ready for the testing. Since one wire had to be connected from each backplane point to the tester, preparing a 10,000-point backplane for testing was a fearsome job in its own right. In fact, with a wire-per-point system the tester-to-backplane connections were often less reliable than the backplane wiring, and a whole new round of verification was necessary. The backplane testing was then performed via banks of clattering relays whose own reliability was less than gilt-edged. Clearly, to call this "automatic testing" was to abuse the language. But at the time there were no alternatives.

Teradyne, which had backplanes of its own to test, refused to accept wire-per-point connection and set about to find a better solution. The result was the "daisy-chain" approach now generally conceded to be the only way to test backplanes.

The idea behind daisy-chaining is to distribute a portion of the test electronics onto the backplane itself, via "fixture cards" inserted into the backplane's card-edge connectors. Then, through a combination of serial and parallel addressing, the system can access any pin connected to any fixture card for testing. The fixture cards are linked, daisy-chain fashion, by a quarter-inch cable carrying 14 leads. At each end of the daisy-chain the cable connects to the test system. That's the only connection to the system required, whether the backplane has 100 points or 100,000. One does have to plug in those fixture cards, but compared with wire-per-point connection this is a trifle. (Besides, with two sets of fixture cards one can set up one backplane while another is being tested.)

Since four switches per point are required to carry off the multiplexing, the game is played in solid-state. But not just any solid-state. Turning 400,000 T^3L switches loose on a 100,000-point backplane is a sure way to vaporize everything in sight. So the switches were designed in custom CMOS, where they run on a cool 350 milliwatts.

As the length of the daisy-chain varies with the size of the backplane and the number of fixture cards, the daisy-chain capacitance varies as well, and it was therefore necessary to design the system so that timing would be independent of daisy-chain length. Teradyne accomplishes this via a "handshaking" technique that ensures that each step is complete before the next is initiated.

The use of low voltage to test backplanes was initially taken for heresy by a world conditioned to define continuity in terms of what would pass 500 volts. However, where the idea is to find wiring errors, 10 volts proves to be just as effective as 500. The case for high-voltage testing rests chiefly on its use to predict insulation cut-through, but even here it's a shaky case at best, for the time window during which breakdown will occur at 500 volts and not at 10 is likely to be statistically insignificant.

Backplane errors are generally the least forgiving of all; a single missed connection can cripple an entire system. Yet many manufacturers sample-test their backplanes or bypass testing altogether until final system checkout. In the days when backplane testing presented a horrendous accessing problem, this may have been understandable. But not now. Testing backplanes today is as easy as picking daisies.
Probing the news
Analysis of technology and business developments

New firms rush into new phone market

Consumer instruments with features based on latest electronic technology are starting to compete for pieces of $170 million annual pie

by Bruce LeBoss, New York bureau manager

Don't look now, but the next consumer electronics market might well be the telephone. A host of companies is developing, producing, and marketing electronic telephones and their integrated circuits. Not only are the phones a new generation of equipment that relies heavily on advanced electronics to provide special features and functions, but many of the suppliers are members of a new breed that expects to give established firms a run for their money—in this case, a market estimated at $170 million annually.

The competition and the companies might not exist were it not for a Supreme Court ruling nine months ago. The court tumbled the barriers to the home phone market by upholding a Federal Communications Commission ruling that permits consumers to attach their own phone equipment to the public network. Now the flood gate is open.

New models. Typical of the new firms is Tridar, which introduced its model S101 electronic phone at last month's Summer Consumer Electronics Show in Chicago [Electronics, June 22, p. 40].

The S101 has 90 electronic components, including four standard integrated circuits and three custom bipolar linear chips that perform preamplification, peak detection, and comparator functions. Hans R. Camenzind, who is Tridar's chairman and director of research and development, says the entire phone measures about 2 by 1.5 by 6 inches and weighs about an ounce less than the handpiece of a home phone. "This is possible because of the integrated-circuit design," says Alan V. Gregory, president of the firm.

The instrument may be used as an amplified speaker phone or as a conventional unit. It has volume control and a hold button with a light-emitting-diode indicator. Priced at the middle of the new market, the $149.95 S101 plugs into any modular jack and is equipped for push-button service.

Founders. Among Tridar's founders are Camenzind, former chairman and founder of Interdesign Inc., recently acquired by Ferranti Ltd.; Gregory, former Fairchild Semiconductor vice president in charge of the metal-oxide-semiconductor division; and A. Crawford Cooley, a venture capitalist and former board member of Interdesign.

Camenzind says the consumer telephone market has three segments: rotary-dialer or push-button units that basically offer the same functions and styles as the current models from the telephone companies, decorator phones with the same standard functions, and what he describes as new-features phones. "The special-features area is where the action is and where there is room for technology," he says. However, "the initiative for this won't come from the semiconductor manufacturers, but from small telephone- and technology-oriented companies that can apply the appropriate microelectronics."

Some of the bigger, traditional suppliers "may have difficulty in getting the entrepreneurial spirit" to develop these phones. (Not that Ma Bell would agree: see "Waiting for Bell to drop the other shoe," p. 82.) What's more, he adds, the circuitry and acoustic engineering call for technology to which the semiconduc-

Electronics / July 6, 1978
Probing the news

The semiconductor industry is not accustomed.

Another newly formed company with ambitious ideas and some familiar names is Telecommunication Corp. of Opelika, Ala. Its market thrust is toward "telephone-oriented products and microprocessor-based telecommunications for the home and office," says W. Roland Matthews, vice president.

Last month the firm took the wraps off the TC 3200 Touch 'n Talk, which has a 32-number memory dialer that can handle up to 16 digits per phone number. The unit is based on a custom 8-bit microprocessor manufactured by Intel using software and programming code developed by Telecomputer. The $189.50 phone has tone- and pulse-dialing capability, emergency dialing capability, and a speaker unit. Housed in an 8.5-by-6-by-2.5-in. package, it is slated to be available in early August.

Genealogy. The firm is an offshoot of Magnetic Electronics Corp. of Opelika, a sister company with a common majority ownership and common founder and board chairman—John H. Orr. In addition to Orr and Matthews, who most recently was a vice president at Magnetic Electronics, the management team includes Doyle Beard, president.

Orr is recognized as a pioneer in the magnetic-tape-recording industry and is credited with bringing the tape formula to the United States after World War II. He formed Orradio Industries in Opelika, which now is Ampex Corp.'s Magnetic Tape division. Beard spent 10 years with Ampex and five with Orrox, a sister firm that makes computerized tape-editing equipment.

By no means a newcomer to the consumer phone market is Allied Telecommunication Equipment Co. of New York, which is now taking orders for its first all-electronic telephone. Its unit, Adonis-G, has two custom ICs, one for voice and one for tone ringing, and has some 120 fewer parts than standard push-button phones. It is manufactured for Allied by Gfeller Telecommunications of Switzerland. The one-piece unit, which will be available in September at $129, includes a silence button to make sure off-phone conversations stay confidential while keeping the line open to an outside party, and a memory circuit that stores the last number called for subsequent automatic redialing.

A unit of Metropolitan Interconnect Telecommunications Inc., Allied's management has been drawn from AT&T, as well as from independent interconnection companies and others that are involved in the design and technical aspects of telecommunications.

Familiar. Some of the established companies looking into the infant market include familiar names in the semiconductor industry. Among them is Fairchild Camera and Instrument Corp. of Mountain View, Calif., which has developed a dialer that has been privately shown to dealers to get their response. There are two versions: one stores 24 numbers, the other 40. Each has two memory chips that perform the first-digit store and scanning.

Before making a plunge into the consumer telephone market, Fairchild is reviewing its potential roles as a supplier of both components and end products, says John Donatoni, marketing director for the firm's Video Products division and the man who is overseeing the telephone project. "From an end-product standpoint, the decision on whether or not to enter the field has been put off until 1979," he says.

Other semiconductor makers see their role as a supplier of chips for the electronic telephones. One firm, General Instrument Corp.'s Microelectronics group in Hicksville, N.Y., has developed the TZ 2000 family of multifunction telephone controllers, based on its 1650 single-chip microcomputer.

The initial TZ 2001 controller converts push-button dialing to a pulse output, displays 12 dialed digits, stores 32 telephone numbers, and has a six-digit real-time clock and elapsed-time indicator, as well as provision for a five-function calculator. "Our products will be geared toward the special-features market," says Ron Hlavinka, GI's manager of telecommunications marketing. "The standard functions that are out there now aren't the only ones the consumer wants."

Meanwhile, the traditional telephone equipment suppliers are not standing still. GTE Automatic Electric Inc.'s Consumer Products division in Northlake, Ill., took the wraps off a miniature electronic phone, called Flip Phone, at the Chicago show and showed prototypes of two other electronic phones.

Other traditional suppliers, such as Stromberg-Carlson Corp. in Sanford, Fla., and International Telephone and Telegraph Corp.'s Consumer Specialty Products division in Clark, N.J., are showing interest in the GI devices. Additionally, Northern Telecom Inc.'s Advanced Telephone Products division in Nashville, Tenn., plans to introduce its first electronic telephone around the first of the year. According to division president Richard W. Lindsay, "Our phone won't just be an electronic replacement for the standard telephone; we'll add features that enhance others that are traditional telecommunications."

Waiting for Bell to drop the other shoe

All this activity and optimism are fine, but the big question for the fledgling electronic home-phone industry remains: What is the Bell System doing?

A spokesman for Western Electric Co., American Telephone & Telegraph's manufacturing and supply arm, notes that the firm employs solid-state technology in three business phones, but declines to comment on efforts in the consumer area. However, he adds, "Bell Laboratories, in cooperation with Western Electric, has been working on the development of new electronic telephones for some time. Research is continuing and we expect to actively apply solid-state technology to other types of phones."

He characterizes the research-and-development effort as intense, but declines to say when the first fruits of that effort will be harvested. Nonetheless, industry observers believe Bell's first features-oriented electronic phone for the consumer market will make its debut next year.
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Round two to VAX: Price/Performance. The 32 bit VAX is the world’s fastest mini. A $141,000 VAX system runs 711 double precision Whetstones. That’s one twelfth the speed — at one twenty-fifth the cost. A dozen VAX systems could equal the throughput of one 7600 — and you’d still save literally millions of dollars.

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E-beam could be the key

British apparently base plans for new memory company
on native expertise in advanced wafer-making technology

by Kevin Smith, London bureau manager

There have been howls of outrage from some in the British semiconductor industry, and there has been skepticism about the possibility of luring British designers working in key Silicon Valley jobs back to the homeland. But as the shape of the United Kingdom's bold plan to enter the random-access-memory race by starting a new company becomes a bit clearer, the move appears to be a shrewd and well-thought-out one.

The National Enterprise Board's idea is to jump into the RAM business at the 64-K level by investing $60 million to $100 million in a new plant in the north of England plus a U.S. operation for marketing and possibly testing. Masterminding the scheme is Richard L. Petritz, president of New Business Resources in Dallas and a former research-and-development director at Texas Instruments Inc.

Hard facts about the scheme are difficult to come by. However, it is believed that Petritz proposes to build the company around six key engineers, preferably British, now working in the U.S. semiconductor industry. Each would chip in $200,000 with the right to purchase up to 5% of the company—tentatively named K-MOS—at a nominal price.

There is also evidence that Petritz' proposal centers around leapfrogging Japanese and U.S. companies by going directly to electron-beam technology to manufacture the precision masks required, significantly an area in which British companies and engineers have a recognized expertise.

What's more, the proposal comes at a time when conventional maskmaking techniques are reaching their theoretical resolution limitations: line widths of 2 to 4 micrometers. "You can just about make a 64-K RAM mask with conventional optical techniques" says Ian Crutwell, general manager of Cambridge Scientific Instruments Ltd.'s electron-beam program, "but it's a lot easier with electron-beam technology, and it's my view that it will be essential for the next generation of 256-K RAMS."

"Because the electron beam is driven by computer from the basic design tapes, reticle manufacture is cut from weeks to hours," he says.

And as an added advantage, the flexibility of the process means that different mask reticles can be incorporated on the same 4-inch-diameter master wafer by changing the electron-beam program after each mechanical step. This can further speed the design process, a factor that could be crucial, since the company has no plans to license a process or a mask design, according to industry reports.

"There are two ways you can go for 256-K parts," Crutwell continues. "You can paint with the electron beam directly onto the wafer, or you can produce electron-beam reticles and get around the diffraction effect which tends to blur the image, by going to X-ray illumination with its wavelength 100 times shorter."

He believes that the direct electron-beam technique is the way to go. But no matter what route wins, it is certain that a company in the leading edge of the memory market must have expertise in electron-beam technology.

Using muscle. The plan also fits some known British strengths. In addition to having supplied Japan's very-large-scale-integration program, the Cambridge group this month delivers the first of three electron-beam machines under the Department of Industry's electron-beam program to the British General Electric Co.'s Hirst Research Laboratories. One initial application for it at Hirst will be to manufacture 625-
Pros and cons

Reaction in Great Britain to the government's plan to spend up to $100 million on a new random-access-memory company has been intense from politicians, industry, and the unions. Initial anger was expressed by Jack Akerman, managing director of Mullard Ltd., over the amount of money involved. On the other hand, Derek Roberts, managing director of Plessey Microsystems, is an ardent advocate of the scheme. He says that, given the right team, the money and the idea are right.

Now, the National Economic Development Office, a body with representation from industry and labor that has not yet seen the detailed proposal, has issued a preliminary report that doesn't condemn the scheme but warns, however, that "it would have to be seen as a long-range option with success evaluated over a five-to-seven-year program. It would require a particularly imaginative and astute plan, with wholehearted government backing to have any chance of success. It would have to concentrate on a few selected items, perhaps memories and microprocessors, where it would be confident of achieving a significant and profitable share of world markets. It would have to attract a particularly talented team of engineers and marketing staff. There are very few such people in Britain and not many throughout the world." Interestingly, Akerman is a member of NEDO, heads a subcommittee and was a member of the working committee on the plan.

line precision masks for GEC's charge-coupled-device imager [Electronics, June 22, p. 63].

So the company probably will be built around advanced electron-beam and ion-implantation technologies. But equally important is the blending for the very first time of an entirely new ingredient in the British microelectronics scene made up of talent and old-fashioned entrepreneurial capitalism, an irony that cannot be lost on the UK's Labour government. In fact, some of the industry anger that greeted the news was based on the belief that the cash could be better used to bolster established companies.

Commenting on the availability of the right talent, Ian Mackintosh, president of Mackintosh Consultants Co., says, "When you have traveled around the U.S. semiconductor industry as much as I have, you begin to realize how many UK engineers have key positions in the U.S. industry." He is convinced that the ingredients are right this time—indeed, his company did a study of the Petritz scheme for the NEDO.

"You need three ingredients for success," he says, "the right people, the right funding, and the right strategy." With regard to the cash, "it's the biggest single venture-capital exercise I have ever heard of as a start-up exercise in the integrated-circuit industry." The one exception he can think of is the defunct Microsystems International operation.

As a possible reason for not founding established companies, Mackintosh says, "Existing UK microcircuit companies are heavily vertically integrated, highly structured operations and are entirely unsuited to the style of freewheeling entrepreneurial management essential to success in the IC industry. "Of the strategy, he says, "It's to go for leading-edge, highly defined products. There's no reason why the company should not be a leading supplier within five years with a $100 million turnover. From that base, it can begin to broaden its product range later."

Dissent. There are other opinions.

Some observers close to the situation believe that the project could founder because of its intention to recruit British nationals now working in the United States and because of its approach to technology. Says one, "There aren't too many UK engineers in the U.S. working on state-of-the-art products right now." As for technology, there is concern that the new firm's apparent insistence on going it alone with its own process rather than licensing technology could be fatal.

In any event, the venture remains a high-risk gamble in the best traditions of the semiconductor industry. It is a gamble that British private enterprise has not taken and it has been left to the government-backed NEDO to do the job.
Probing the news

Consumer electronics

A-m stereo getting mixed reviews

IC makers’ reactions range from raves to pans, even as they prepare for what could be $30 million market

by Robert Brownstein, San Francisco region bureau

With the Federal Communications Commission deliberating about which, if any, of five proposed a-m stereo approaches to bliss, ripples are beginning to spread beyond the receiver makers and touch the manufacturers of the integrated circuits that would be needed. Receiver makers say that each radio would contain $2 to $5 worth of ICs, and 10 million to 12 million auto radios alone are manufactured each year. Add home systems, and the result is an estimated total annual market of at least $20 million to $30 million worth of circuits.

The impetus behind the a-m stereo issue is provided mostly by the National Association of Broadcasters, the National Radio Broadcasters Association, the Electronic Industries Association, and the Institute of Electrical and Electronics Engineers through the National A-M Stereophonic Committee, [Electronics, April 14, 1977, p. 82], with little if any demand for a-m stereo from consumers. The question mark on sales makes some chip makers skeptical; others are unrewarded in their enthusiasm.

Neal Williams, consumer-products marketing manager at Signetics Corp. in Sunnyvale, Calif., is representative of the skeptics, saying flatly, “No one needs a-m stereo.” Nevertheless, his company is researching an a-m stereo IC.

He says Signetics has rejected one of the five approaches, that of the team of Kahn Communications Inc. and Hazeltine Corp., as unwieldy and made a gentleman’s agreement with Sprague Electric Co. of North Adams, Mass., to divide the others. Signetics wound up with the systems submitted by Motorola Inc. and Belar Electronics Laboratory Inc., while Sprague has those of Magnavox Corp. and Harris Broadcast Products. Once an FCC decision comes down, Signetics and Sprague will exchange data and both will produce the chosen design.

Enthusiasm. In contrast with Williams’ view is that of his counterpart at Sprague, Oliver Richards. Richards, manager of radio-circuit development at the Semiconductor division, is enthusiastic about a-m stereo’s prospects. “It’s the first thing that’s happened to a-m in 50 years,” he says, “and it’s nice to see it happening to a stodgy old product.”

The enthusiasm at the Consumer division of National Semiconductor Corp. in Santa Clara, Calif., falls between the responses of Signetics and Sprague. Also, the firm is not working with any other. Instead, says Timothy D. Isbell, consumer linear development manager, “We are going as far as we can with each proposal and will try to shift our efforts to the chosen one to get to the market quickly.”

The problem faced by chip makers is that while there are two basic approaches, the five proposals differ enough so that it is virtually impossible to make a chip that could be used for all by suitable metalization changes. “We could probably do three of the systems with one IC,”

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**Getting together.** One example of a-m stereo implementation is Magnavox’s, shown here. Monaural receivers would still be able to detect the full program, but stereo receivers would separate signals into right and left channels.
says Lawrence R. Sample, radio-IC development engineer at National. "But the other systems might require three separate ICs to implement them." However, Richards believes that Sprague could do any of the systems (except Kahn-Hazeltine) with a single 16-pin device in a dual in-line package.

Still, the major differences are between the two basic systems. One involves amplitude-modulating a transmitter with left-plus-right channel information and simultaneously supplying a second a-m signal, modulated with left-minus-right information but transmitted out of phase with the first—30° out for Harris, 90° out for Motorola and Kahn-Hazeltine. This is a quadrature system (modified quadrature in the Harris case).

The second idea has the left-plus-right a-m signal, as in the quadrature approach, but uses the left-minus-right information to frequency- or phase-modulate the carrier (Magnavox and Belar). In all systems, receiver circuitry will separate the signals into left and right channels, producing a stereophonic effect.

Compatible. As with color television and FM stereo, the a-m stereo systems proposed must be compatible with existing receivers. Monaural a-m radio uses a single-channel audio amplitude that modulates a fixed-frequency carrier. A prospective stereo approach must retain that same full-program a-m carrier format but provide a means to transmit and later separate a dual-channel (left and right) signal. Each of the proposed systems will do so, but in the process, each distorts the original, monaural a-m signal.

One of the standards that the FCC will be called upon to establish is exactly what degree of distortion will be acceptable. It appears that the a-m plus frequency- or phase-modulated systems are more prone to distortion and signal-level sensitivity than the quadrature or modified quadrature designs. However, the quadrature systems are more complex, especially when trying to do it in an economical, discrete form, says Neil Madonick, consumer applications engineer at Signetics.

From a first-order technical standpoint, without regard to implementation, Isbell sees no clear-cut choice. "The specsmanship fight is being waged on the second-order level," he says. Isbell finds that ludicrous in view of the fact that a listener would be hard pressed to hear a difference in a favorable sound environment and could never tell the difference in an automobile, where the product is likely to be used most.

Robert R. Werather, FM transmitter manager at Harris, expects the first a-m stereo receivers will be home-entertainment products. There is more flexibility in doing a discrete design for the more expensive home receivers, while awaiting ICs, than is the case in the under-$200 automobile types, he says. Once ICs are available, he predicts, car units will sell for around $125 versus $180 for FM stereo units. Moreover, he believes the Japanese will market sets for the home for as low as $50.

Good and bad. What are the advantages to the consumer in having an a-m stereo? Assuming most listeners prefer the spatial separation effect obtained with two-channel stereophonic reproduction, the new radios would open up to the listener stereo programming devoid of the multipath distortion and limited range of FM stereo. The disadvantage, more noticeable in the home environment, is that the fidelity of an a-m stereo reproduction would not be as good as that of FM because of the narrower bandwidths needed to house the numerous a-m stations in their lower frequency spectrum.

The FCC's decision, however, may not be technically based, Isbell says. Its choice may depend upon whether it gives more consideration to implementation of the transmitter or of the receiver, but he feels there is plenty of room for politics to creep in from the heavy transmitter makers. He believes that the choice should be keyed to the receiver, although a comprehensive system-level decision would be the least controversial.

There is also the possibility, Williams says, that the FCC may solicitation more proposals or decide that there is no need for a-m stereo. "After all, the public isn't asking for it, the NAB is," he notes. Werather believes, however, that it is in line with the FCC's charter to provide for upgraded services.
Armed with a new generation of Winchester drives, an increasing number of disk-drive manufacturers are taking aim at builders of small computer systems. Their target is a share of that burgeoning original-equipment-manufacturer market.

Those computer makers are always looking for larger-capacity storage units to increase system capability. At the same time, however, they want to squeeze the larger storage units into the cabinets—and prices—of their systems.

Their most popular answer has been cartridge disk drives with capacities of 5 to 20 megabytes and prices ranging from $4,000 to $8,000. But a better solution, say disk-drive makers, is to take the Winchester technology developed for mainframes and offer it in a package similar in both size and price to the small-system cartridge drives but with as much as eight times the storage capacity.

Entries. Some disk makers, such as Control Data Corp. in Minneapolis, Memorex Corp. of Santa Clara, Calif., and Kennedy Co. of Altadena, Calif., introduced Winchester drives over a year ago. Now, in the past three months, the number of small-system Winchester disk suppliers has more than doubled.

The new entries range from 14- and 20-megabyte units priced under $1,500 but offering a relatively slow 87-millisecond average access time to 170-megabyte drives selling for $4,500 and operating at the typical mainframe average access time of 35 ms. The manufacturers of all these units claim that the higher recording densities and sealed head-disk assemblies used in Winchester drives (see "What's a Winchester?") substantially improve the price-per-byte of storage and drive reliability.

"Winchester technology allows us to put more capacity per disk surface than with 3330 technology," explains Norman Petersen, vice president for OEM marketing at Storage Technology Corp. "That means we can use fewer parts and get lower costs, thereby giving us price-per-byte advantages over cartridge disk drives." The Louisville, Colo., company recently introduced its model 2700 disk drive (see p. 149) with storage capacities of 33, 80, or 170 megabytes at prices ranging from $3,000 to $4,500 in quantities of 100 or more.

Reliable. Also introduced recently was Ampex Corp.'s DF-900 drive with capacities up to 87.8 megabytes selling for up to $3,650 [Electronics, June 8, p. 230]. Larry Sarisky, Winchester product manager for the Redwood City, Calif., company, maintains that the new generation of drives offers the customer increased reliability.

"As hardware costs are decreasing, the price of service is going up. Winchester disks require no scheduled maintenance and offer increased reliability because of the sealed head-disk assembly, and the fixed nature of the media removes
The dawn of high performance, low cost counter timers.

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The design and planning of a new series of minicomputers is a difficult problem, especially for a company with a large installed base of a highly successful family. And the problem is greatly magnified when the proposal is for the new family to overstep what were earlier regarded as a minicomputer's limits.

Thus, when Digital Equipment Corp. decided to extend its line into 32-bit mainframe territory, it set in motion a series of complex design decisions requiring a thoroughgoing reexamination of minicomputer architecture in the light both of likely user needs through the 1980s and of likely technological progress through the same period.

This article addresses some of the issues that guided the development of the VAX-11 architecture, the VAX-11/780 computer system, and the VAX/VMS operating system. The goal was to preserve compatibility with the existing large software investment in the PDP-11 minicomputer family yet to reflect future system needs, in particular by enlarging virtual address space to a huge 4 gigabytes. VAX, in fact, stands for virtual address extension, and VMS stands for virtual memory system.

The VAX-11/780 32-bit minicomputer system is the high end of the new family. A typical configuration costs between $150,000 and $200,000. Initial benchmarks show the machine's Fortran performance, using its fast-floating-point option, to be comparable to that of a modern upper-to-middle-range mainframe costing several times as much. Yet processor, optional floating-point unit, up to 1 megabyte of metal-oxide-semiconductor random-access memory, a Unibus medium-speed input/output controller, and two high-speed (Massbus) I/O controllers come in a single cabinet measuring 47 by 60 by 30 inches (Fig. 1). More memory and various options can be added in extender cabinets.

Parts

All this was implemented with conventional Schottky transistor-transistor logic and standard large-scale integrated memory circuits. Indeed, it was the ready availability of fast, high-density read-only memory that made it possible to design a complex processor without resort-
tions previously available only to mainframe computers. Examples are full virtual-memory management, demand paging, indexed data-access methods, and extensive interjob protection and sharing capabilities. **VAX/VMS** supports up to 64 on-line users simultaneously developing and executing programs in assorted high-level languages. In particular, a compiler for DEC's Fortran IV-Plus language (a superset of ANSI Fortran) has been developed to take full advantage of the extended instruction set of the VAX-11 architecture.

**Compatibility with the PDP-11**

Though the VAX-11/780 is not a 32-bit PDP-11, for reasons that will shortly be gone into at length, cost-saving compatibility with the PDP-11 and its associated software has been achieved as desired at the six most relevant user levels:

- **Cultural compatibility,** if such a term may be used to describe the stylistic similarity of the machines. Because of it, PDP-11 programmers can produce high-quality VAX-11 native-mode code with little training, and language compiler designs that generate PDP-11 code can be adapted to generate efficient VAX-11 code.
- **Operating-system compatibility.** Many of the **VAX/VMS** operating-system functions were modeled after the PDP-11 RSX operating systems (for example, in the type and form of system calls, the way in which tasks synchronize with each other and exchange data, etc.). Key **VAX/VMS** functions, such as the file system and record management facilities, are functionally identical to their RSX counterparts.
- **High-level language compatibility.** VAX-11 languages are designed to be compatible with the existing PDP-11 compilers. A calculation program written in Fortran IV-Plus for the PDP-11 runs unchanged on VAX-11.
- **Direct processor support for user-mode PDP-11 programs.** The VAX-11 architecture includes a PDP-11 compatibility mode, in which the processor behaves just like a user-mode PDP-11, except that it can simultaneously run 32-bit code jobs.
- **Data compatibility.** All PDP-11 data formats were brought forward to the VAX-11 architecture.
- **Data-file compatibility.** **VAX/VMS** is able to create and access disk files that are compatible with the PDP-11 RSX-11 operating systems.

**Why not a 32-bit PDP-11?**

During planning of the VAX-11, one idea that received serious consideration was in fact a 32-bit PDP-11. Most of the PDP-11 architecture is already independent of word length, and recent architectural studies had demonstrated that the PDP-11 is a bit-efficient architecture, even compared with mainframe architectures. In short, a PDP-11-like machine with an extended virtual address space would evidently be an attractive computer, today and tomorrow.

The most distinctive attribute of the PDP-11, and the basis for its architectural power, is the flexible way in which its registers can be used to form addresses. This flexibility permits the machine to be used effectively for many different types of computing, unlike most previous architectures, which tended to be good for one style of

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processing but poor for another. For example, a design that has many central registers but not stack-like characteristics is good for scientific calculation but poor for complex subroutine structures. Conversely, a machine designed around a stack architecture is good for program control but inefficient for intensive calculation. But the PDP-11 is able to take on either set of attributes, and others, whenever a task demands it.

However, a 32-bit PDP-11 would have meant extending the register width to 32 bits but keeping the instruction formats and encodings unchanged, and this turned out to be an impossibility. The idea would have been a machine that could execute existing PDP-11 machine code intermingled with 32-bit code that made full use of the 4-gigabyte virtual address space. But a careful examination of a 32-bit version of the PDP-11 uncovered some unsurmountable obstacles.

There turn out to be many ways in which a programmer can implicitly design the address length into a program. For example, before control is passed to a subroutine, parameters may be pushed onto the stack. The subroutine call itself leaves the return address on the top of the stack. Within the subroutine, the parameters are accessed with respect to a known displacement from the top of the stack. But unfortunately, changing the address length from 2 to 4 bytes makes these known offsets invalid. This and many similar problems ruled out the possibility of executing 16-bit code unchanged in a larger address space, or of automatically translating 16-bit programs into a 32-bit form.

Given the difficulties of directly extending the PDP-11 design to a 32-bit form, the next alternative was to see what improvements could be gained by a bit-level-incompatible, but otherwise highly similar, design. The result was the VAX-11, a substantially better design that, though not precisely like the PDP-11, is "culturally compatible" with it. Hardware and software were also developed that permit a large subset of existing PDP-11 programs to execute without any changes on a VAX-11 system, as described earlier.

Architectures and word lengths

The description of the VAX-11 as a 32-bit minicomputer and the PDP-11 as a 16-bit minicomputer implies that the essential difference between them is their word length. But any significant difference in the architectures would presumably be measurable in terms of their comparative bit efficiencies on important applications. As it turns out, the bit efficiency of the PDP-11 is excellent, and in most respects the PDP-11 is not restricted to a 16-bit word length.

The problem is that the term "word length" has too many meanings to be useful without qualification. In a typical computer system, many different word lengths can be identified. In this context, therefore, it is necessary to eliminate from consideration the word lengths that represent engineering decisions for specific implementations and to consider only those that are intrinsic to an architecture and affect all its implementations in the family.

Instruction length is a possible candidate here. But both the PDP-11 and the VAX-11 have instructions of variable length, ranging from 16 to 48 bits and 8 to 296 bits respectively. In both cases, the variable-length instruction format offers better bit efficiency than an equal-length format because common instructions can
The importance of bit efficiency

A good architecture is reflected in a computer's static and dynamic bit efficiency. Bit efficiency is a quantifiable measure of how well the investment in the computer system's components pays off in application-level throughput. In other words, if two systems are built with the same technology and the same complexity, then the one with the greater bit efficiency will be more cost-effective (assuming that the bit-efficient instructions can still be rapidly decoded and executed by the processor).

Static bit efficiency is the relative size of a program compared with the size of a program coded for an architecture defined as a standard. A good static bit efficiency reduces the requirements for central memory and program file storage and streamlines the tasks involved in program-moving overhead, such as initial program loading, fetching overlays, paging, or swapping.

Dynamic bit efficiency is a comparative measure of how many program bits must be fetched from memory to the processor to execute a program. If all machine instructions were used with the same frequency, then static and dynamic bit efficiency would be the same. In practice, some instructions and data types occur often and others occur rarely. Good dynamic bit efficiency reflects the fact that the most frequent instructions (such as loop control instructions) have particularly good encoding.

The ideal way to compare bit efficiencies would be to take a specific set of application programs and measure their actual bit efficiencies on different architectures. Unfortunately, such an approach is impractical for a computer vendor because customers have many disparate applications and many architectures of interest are hypothetical.

Fortunately, there are ways to characterize typical applications. Those coded in common high-level languages, such as Fortran, Cobol, and Basic, may be related to studies of typical program behavior, which show that in each of these languages different statements and data types have a characteristic frequency of occurrence. With these statistics and with an understanding of the machine code generated for each common statement, it is possible to estimate the bit efficiency of real or hypothetical architectures.

Bit efficiency is a good general test of architectural effectiveness, since it diminishes with any difficulty in machine-level programming or compiler code generation. Good static bit efficiency reflects effective use of system components; good dynamic bit efficiency reflects effective use of memory system bandwidth.

have shorter encodings. No architecturally useful definition of word length can be derived from instruction length, therefore.

Both the PDP-11 and VAX-11 are byte-address machines, since all data types are addressed in main memory by the byte address at the beginning of the data item, regardless of whether the data is a 1-byte character or an 8-byte double-precision, floating-point number. So memory addressing is also no help in defining the architectural difference between the machines.

But the PDP-11 has 16-bit general registers, whereas the VAX-11 has 32-bit general registers. In both architectures the registers can be used for arithmetic on data items that are shorter than the register size (8-bit integers on the PDP-11, 8- and 16-bit integers on VAX-11) or can be used in multiples for data items that are longer than the register size. Register length as used in arithmetic is not an invariable word length, therefore.

Register length

However, register length as used in instruction address formation is another matter: it does define the essential difference between the PDP-11 and the VAX-11, since it determines the size of logical storage that a program can instantaneously address—the size of the virtual address space. Thus the PDP-11's 16-bit byte address creates a virtual address space of 65,536 bytes, whereas the VAX-11's 32-bit byte address creates more than 4 billion bytes of virtual address space. What's more, virtual address space limitations can affect bit efficiency.

At the time the PDP-11 was designed, it seemed unlikely that any minicomputer would need more than 65 kilobytes of physical (as opposed to virtual) memory. In retrospect, the designers realize they failed to anticipate how rapidly central memory costs would decline.

Early in the evolution of the PDP-11 family, hardware memory mapping was added to the top-range machines. PDP-11 mapping logically divides the 64-k virtual address space into eight 8-k pages, each of which can be located independently in physical memory and protected independently (Fig. 2).

The addition of mapping offered two major benefits:

- It permitted the design of multiprogramming software systems in which a user program is prevented from damaging another user program or the operating system code, since each program can address only those parts of central memory allocated to it.
- It permitted the design of configurations with more than 65 kilobytes of physical memory, since the mapping hardware can translate 16-bit addresses into physical memory addresses of arbitrary length. Thus a PDP-11/70 may have in excess of 4 million bytes of central memory by developing 22-bit addresses.

For most applications, the remapping overhead is insignificant. But there are calculation applications in which it induces noticeable bit inefficiency. Also, although today most minicomputer programs and their data fit naturally into a 65-kilobyte address space, the trend to larger central memories will surely lead to larger program sizes as well.

The need for large address space

Consequently, though the immense marketplace success of the PDP-11 and other minicomputer architectures demonstrates that limited address space has not so far been felt as a restriction, it might become one in the future. Since the need for large address space is felt first in large configurations, the VAX-11/780 was designed as a top-of-the-line minicomputer.

The fundamental need of VAX-11 was to solve the
addressing problem. Given the byte orientation of the PDP-11 and the need to do address arithmetic conveniently, the obvious address lengths to explore were 24 bits (16 + 8), 32 bits (16 + 8 + 8), etc.

Memory costs are roughly halving each year, and 1 more bit of physical address per year is needed. A 24-bit virtual address seemed too small. For VAX-11 the choice was 32 bits, representing a 4-gigabyte virtual address space (see Fig. 2 again). The next decision was to make this address space linearly addressable, meaning that there would be no further segmentation (many mainframes offer comparably large virtual address spaces but break them into many segments). This is large by any standard today, including mainframes, and should also allow a good decade of growth before the size of typical physical memories comes anywhere near the virtual address space. The very large, linear, virtual address space will also permit flexible evolution in software system design techniques, that should prove needed, for example, in advanced file or data-base management system designs.

Picking the virtual address size was a key decision, but a simple one compared with the total question of virtual memory design. Other issues included:

- Feasibility. It had to be possible to implement without adding a large cost penalty to the processor.
- Functionality. It had to be able to support sophisticated data-processing applications.
- Efficient use of control memory. The VAX-11 architecture had to exhibit a wide range of system performance without requiring large amounts of central memory for control tables.
- System efficiency. A virtual memory design would have to work well in real-time applications, yet be able to switch rapidly from one program to another while responding to external requests.

A 32-bit virtual memory design is totally different from a 16-bit one. For example, mapping a 65-kilobyte PDP-11 program consists of initializing eight internal processor registers. In contrast, mapping a 4-gigabyte address space would mean specifying 8 million page relocations (on VAX-11, each page or separately mappable unit of virtual memory is 512 bytes). Obviously, no VAX-11 processor will have 8 million internal relocation registers!

Similarly, the operating system on a PDP-11 does little in the way of virtual memory management. Because programs are relatively small, they are typically swapped in and out in their entirety. But the large virtual address space on VAX-11 encourages programmers to build large, logically connected programs that may well be much bigger than the physical memory of the system. For example, a large computation that had previously been structured in overlays will simply be a big program on VAX-11. But making the virtual memory useful to the application programmer means that the operating system has to be much more active in deciding which pieces of an application program should be kept in central memory and which should be kept on disk-backing storage (called working-set management). This in turn means that the mapping mechanism must be efficiently controlled by operating system code and must provide as much useful information about the dynamic usage of virtual memory as possible.

Sharing virtual memory space

A key feature of the VAX-11 virtual memory design, which leads to efficient use of central memory and low overhead during execution, is the way in which the operating system shares virtual memory space with user processes. The entire 4-gigabyte virtual address space is logically divided into halves. The user process is limited to the use of the bottom half, and most of the operating-system code resides in the top half (Fig. 3). (Remember that this is just virtual memory; the decision about what virtual memory is made resident in central memory, including operating-system code, is made dynamically on the basis of actual need.) The mapping of each user process may be unique, or user processes may share program and data pages with one another, but in either
case the same virtual operating system is mapped with each user process.

Putting the operating system into a single address space rather than having pieces of the system code in multiple address spaces minimizes the need for system mapping control tables and makes intersystem communication more efficient. Having the operating system share the virtual address space of each user process simplifies requesting services from the operating system. The high-speed processor translation caches, which store the most recently used mapping translations, treat system and user mapping separately so that system mapping translations stay in the cache when the operating system switches to another user process, but the user translations are flushed out.

In a simple memory scheme, it would be risky to put the user programs in the same address space as the operating system, since their malfunctions could affect the system operation. In VAX-11, the system is totally protected from this by a separate access control mechanism. The processor executes in one of four modes:

- Kernel, for interrupt processing, physical I/O control, processor scheduling, and the like.
- Executive, for file management and similar functions.
- Supervisor, for functions such as interactive command processing.
- User, in which user programs are executed.

The accessibility of each page in the virtual memory space (whether the page can be read, written, or both) can be controlled for each of the processor execution modes. Thus the operating system can keep critical data in the user's address space and can access that data freely during execution of an operating system service (during which the processor runs in a more privileged mode), and yet the user's program may be restricted from reading the data, if that is inappropriate.

Compatibility mode

The VAX-11 user mode can be put into a compatibility mode, which makes it capable of executing many PDP-11 programs often faster than the PDP-11/70, the top-of-the-line PDP-11. The efficiency of PDP-11 emulation is due to the strong cultural compatibility between VAX-11 and the PDP-11. Thus a processor designed to perform VAX-11 instructions efficiently can also perform PDP-11 instructions well. Instruction execution of the VAX-11/780 is implemented with microcode (as is true of most computers today); PDP-11 compatibility-mode emulation was primarily implemented with a 10% increment of microcode.

This VAX-11/PDP-11 compatibility mode is worth exploring in some detail. Some earlier "compatible" emulation modes required that the computer be used only in one mode at a time. But although 16- and 32-bit code cannot be freely mingled within a single program on the VAX-11, compatibility-mode jobs and native jobs can run at the same time, sharing the resources of the VAX/VMS multiprogramming system. The two kinds of jobs can even cooperate with each other by exchanging messages or by sharing files.

Emulation modes have also been used in the past in the place of software development for the new architecture. However, in the case of VAX-11, the power of the enormous virtual address space and new instructions were intrinsic to the value of the system. So there seemed to be little value in a hardware-supported compatibility mode that would execute a complete PDP-11 operating system. Instead, as already indicated, the compatibility mode is limited to user-mode programs. Those operating-system utilities that are insensitive to the size of the address space have been taken from the earlier family's
RSX-11M operating system and execute in compatibility mode transparently to the user.

The application migration executive is a subroutine package provided with VAX/VMS that emulates RSX-11M operating support for PDP-11 programs running in the VAX-11/PDP-11 compatibility mode. VAX/VMS has been designed to transfer control to the AME within 50 microseconds on the VAX-11/780 when a PDP-11 compatibility-mode program requests operating-system services. The AME executes as a VAX-11 program, in a 32-bit address space that includes the 16-bit address space of the PDP-11 program. The AME determines which RSX-11M system call is being requested by a PDP-11 program, translates it into VAX/VMS format, and issues the request to VAX/VMS. When control returns to the AME, it translates the results into RSX-11M format, stores the result in the compatibility-mode program data, and then returns control to the PDP-11 program via a VAX/VMS service.

Translators

Use of the AME permits a large collection of the RSX-11M programs to run unchanged on VAX-11 systems under VAX/VMS. Although the AME translates RSX-11M system calls, a similar program could be written to translate calls of other PDP-11 operating systems. A single VAX/VMS system could, theoretically, have translators for multiple PDP-11 operating systems.

The efficiency of compatibility-mode program execution under such a translator depends on how heavily the program uses operating-system facilities and how different the emulated operating system was from RSX-11M and VAX/VMS. Although the translation adds some overhead, the typical VAX/VMS service is faster than RSX-11M (run on a PDP-11/70) because of the increased functionality of the VAX-11. On balance, emulated PDP-11 programs run about as fast as they would in the PDP-11/70 under RSX-11M.

The PDP-11 was designed with 8 general-purpose registers. Since then, the cost increment of additional processor registers has gone down dramatically, and the VAX-11 was given 16. Apart from cost, the penalties for additional registers are a need for extra system overhead to perform context switching and a reduction in bit-efficiency, since more bits are required to address a register. Nevertheless, these extra registers do provide better compiler optimization of generated code, lower overhead in subroutine usage, and efficient design of complex instructions.

The strength of the PDP-11 architecture is its inclusion of the best features of stack, multiple-register, and memory-to-memory designs because of the versatile way in which its general registers can be used to develop addresses. VAX-11 added to these addressing modes to increase the efficiency of program indexing into those tables that list multiple-byte data items like 4-byte floating-point values or 8-byte integers.

In the last decade the processing capacity of minicomputer systems has increased to the point where they are patently unsuited for very few applications. To support efficiently all likely forms of processing, new data types (forms of data for which processor instructions exist) were added to VAX-11, as shown in the table. VAX-11 implicitly does 32-bit address arithmetic, and instructions were added for explicit 32-bit integer arithmetic and Boolean logic.

Decimal arithmetic

Thirdly, VAX-11 permits arithmetic to be done directly in decimal form, instead of requiring that it be converted to binary form, to ensure that full data precision is retained, and because such data is more often moved intact between data records than used for calculation. Still other new data types are test string manipulation (where strings of characters can be moved, translated, and searched with specific instructions) and a complex editing instruction (to provide for the kinds of manipulations common in generating the typical data-processing report—for example, editing out leading zeros or adding a dollar sign). On VAX-11, direct processor support for 1- to 32-bit data fields has been implemented, increasing the bit efficiency of critical
The economics of compatibility

The last thing a computer user wants to do is to rewrite an existing program for a new hardware design. He would rather develop new software for all the profitable new applications it opens up. After all, if the hardware is costing him less, the cost of programming is still as high as ever. Worse yet, it may even be rising, since the number of computers to be programmed appears to be growing faster than the population of skilled programmers.

In view of this, a major design focus for the VAX-11 architecture was compatibility with the PDP-11. Accurate statistics are not available, but if as little as $20,000 has been spent for software for each of the 50,000 PDP-11s produced this far, then the total investment is $1 billion. Surely, this is a conservative estimate when it is remembered that $20,000 buys only a small amount of code.

The size of the entire existing investment in software is incomparably larger, and the need to preserve it might already have halted innovation in the computer industry were it not for the phenomenal rapidity with which computer technology is evolving. The new markets and applications continuously being opened up force architectural changes that compel some level of innovation even at the price of a devalued software investment. Nevertheless, the point has seemingly been reached at which no new computer—mainframe, mini or micro—can be designed without careful examination of the compatibility issue. Barring some remarkable breakthrough in software engineering, compatibility will continue to grow in importance.

Operating-system code and like programs. Since field-bit position is specified by a 32-bit integer, very large (512-megabyte) structures can be linearly bit-addressed.

Although most of the added instructions were in support of the data types listed above, many other special instructions were added for operating system support, user programming support, and specific computation needs. For example, an instruction, POLY, has been provided to compute polynomial equations of the form:

\[
y = C_1 + C_2x + C_3x^2 + \ldots
\]

in a single instruction, with the loop overhead handled in microcode. This instruction substantially speeds up the calculation of standard numerical approximation, such as the calculation of sine and cosine functions within a Fortran run-time library.

Future minicomputers

The implications of all these capabilities for the future of the VAX-11 minicomputer family can readily be assessed. The yardstick may be inferred from the apparently constant rates of improvements in base technologies like semiconductors and magnetics and from computer designers' rules of thumb. For example, in a typical system the number of bytes of central memory is about equal to the number of instructions per second by the central processor. Such a system must also be capable of performing 1 bit of I/O for each instruction executed (these rules are sometimes attributed to Gene Amdahl). For any year in the near future, the technologies' price prediction for computer subsystems may be combined with the designers' predictions of the appearance of a balanced system, the constant price definition of minicomputers applied, and the range of expectable system configurations thus delimited.

Following such logic, a minicomputer priced at $50,000 in the early 1980s should look much like today's mainframe in gross capability, having on the order of a million bytes of central memory, hundreds of millions of bytes of disk storage, and so on. That prediction, made some years ago, led to the VAX-11 design project and the development of the VAX-11/780.
Single-supply erasable PROM saves power with C-MOS process

New ultraviolet-erasable 4-k programmable read-only memory uses p-channel floating-gate technology for superior speed-power product

by Gopal Ramachandran, Intersil Inc., Cupertino, Calif.

The erasable programmable read-only memory has quickly found its niche as a nonvolatile temporary storage medium. Such devices, built with either n- or p-channel metal-oxide-semiconductor technology, have served well in prototyping microprocessor-based systems. To enhance their usefulness in development and to extend their use into low-run production systems, the next design step is to move beyond these single-channel floating-gate erasable PROMs to an easy-to-use, low-power, complementary-MOS part that needs only a single-ended voltage supply.

Thus the ultraviolet-erasable 6603 and 6604 have come about. The superior speed-power product of C-MOS is the key to the new 4,096-bit parts—they have a quiescent current of only a few microamperes and, even when cycling at 500 nanoseconds, draw just a few milliampere from a 5-volt supply.

The floating-gate avalanche-injection MOS transistor and its stacked-gate cousin, the fundamental storage units in all previous UV-erasable PROMs, have proven reliable in both p-type configurations (the 1702A, for example) and n-type configurations (the 2708 and 2716, for example). So the decision was made to use the p-MOS device in the C-MOS design (see "The p-channel floating gate in a C-MOS PROM").

One significant need that the 6603/04 will fill is in the

1. Two arrays. This 4,096-bit complementary-MOS erasable programmable read-only memory contains two 64-by-32-bit subarrays. The metal masking in the device's fabrication determines whether the chip is organized as 1,024 by 4 bits (the 6603) or 512 by 8 bits (the 6604).
The p-channel floating gate in a C-MOS PROM

Since the 6603/04 parts are built with complementary-metal-oxide-semiconductor technology, the floating-gate device that actually does the storing could be n-channel or p-channel material. The 1702 erasable programmable read-only memory, which has a 512-by-8-bit organization, is built with the p-channel floating-gate transistor shown at the left. The 2708 and 2716 erasable PROMs, which are 1,024-by-8- and 2,048-by-8-bit arrays, use the n-channel dual-polysilicon technology shown on the right. Intersil settled on the p-channel floating-gate transistor for the 6603/04 because of the simpler process required.

An early requirement was that the 6603/04 had to use conservative design rules and run on a standard high-volume, well-documented low-threshold ion-implanted silicon-gate C-MOS process. The idea was to bring a readily manufacturable part to market quickly, then introduce enhancements as improved C-MOS processes came to the production line.

Such an improvement is scheduled for high volume soon—a new shallow-junction selective-oxidation process called Selox C. The process has already yielded two- to threefold improvements in access time for 1,024-bit random-access memories. What’s more, the tightening of design rules and alignment tolerances coupled with optical-mask shanks and improved double-layer polysilicon processes that together have contributed to cost, performance, and density improvements in random-access memories will soon be applied to C-MOS erasable-programmable-read-only-memory products, which are still in their infancy.

development of systems using single-supply C-MOS microprocessors. Until now, the designer has been faced with prototyping with power-hungry bipolar PROMs, or single-channel MOS PROMs requiring several supply voltages, or fusible-link C-MOS PROMs that lacked sufficient density and cannot be reused.

Organization

A metal-mask option configures the 4,096-bit devices (Fig. 1) either as a 6603, organized as 1,024 by 4 bits, or as a 6604, which is 512 by 8 bits. The memory elements in the 6603/04 are arranged as two 64-by-32-bit subarrays separated by row-address decoding logic.

Both devices have a 10-bit internal address latch. The six address bits, A₁ through A₆, are used by the central row-address decoder to select one of 64 rows. Similarly, the column decoders use A₇ through A₁₀ to select one of eight columns, which are connected to each of the eight sense amplifiers and data input/output buffers.

In the 6603, the 10th bit (A₁₀) is used as an odd/even select to steer data to and from the array. Since A₁₀ activates alternate columns and sense amplifiers, only 4 bits at a time are read out of the array, making it effectively appear twice as deep: 1,024 bits instead of two 512-bit arrays. The 6604 needs only 9 bits for addressing, so it treats the 10th bit as a latched chip-enable input.

The two devices have an on-chip address register permitting use with bus-organized systems that multiplex data and addresses. As shown in the timing diagram of Fig. 2, valid address-line levels are required within a hold time following the falling edge of the strobe line, STᵣ. Because of the very fast regenerative address buffering, address-setup time is specified to be zero; in fact, it is a negative time—the address can be presented after the strobe line falls, because of the differences in logic delays in STᵣ and address-input paths.

Operation

The 6604's chip enable treated as an address input is latched and activates the chip if it is low. In addition, a fast chip-select circuit ensures that CS decoders may be used with an array of erasable PROMs with no sacrifice in access time.

The STᵣ line need only be low for the duration of an access. As soon as the microprocessor has acquired the
2. No setup. The very fast regenerative buffering used in the 6603/4 erasable programmable read-only memory means that valid address lines can be presented after the falling edge of the strobe line. Thus, setup time for addresses is actually negative.

4. Programming. Once an address is strobed in, the cell is read to ensure it is not already programmed. When the chip select goes high, data is presented to the I/O lines. Pulsing the chip's program pin negatively from 10 V to -40 V stores the data.

3. Address register. When the buffered address register's strobe line is high, complementary outputs A and A̅ are both initially high. When STR falls, the circuit becomes extremely sensitive to the input signal A, and the high loop gain causes it to latch. As the strobe line can return high and subsequently cause the outputs to go to a high-impedance mode; however, it must remain high long enough for all columns to precharge.

**Address registers**

The very fast buffered address latch (Fig. 3) means, in typical devices, addresses need be stable only in a 10-ns window at 25°C for a supply of 10 V. When its STR goes low, Q1 and Q2 turn off, and p-type transistor Q3 turns on, activating the latch. Because of its high loop gain, the latch is extremely sensitive to input-level changes. Its switching threshold is determined by the reference voltage, VR, which is generated on chip; hysteresis depends on design variables and lateral asymmetry in the circuit.

When STR is high, n-type transistors Q4 and Q5 are
conducted and thus connect the drains of the input and reference transistors Q₀ and Q₁ to the latch. These transistors have no effect, however, until STR falls. Then the feedback latches the input address. Further transitions are incapable of switching the latch, and the address decoders are thus driven by complementary outputs A and X.

**Programming**

A 10-v supply must be used to drive the array when programming, though both erasable PROMs can operate at 5-V. The READ-PROGRAM-VERIFY sequence of Fig. 4 shows that in both programming and reading, a cell is addressed by strobing the desired address in. Reading the location verifies that it is unprogrammed; STR is left low to ensure that the address does not change and then the chip is deselected. When CS goes high, the data-output buffers turn off and the program data may be presented to the input/output pins.

With data at the i/o pins, the program pin is pulsed negatively from 10 v to -40 v, which alters the threshold of the floating-gate transistor in each cell and stores the data. The next positive strobe pulse is especially important, as it precharges the selected line up from somewhere below ground to the level for proper read operation. Exposure of the array to high-intensity UV light generates photocurrents that discharge the floating gates for reuse.

**Operation**

The C-MOS design differs significantly from other erasable-PROM configurations, as the simplified schematic of one of the floating-gate memory cells and its associated programming and data-sensing circuitry in Fig. 5 shows. When the strobe line is high, both complementary address-register outputs are high for all 10 bits (9 address bits and CE in the 6604). Decoder Y outputs will be low; Y and X lines will be high.

These conditions ensure that p-channel devices Q₉ and Q₁₁, which connect the column to the sense amp and the programming cell, and the p-channel cell-select transistor Q₈ will all be off, thus isolating all column lines. Because the strobe line is high, STR is low, causing the column lines to be precharged to a known level.

A minimum positive strobe pulse width is important, since too small a pulse will not allow all lines to be uniformly precharged. If the column has not been allowed sufficient precharge time, a subsequent read from any of its memory cells may not yield valid data if the cell tried to discharge the column toward ground (the cell contained a 0).

On the other hand, the minimum access time is set by the maximum time required to allow a cell to charge a properly recharged column up to the level at which the sense amp can acquire it. This time depends on column-line capacitance, sense-amp gain, column resistance, transistor thresholds, and other factors.

With the strobe line high, the column is disconnected from the sense amp. Also, in the sense amp, the feedback loop of the data latch is broken by the turning off of the p-channel transistor Q₁₂, and the internal data output bus is high. Once the strobe line falls, internally gener-
ated clocks time the following series of events:

- The address is latched.
- The address decoders are activated and a single word is selected to drive the columns.
- The columns are corrected to the sense amps, and the data is latched internally after an access time.
- If the chip is selected, the output-data buffers are turned on, and the internal data latch drives the outside world through transmission gates. If \( V_{DD} \) is less than \( V_{DS} \), level translation also takes place.

**Further features**

The buffered address latch can work with many logic levels because it has been designed so that the input switching threshold varies very little with supply voltage. For a supply range of 2 to 12 volts, the minimum voltage that is needed to operate the latch varies only from about 1.6 to 2.6 volts.

However, the 6603/04 are specified at a minimum of 2.7 volts over their standard operating range. This specification allows the user to supply a higher drain voltage for fast access and still drive the address lines with open-collector transistor-transistor-logic gates and resistive pullups to 5 volts. Even TTL gates with totem-pole outputs will drive the address lines satisfactorily. When loaded by the 1-\( \mu A \) C-MOS inputs, their output high level is 3.5 volts; the 2.4-v level guaranteed by TTL assumes a much heavier load of 10 TTL inputs, or 400 \( \mu A \).

For a setup in which the address inputs are being driven by transistor-transistor logic, the data output can also be made TTL-compatible by tying pin 24 to a 5-v supply. The output drivers are transmission gates switching either ground or the \( V_{DD} \) supply, and they are independent of the drain voltage that powers the memory array. Of course, by connecting \( V_{DD} \) and \( V_{SS} \) together, an all C-MOS system is also possible. To take full advantage of high-speed operation while maintaining a TTL interface at the inputs and outputs, the strobe and chip-select lines should be driven by fast level translators, since they require the standard C-MOS threshold voltage of 5 volts.

The main advantage of C-MOS is, of course, its low power dissipation. The quiescent power in the 6604/03...
TABLE 1: COMPARING POWER DISSIPATIONS

<table>
<thead>
<tr>
<th></th>
<th>Quiescent power per bit</th>
<th>450 ns cycle, 25°C active power per bit</th>
</tr>
</thead>
<tbody>
<tr>
<td>1702A (2,048 bits)</td>
<td>160 nW</td>
<td>160 nW*</td>
</tr>
<tr>
<td>6603/04 at 5 V (4,096 bits)</td>
<td>0.0016 nW</td>
<td>2 - 8 nW</td>
</tr>
<tr>
<td>2704 (4,096 bits)</td>
<td>145 nW</td>
<td>145 nW</td>
</tr>
<tr>
<td>2708 (8,192 bits)</td>
<td>72 nW</td>
<td>72 nW</td>
</tr>
<tr>
<td>2716 (16,348 bits)</td>
<td>3 nW</td>
<td>17 nW</td>
</tr>
</tbody>
</table>

*500-ns cycle time

TABLE 2: COMPARISON OF POWER DISSIPATION IN A 32,768-WORD MEMORY ARRAY

<table>
<thead>
<tr>
<th></th>
<th>2716</th>
<th>6604</th>
</tr>
</thead>
<tbody>
<tr>
<td>32-K-by-16-bit, 1-μs cycle time, 5-volt supply</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Total number of devices</td>
<td>32</td>
<td>128</td>
</tr>
<tr>
<td>Standby power per device (P_S)</td>
<td>50 mW</td>
<td>6 μW</td>
</tr>
<tr>
<td>Active power per device (P_A)</td>
<td>285 mW</td>
<td>4 - 16 mW</td>
</tr>
<tr>
<td>Total array power</td>
<td>30 P_S + 2 P_A = 2,070 mW</td>
<td>126 P_S + 2 P_A = 9 to 33 mW</td>
</tr>
</tbody>
</table>

The chip. Both the 1,024-by-4-bit 663 and the 512-by-8-bit 6604 erasable PROMs use the same 167-by-180-mil silicon chip. The devices are housed in 24-pin packages with transparent lids that facilitate erasing of stored data with an ultraviolet lamp.

works out to a little more than 1 nanowatt per bit for a 5-V supply. When the device is cycling at 500 ns, the consumption climbs to 2 and 8 microwatts per bit.

The quiescent and active power dissipations of a variety of erasable PROMs are shown in Table 1. The p-channel 1702A, which uses a floating gate similar to the one in the 6604/03, is listed, even though its cycle time is 1,500 ns. It is the earliest erasable PROM made and draws the most power. The 2704, 2708, and 2716 use a more complex n-channel stacked-gate cell. What's more, most other erasable PROMs require multiple power supplies, while the 6603/04 require only one.

In use

A microprocessor-based programmer for the 6603/04 best illustrates the sequence of operations involved. Built around Intersil's 6100 processor, the programmer (Fig. 6) uses a monitor ROM that allows an ASCII terminal to be used to enter, edit, run, and debug programs. Other parts provide interfacing with a terminal and paper-tape reader.

Three 256-by-4-bit RAMs store the application program, and three 1,024-by-4-bit RAMs hold the data to be programmed into the erasable PROM. Under program control, tapes may be read into the data RAM. The application program may be written to read any of the following:

- 1,024 4-bit nibbles to program one 1,024-by-4-bit 6603 erasable PROM.
- 1,024 12-bit words to program three 1,024-by-4-bit 6603s, one at a time.
- 512 8-bit bytes to program one 512-by-8-bit 6604.

The application program can include several variations. It can use single-location programming and verification by entering addresses and data from a terminal. It can read or punch formatted tape, and the printer can be used for generating formatted truth tables. The program can even include stopping at or listing any address with a mismatch. The whole system runs at 10 V, and a -40-V supply is connected to the emitter of the programming pulse driver.

In actual practice, an interactive programming procedure should be used to ensure uniform avalanche injection into all locations. In other words, each location to be programmed would first be read to verify that it is erased, then successive program-read-verify sequences would be performed.

Though most erasable PROMs dissipate the same amount of power upon access and when idle, the 6603/04 (Fig 7) and the 2716 do not. Table 2 shows the ratio of active to standby powers for the two devices. In the 2716, the ratio is about 6:1, whereas in the 6603 or 6604 it is anywhere from 1,300:1 to 5,300:1, depending on the cycling rate. This substantial difference suggests that large erasable PROM memory arrays should be designed so that the majority of the devices are on standby; if so, the power consumption will asymptotically approach the power consumed by the number of devices needed for one memory word.

An example is a 16-bit airborne computer with a 15-bit program counter that requires 32,768 bytes of erasable PROM storage in standard configuration. If a memory-cycle time of 1 μs is assumed, Table 2 shows that the total power consumed by 128 6604s is roughly a hundred times less than that consumed by only 32 2716s—9 to 33 milliwatts in the former vs 2,070 mW.

Electronics/July 6, 1978
A single 555 timer operating as an astable multivibrator can be used to set its own delay time before turning on, thereby circumventing the most annoying problem encountered with threshold-detector and industrial-alarm circuits—how to distinguish between an actual trigger signal and one that is generated by noise. With this circuit, a wide range of delay periods can be selected to negate the effects of noise spikes.

The circuit requires one transistor and several diodes to function, as shown in the figure. During the quiescent (no-trigger) condition, Q1 is biased on, D1 clamps pin 5 of the timer to the approximately 0.8 volt, and D2 is back-biased. The R7-R3 voltage divider maintains the positive plate of capacitor C1 at 2.5 V and the R5-R4 divider ensures that there is 1.5 V at the negative plate (D3 is forward-biased). Thus the initial voltage across C1 is 2.5—1.5 volts, or 1 V. Under these conditions, pin 6 is at a higher voltage (1.5 V) than the control voltage (Vc) at pin 5, and so the output of the timer at pin 3 is driven low, back-biasing D4.

The delay period begins when the trigger or alarm input, represented by a switch, is grounded. Q1 turns off, and the collector voltage climbs to 15 V, back-biasing D3 and bringing pin 5 to 3.8 V (the voltage depends on R5, which is in parallel with two 5-kilohm resistors internal to the 555).

Meanwhile, D2 becomes forward-biased, with the result that approximately 14.5 V is applied at the positive plate of C1, a step rise of approximately 12 V above the previous voltage. D1 is now back-biased; the step voltage is therefore transferred to the negative plate of C1, and pins 2 and 6 of the timer jump to 13.5 V.

Because the threshold voltage (13.5 V) is still larger than the control voltage (3.6 V), the output of the timer remains low. However, C1 now starts to charge through R4 and the discharge transistor within the timer. If the voltage at pins 2 and 6 reaches one half of the control voltage before the trigger input is removed, the output will move high. The time it takes the capacitor to charge to ½ Vc (that is, the delay time) is given by:

$$t_d = R_4C_1 \ln \left( \frac{V_m}{V_m - (V_f - V_i)} \right)$$

where $V_m$ is the maximum voltage, $V_f$ is the final voltage on C1, and $V_i$ is the initial voltage across C1. In this case, $V_m = 14.5$ V, $V_f = 14.5 - 1.5V_c = 12.7$ V, and $V_i = 1$ V. At the end of the delay period, the timer begins to oscillate at a frequency and duty cycle that can be set by the user.

When the timer's output is high, D3 is forward-biased and the $V_c$ voltage is clamped to approximately 2 V. C1 is now discharging through R1, and when the threshold voltage at pins 2 and 6 equals 2 V, the timer output moves low, reverse-biasing D4 and restoring pin 5 to 3.6 V.

The time the output is high is given by:

$$t_1 = R_1C_1 \ln \left( \frac{V_s}{V_f} \right)$$

where $V_s$ is the initial on-state voltage of C1 (14.5—1.8 = 12.7 V), and $V_f$ is the final voltage on C1 (14.5—2.0 = 12.5 V).

When the output moves low in the cycle, C1 starts to charge through R4. When the voltage at pins 2 and 6 drops from 2 to 1.8 V, the timer output goes high, the discharge cycle begins, and the cycle is repeated until the trigger signal is removed. The time the output is low is given by:

$$t_2 = R_4C_1 \ln \left[ \frac{V_m - (V_{ni} - V_i)}{V_m - (V_{nf} - V_i)} \right]$$

where $V_{ni} = 14.5 - 1.8 = 12.7$ V and $V_{nf} = 14.5 - 2.0 = 12.5$ V.

**Sure-fire.** Circuit can differentiate between real and noise-generated alarm signal by waiting a user-specified time before turning on. Frequency and duty cycle of astable multivibrator can be tailored for optimum response from loudspeaker or other audio-alarm monitor.
Audio blanker suppresses radar-pulse and ignition noise

by Carl Andren
E-Systems Inc., St. Petersburg, Fla.

This simple audio-stage noise blanker will reject most repetitious, pulse-type interference, like radar and automobile ignition spikes, that often plagues a-m receivers. The circuit is both less costly and far less complex than the radio-frequency stage blankers employed in some of the more sophisticated receivers, and though not as effective in eliminating interference, it outperforms the more commonly used noise-limiting audio-clipping circuits.

The blanker shown in the figure detects whether the amplitude of an offending pulse train at the output of the receiver's envelope detector exceeds a set threshold and then disables the output stage if necessary. Waveform diagrams are shown at several circuit points to help clarify operation of the blanker.

A typical amplitude-modulated signal might appear at the input of an a-m receiver as shown in the upper left of the figure, where a 20-megahertz radio-frequency wave, modulated 30%, is overridden by radar pulses 20 decibels greater in amplitude. A time-magnified portion of the a-m detector output, after passing through an inverting operational-amplifier stage, would appear as shown, where the maximum amplitude of the pulse would be limited by the saturating level of the intermediate-frequency amplifier. Only two offending pulses are shown for clarity, but this detected signal contains a pulse train of sufficient amplitude and repetition rate to generate a substantial pulse noise and so impair the readability of the signal.

The interfering spikes increase the effective modulation percentage to well over 100%. The blanker is triggered into operation when the modulation peak exceeds 140%, whereupon Q1 and Q2 switch on and disable signal-gate Q3 for the duration of each spike. The 140% threshold has been experimentally determined as the point at which the interference caused by the blanking operation itself is still less than the interference generated by the offending pulse train. Note that to ensure that the blanking action occurs at the set modulation peak independently of signal-level changes, the receiver's automatic-gain-control signal is introduced at the

---

**Spike eater.** Audio-stage noise blanker, although not as effective at eliminating pulse-type interference as rf-stage blankers, outperforms noise-limiter/clipper circuits. Blanking occurs when spikes raise effective modulation percentage over 140%. Receiver's agc signal is introduced to emitter of Q1 to ensure that the blanking action occurs at the set modulation point independent of input signal amplitude.
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threshold bias point at the emitter of $Q_1$.

$Q_3$ operates with no applied dc voltage so that no switching transients will be generated by the blanking action to impair circuit performance. $Q_2$, $R_1$, and $C_1$ have a fast-attack, slow-decay characteristic. $Q_3$ is thus gently turned on after a spike has passed so that the popping and clicking sounds that often accompany the operation of a blanking circuit that processes a randomly occurring train of spikes will be further suppressed.

The results of the blanking action are shown at the output of $Q_3$, where it is seen that only brief transients appear. The signal is slightly distorted, but the distortion is barely audible. There is a great improvement in noise reduction, however.

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**Four-function calculator times long intervals accurately**

by Steve Newman

_Hospital of the Good Samaritan, Los Angeles, Calif._

Time intervals extending up to several years can be set with the aid of an inexpensive four-function calculator and an integrated-circuit divider. This timer is accurate to within a few seconds per year. The only requirements for the calculator are that it have at least an eight-digit display, a minus-sign indicator at the left-most position of the display, and a continued-operation mode, which allows subtraction of a given number repetitively by depressing a single key (usually the equal-sign button).

The time interval is set by keying in the desired value, expressed in seconds. For instance, if the timer is set to go off in 3 days, 10 hours, 54 minutes, and 33 seconds, the number 298,473 is entered. (With an eight-digit display, an interval of 10^8 seconds, or 38 months, can be set.) Next, the −1 command is keyed in. The calculator is now programmed to subtract 1 from the displayed value each time the equal-sign key is activated and then to display the new value.

To decrement the count at proper intervals, a precise time base is required, and the calculator's keyboard pins must be made accessible. In this case, a divide-by-60 counter, the HEP C4055P, is used to derive a 1-hertz signal from the 60-hertz power line, as shown in the figure. This clock drives the transistor switch connected across the pins corresponding to the equal-sign key, which are closed when that key is depressed in normal operation.

The timing interval begins when the time base is activated. The displayed number is decremented for each pulse emanating from the C4055P, so that after N seconds the calculator will display zero, and after N + 1 seconds it will display −1.

The minus-sign output, which is part of the display circuitry, provides a convenient way to detect the end of the set timing interval. Here, the g-segment pin corresponding to the minus-sign key is brought to one input of a NAND gate, $G_1$, as is the lead corresponding to the left-most digit of the display. An identical gate, $G_2$, follows, so that the entire logic function is that of an AND gate. This function is suitable for driving positive-logic circuits or devices.

Pulses emanate simultaneously from both the minus-sign pin and the last-digit driver port when the calculator first displays a minus value, and for every result thereafter. The first pulse may thus be used to turn on an alarm. Because many calculators scan the display at a frequency of a few hundred hertz, an audible output can be obtained if a loudspeaker is connected to $G_2$.

---

**On the button.** Precision, low-cost timer (a) can be built with most any four-function calculator and integrated-circuit divider (b). Keyboard pins corresponding to equal-sign button must be accessible. Circuit is accurate to within a few seconds per year.
Beam tape plus automated handling cuts IC manufacturing costs

Fully automated finishing operations make it possible to bring plastic-encased small-scale integrated-chip assembly back home


Over the last five years tremendous advances in integrated-circuit manufacturing have occurred. But while wafer fabrication techniques and automated testing operations have leapt ahead, bonding, assembly, and other aspects of finishing have stayed close to the starting line.

An industry that is among the most technically sophisticated has attacked the problem of high finishing costs by shipping devices on a 12,000-mile round trip to have them assembled manually. That was done on the principle of reducing the cost per unit of labor. Now, a more viable approach for plastic-housed small-scale integrated circuits is emerging: reduce the amount of labor by applying a fully automated system built around the beam-tape method of assembly.

Assembly operations contribute significantly to the manufacturing costs of all integrated circuits. In fact, as Fig. 1 illustrates, for devices smaller than 80 mils per side, assembly operations represent the largest single cost of manufacturing. And these devices, the so-called "jelly beans," are the high-volume ICs on which much semiconductor manufacturing is based.

Historically, the experience of the IC industry has been that any manufacturer who is not constantly working to reduce costs risks being undercut by his competitors to the point of bankruptcy. Continually searching for developing nations with low labor rates is not a long-term solution to the assembly-cost problem. In fact, it is a good bet that the cost of offshore assembly will actually rise because of increased airline freight rates, growing inflation in the Third World, and a trend toward higher import duties.

Because of the distance and the turnaround time involved, offshore assembly has two other disadvantages. First of all, a firm must tie up working capital to finance its inventory in the 12,000-mile-long pipeline. Secondly, the system is usually sluggish and responds poorly to changes in market needs.

Under the proper conditions, a better choice for both
1. **Manufacturing costs.** As chip area increases, the cost of assembly becomes lower. In small-scale integration, assembly costs dwarf all others. Two methods of cutting these costs are offshore assembly and the use of a fully automated assembly line.

2. **Automated assembly.** The major steps in Solid State Scientific's automated assembly system involve automatic unloading, processing, and reloading at each step. The individual complementary-MOS chips are never handled by production personnel.

User and manufacturer would be to bring assembly operations back to the United States. What is required is that the manufacturer consider the entire assembly operation, from die attachment to final testing, as an integrated manufacturing system. This system can then be optimized for cost and efficiency.

Recent developments in beam-tape (film-carrier) interconnection systems have encouraged IC firms to re-evaluate their assembly operations. These systems use prefabricated metallic interconnection patterns on a sprocketed insulating film to provide automated, high-speed bonding of the interconnection to both the chip and a lead frame. Integrated into the total assembly operation, such a system allows the IC maker to completely automate the back-end functions. An example of how beam-tape technology has been incorporated into a fully automated assembly line is Solid State Scientific's assembly system for packaged complementary-metal-oxide-semiconductor chips, which is diagrammed in Fig. 2.

In this assembly operation, wafers are given metallic "bumps" by electroplating a copper contact about 25 micrometers high over a chromium barrier (Fig. 3). The barrier prevents undesirable intermetallic compounds...
from forming between the copper contact and the aluminum metalization of the chip pattern.

Each wafer is then electrically probed, and rejected dice are inked. Following probing, wafers are mounted on a substrate, held in place by a thermoplastic material, and then sawed through to the substrate with a diamond saw. Because the wafers are attached to the substrate, separated dice maintain their original orientation after the sawing.

**Chips on tape**

Actual bonding takes place in two separate operations. In the first step, inner lead bonding, the dice are bonded to an 11-millimeter patterned tape. The tape consists of two layers—a copper interconnection pattern bonded to a sprocketed polyimide carrier for strength. Single-layer pure-copper tapes, which are simpler to process, are just starting to be used by a few firms. However, Solid State Scientific chose two-layer tape for its system because of its commercial availability and satisfactory field performance.

The chip-on-tape resulting from this first step is stored on reels until the second step begins. This procedure, called outer lead bonding, involves fixing the tape's IC microinterconnections onto the copper-based lead frames. After this step, the lead frames are cut into strips of 10 devices and loaded into a magazine for subsequent processing. Devices are then inspected on a sample basis for unsatisfactory bonds and for manufacturing defects that are capable of causing electrical malfunctioning.

**Automated procedures**

The strip-mounted devices are next routed to a molding facility, where they are epoxy-molded and loaded into a special vertical holder, or cassette. The holder then goes to a deflashing operation. There, the devices are automatically unloaded, excess plastic is removed, and the devices are then automatically reloaded back into the cassette.

The first trimming and forming operation is next. After unloading, the strips are positioned beneath a multistage series of punches. Then, the epoxy between the dam bar and the main body of the device is removed. (A dam bar is a thin metal strip that shorts out all the leads on the lead frame. It prevents plastic from getting on the leads.) The dam bar itself is removed, and finally the devices are formed into the lead-down, or bug-down, configuration. Throughout this operation, the devices remain connected in strips by pins at each end of the package. The strips are then automatically reloaded back into the assembly magazine.

Next, a number of precleaning steps are performed and the devices are dipped in hot solder—all done auto-
Automated assembly's impact

The table, which compares the major assembly techniques for dual in-line packages made of epoxy, attempts to put automated systems in perspective. Though not shown, the figure of merit of unit output per operator hour represents the approximate efficiency of the total system from die interconnection up to final testing.

Introduction of high-speed die bonding in 1973 resulted in a very impressive doubling of an operator's production rate from 20 to 40 devices per hour. As beam-tape interconnection systems were introduced, output increased fivefold to an unprecedented 200 devices per operator hour. Integrating beam-tape technology into a completely automated assembly facility leads to a further 50% improvement in output.

For the user, automated assembly systems provide the obvious benefit of reduced costs for those high-volume devices adaptable to automated assembly. Of greater significance, however, is the fact that they equip the IC manufacturer to respond better to the marketplace. On the one hand, during an industry-wide downturn, the response of IC firms is sluggish because much of the work in process is already in the pipeline. The result is rapidly rising inventories, with their concomitant economic penalties.

On the other hand, a period of rising demand causes offshore assembly facilities to run at or close to 100% capacity. Therefore, increasing production during an upturn is extremely difficult and costly, with the result that lead times stretch out and deliveries slip.

Automated assembly can do much to improve this situation by giving the IC manufacturer much better control. In down periods, inventories can be adjusted much more quickly, and the capital that would otherwise be tied up in inventory will be available for other projects. When demand rises, production can be increased quickly by running up to three shifts, seven days a week.

3. Bumped wafers. Bumps are formed by evaporating layers of aluminum, chromium, and copper over a wafer. The copper contact is electroplated up 25 µm, then the resist and unwanted metals are stripped. Lastly, the bump is gold-plated.

Beaming in. This a view of the semiautomated equipment used at Solid State Scientific for gang-bonding the inner leads of each beam-tape interconnection pattern to the bumped I/O pads of an IC chip. Note that the TV monitor provides excellent visual control.
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To improve performance, reliability, and yield of integrated circuits, knowledge of thermal design considerations and of measurement techniques is a must for the user, as well as the manufacturer, of semiconductor devices.

by Bernard S. Siegel, Sage Enterprises Inc., Mountain View, Calif.

☐ Taking the heat off semiconductor devices is a sure way to improve their performance, reliability, and yield. For both user and manufacturer, a knowledge of their thermal properties and in particular their thermal resistance can spell all the difference between success and failure, whether in terms of equipment functioning or in relation to parameter yields. And new instruments are making this knowledge easier to come by.

Take performance. If an operational-amplifier chip capable of operation off an input bias current of 1 picoampere is not thermally packaged correctly, it may be unable to reach its bias specification. Yet in most attempts at improving electrical specifications, thermal design considerations come a poor second to changes in circuit design and fabrication methods.

As for reliability, numerous test programs since the transistor's invention have verified that every 10°C or so rise in junction temperature halves a device's operating life expectancy.

Finally, fluctuating yields at the manufacturing level and actual failures in users' equipment can often be traced to differences in parameter test results that are the direct consequence of variations in thermal resistance. In the case of most low-input bias op amps, for instance, a 10°C increase in junction temperature will just about double the input bias current required.

The ability to monitor both the absolute magnitude and manufacturing variations in thermal resistance in particular is clearly crucial. But first, it is as well to be clear as to the exact meaning of "thermal resistance."

Defining thermal resistance

Whenever electrical power is applied to a semiconductor device, some of the power is converted into heat, resulting in a rise in junction temperature. This occurs because the heat-generating portion of the device is separated from the outside world by the path shown in Fig. 1. The heat-flow path is made much more complex by the heat-removal paths associated with conduction and convection within the binding wires and by radiation from the heat source to the package. Such heat flow occurs with most semiconductor devices.

Each of the different portions of the path from the heat source (the active area or junction) to the outside world has two components. Of primary concern for most steady-state conditions is thermal resistance, shown as

![Thermal-equivalent circuit](image)

1. Thermal-equivalent circuit. The simplified electronic analog of the flow of heat from a semiconductor device to the outside world is a series of equivalent resistors and capacitors in parallel. For steady-state conditions, the thermal resistance is of primary importance.
2. Junction temperature. With the operating conditions and device specifications shown, it is possible to calculate the device junction temperature, \( T_J \). For the case shown, \( T_J \) equals 40°C, which is well below the maximum value of 75°C specified.

\( T_J = T_C + \Delta T \)
\( = T_C + \theta_{JC} P_D \)
\( = 25°C + 75°C/\text{W} \times (0.01 \text{V} + 0.01 \text{V} + 0.01 \text{V} - 0.01 \text{V}) \)
\( = 25°C + 15°C \)
\( = 40°C \)

In this instance, the case temperature could increase to 60°C before the \( T_{J,\text{max}} \) device specification was exceeded. If the semiconductor device is assumed to be an op amp and 1 nanoampere is the maximum current that can be supplied for \( I_1 \), then for a \( T_J \) of 40°C, the op amp should be chosen for input bias current of less than 350 picoamperes at 25°C.

Should \( \theta_{JC} \) be specified as a typical value instead of a maximum, the thermal-resistance range must be estimated before it is possible to select a device properly. A range of 50° to 100°C/W causes a \( T_J \) variation of 10° to 20°C, dictating a maximum input bias current at 25°C of 250 pA. Also, \( I_1 \) will vary between 500 pA and 1 nA.

This simple example can be modified to cover a wide range of semiconductor devices, including discrete transistors and ICs, under varying operating conditions.

3. Substrate isolation. The forward voltage drop of the substrate isolation diode of most ICs can be used to make thermal measurements. An increase of power to the active portion of this circuit heats the substrate, decreasing the forward voltage drop of the diode.

4. Negative slope. As junction temperature increases, there is a linear decrease in the voltage drop across a semiconductor junction driven by a constant current. The reciprocal of the curve's slope is directly proportional to thermal resistance.

\( \theta \) in Fig. 1 but sometimes referred to as \( \theta_{TH} \) or \( R_{TH} \). The other component, heat capacity \( C_h \), becomes important when the device is subjected to pulse operation with short duty cycles, in which electrical power is applied for a period of time equal to or less than the longest thermal time constant.

Thermal resistance for any semiconductor is defined as the increase in junction temperature (\( T_J \)) due to the application of dissipative power (\( P_D \)) in the device:

\[ \theta_{JX} = \Delta T_J / P_D \]

The two \( \theta \) subscripts describe the points between which the thermal resistance is measured, with \( J \) always indicating junction and \( X \) being dependent on the reference point being used. For example, \( X \) could be \( C \) for case (header or package) or \( A \) for ambient or \( L \) for liquid. The two most commonly specified thermal-resistance parameters are junction to case (\( \theta_{JC} \)) and junction to ambient (\( \theta_{JA} \)).

Using the thermal resistance parameter

Deriving the thermal-resistance parameter is very simple provided that careful consideration is given to the power actually dissipated in the device. For a semiconductor device in the operating conditions of Fig. 2, junction temperature can be determined as follows:

\[ T_J = T_C + \Delta T_J \]
\[ = T_C + \theta_{JC} P_D \]
\[ = 25°C + 75°C/\text{W} \times (10 \text{V} + 1 \text{mA}) + (15 \text{V})(20 \text{mA}) - (10 \text{V})(10 \text{mA}) \]
\[ = 25°C + 15°C \]
\[ = 40°C \]

Comparison of measurement techniques

The advantages and disadvantages of the four basic techniques for the measurement of thermal resistances—optical, chemical, physical, and electrical—are summarized in the table. The power dissipation within the device is always measured electrically in each case, but junction temperature is measured differently.

Only optical and electrical techniques are in widespread use today. Infrared microscopes capable of resolving down to 0.5-micrometer spot sizes are particularly useful as an aid in the thermal design of high-power systems.
devices to prevent the occurrence of hot spots within the chip active area. However, careful attention to the emissivity of the chip surface materials is required to obtain accurate readings.

The electrical technique is usually implemented with standard laboratory instruments or individually designed and built-in-house test equipment. It has suffered from the lack of definitive measurement standards, but the advent of commercially available thermal-resistance testers will go a long way towards providing de facto standardization within the semiconductor industry, for their ease of operation and relatively low cost should appeal strongly to both manufacturers and users of semiconductors.

The electrical technique determines thermal resistance in an integrated circuit by using a sequence of voltage and current pulses to both heat the device and measure the change in junction temperature. As an indication of this change, a temperature-sensitive parameter, such as the forward-biased voltage drop of a diode under low-value constant-current conditions, is used.

There are several different temperature-sensitive parameters associated with ICS that can be used to make thermal-resistance measurements. The most commonly used is the substrate-isolation junction diode that occurs in all semiconductors (bipolar, metal-oxide-semiconductor, and complementary-MOS) except for silicon on sapphire and dielectrically isolated units. Figure 3 shows a schematic representation of an IC for thermal-resistance testing purposes. If voltages of the proper polarity are applied to the voltage terminals, the active circuit, whether it be analog or digital, will be turned on and power dissipation will occur, causing the junction temperature to rise. If the substrate isolation diode is forward-biased by a small constant current insufficient to cause self-heating before power is applied, the diode voltage will be higher than a similar measurement made after heating, because of the $V_T / T$ diode characteristic illustrated in Fig. 4.

**Electrical measurement technique**

Voltage waveforms across the device under test for a typical measurement are shown in Fig. 5. During period $t_1$, a small reverse constant current is applied through the supply terminals of the device under test, causing the substrate-isolation diode to become forward-biased and produce voltage $V_1$. Power is then applied to the device being tested during $t_2$ when the supply voltage goes positive to the heating voltage, $V_H$ (shown as $V_2$).

At the completion of $t_2$, $V_H$ is quickly removed from
The device under test, and reverse constant current is again applied during period t3. The diode voltage, V3, will have a new value because of the higher junction temperature. The difference between V1 and V3 is proportional to junction temperature rise through the characteristic shown in Fig. 4, that is:

$$\Delta T_1 = K(V_1 - V_3)$$  \hspace{1cm} (1)

where K is the reciprocal of the slope of Fig. 4. The power required to produce $\Delta T_1$ is the product of $V_H$ and heating current $I_H$. The thermal resistance of the device under test from junction to some reference point (X) is:

$$\theta_{JX} = \Delta T_1/P_D = K(V_1 - V_3)/V_H I_H$$  \hspace{1cm} (2)

The X subscript mentioned above can vary, as described previously, depending on what temperature reference is used for the device.

If the reference point is the device case, then the temperature of the case must remain constant during the entire test cycle. Similarly, if an ambient like air is the reference condition, then the air conditions surrounding the device under test must remain constant during the entire test cycle.

The timing of the various current and voltage levels used in this measurement has a critical effect on the accuracy of the $\theta_{JX}$ measurement. Heating period $t_1$ must be long enough to assure junction temperature stabilization for the heating voltage applied. The voltage measurement, $V_3$, made during period $t_3$ must be made in a time interval as small and as close to the end of period $t_2$ as possible to avoid junction cooling effects. The transition between periods $t_2$ and $t_3$ must be very fast for the same reason.

Finally, $t_3$ must be very large compared to $t_1$ to ensure that the average and peak heating power are essentially the same, thus allowing direct computation of $\theta_{JX}$ without a heating-power correction factor. Periods $t_2$ and $t_3$ should be repeated several thousand times to provide maximum system accuracy: period $t_1$ occurs only at the start of each test cycle.

A block diagram of a commercially available thermal-resistance tester, Sage's Theta 400, that uses the method previously discussed is shown in Fig. 6. The tester is built up out of seven basic blocks—heating source, measurement source, power supplies, switching, control logic, analog sampling and computation, and a display section.

Kelvin (four-terminal) contacts on the fixture holding the device under test eliminate the measurement errors caused by contact voltage drops under high current conditions. The heating and measurement sources feed the necessary test cycle voltage and currents required through one set of the contacts of the switch to the device being tested.

Voltage measurements are made across a second set of contacts and fed directly to the analog sampling and computation circuits. The display and indicators are driven by the control logic and analog sections. Test-cycle duration, voltage and current pulse timing, and display and indicator control circuits are all contained in the control logic section. The entire instrument takes up about 1 cubic foot of benchtop space.

**Calibration**

In order to measure thermal resistance, $\theta_{JX}$, it is necessary to insert a value of K, the reciprocal of the slope of the $V_F$ versus $T_1$ curve of a forward-biased semiconductor junction, into Eq. 2. The K parameter must be measured for a particular type of semiconductor and this value set into the thermal-resistance tester's K factor control. K is essentially the same for all semiconductors of the same type and number from the same manufacturer, even though the units may have been produced in several different manufacturing runs or batches. Typical variations in K are within 3% for devices within a given batch or from various batches.

The relatively constant value of K for a given device type and number allows it to be measured on a sample basis. Typically, once the average K value is determined for groups of 10 junction diodes taken from two or three different batches of semiconductor devices, then no further K-factor measurements are required except for periodic quality control.

The measurement system for the temperature-sensitive-parameter coefficient (K factor) is shown in Fig. 7. The current source should provide the necessary forward current, as specified by the thermal-resistance tester requirements, to an accuracy of ±5% or better. Forward voltage across the diode must be measured with millivolt resolution: a 3½-digit voltmeter with a 1-volt scale is recommended. The temperature monitor, which may be a thermocouple type or any other suitable instrument, should have a range of at least 150°C.

The linear nature of the temperature coefficient enables sufficient accuracy to be obtained from forward-voltage measurements at only two different temperatures. Room temperature may be one of them. The other can be some elevated temperature in the 75°-to-125°C range, depending on the type of parts to be measured.

The K factor for each diode is:

$$K = [(T_2 - T_1)/(V_{F2} - V_{F1})]I_F = \text{constant}$$
where \( K \) = the temperature coefficient in °C/mv,
\( T_1 \) = the lower test temperature (usually room temperature),
\( T_2 \) = the higher test temperature (usually near the
device maximum operating temperature specification),
\( V_{F1} \) = the forward voltage at \( I_F \) and \( T_1 \),
\( V_{F2} \) = the forward voltage at \( I_F \) and \( T_2 \),
\( I_F \) = the fixed forward measurement current, required
by the thermal-resistance tester.

Once the average \( K \) value is determined, it is set on a
thermal-resistance tester's \( K \) factor control whenever
devices of the same type and number are to be tested for
thermal resistance.

**Measurement problems**

There are two major problems in the previous ther-
mal-resistance test method associated with the choice of
the temperature-sensitive parameter. First, the use of the
substrate-isolation diode for such a parameter produces
a weighted-average indication of \( T \), because not all
portions of the IC dissipate the same amount of power.
Junction temperature gradients occur across the chip,
and a lower-than-actual value of thermal resistance
results.

Secondly, some IC fabrication technologies, such as
dielectric isolation and silicon on sapphire, require some
other diode for their temperature-sensitive parameter,
because they lack the substrate diode.

The first problem can be partly overcome by sensing a
temperature-sensitive parameter in the vicinity of the
hottest portion of the IC chip, typically the output region.
Any junction-isolated region that has a transistor in it
will have its substrate diode, either directly or through a
diffused resistor, available for use as the temperature-
sensing element.

**Diode connection**

The other problem can be overcome if some form of
diode connection is available through the pins of the
device under test and can be coupled and decoupled
during various portions of the test cycle.

A third potential problem occurs when attempts are
made to test static devices, such as random-access or
read-only memories, that dissipate significant power
only when making the transition from one binary state to
the other. External circuitry may be required to cycle
devices during the \( t_h \) heating period.

Fortunately, for the purposes of thermal-resistance
testings, the thermal time constants for the various
portions of the circuit differ by one or more orders of
magnitude. To refer back to Fig. 1, for instance, \( t_{d1} \) is
typically in the range of high tens to low hundreds of
microseconds, while \( t_{d2} \) is in the hundred-millisecond
range. Each of the other time constants is correspondingly
greater.

The interface between die attachment and head-

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**6. Thermal tester**. Sage Enterprises' Theta 400 is an instrument designed for thermal-resistance measurement. All heating measurement sources, analog computation, and power sources are self-contained. Results are displayed digitally.
7. Temperature coefficient. The K factor, reciprocal slope of the $V_T / T$, curve, is necessary to compute thermal resistance. Two measurements of diode forward drop—under constant current at room and at elevated temperature—are sufficient to calculate K.

...er/package starts at the bottom of the chip and ends at the top of the header/package. For mounting configurations in which the header and package are not the same, as in hybrid circuits where the chip might be mounted on some form of substrate, Fig. 1 would be modified to show additional thermal interfaces and their corresponding thermal circuitry.

Junction temperature variances

The existence of differing time constants in the IC's thermal circuitry causes the junction temperature (or thermal resistance) of the IC to vary as a function of time from the initial application of power to the device as shown in Fig. 8. The relatively short time constants from the IC active area to header/package cause the initial plateau to occur within several seconds. Then, depending on the package-mounting configuration, this plateau will either continue if the header/package temperature is fixed (because of good heat-sinking) or will lead to a new plateau as $T_{J4}$ is exceeded and thermal equilibrium with the environment is reached. The second plateau typically occurs within 5 to 20 minutes when the environment is still air at room temperature.

The thermal circuitry from the header/package to the environment, whether the latter is still or moving air, liquid, or a heat sink, is relatively independent of the chip contained within the header/package. Thus, the thermal characterization of an IC chip/package configuration can be broken into two separate measurements: one for the IC active area-to-header/package, which only takes seconds for each measurement, and one for the header/package-to-environment configuration, which may take tens of minutes but does not have to be done for each device.

The semiconductor manufacturers should find thermal-resistance testers useful in many areas, including product characterization, manufacturing, and quality assurance. In the first area, thermal-resistance testers assist the device designer by providing thermal characterization of prototype devices as well as final versions. The effects of different packages (for instance, plastic versus ceramic dual in-line packages) can quickly be ascertained on meaningful sample sizes. The manufacturing area can use the thermal-resistance tester, or its derivatives, to quickly determine the consistency of die-attachment procedures and/or improvements. Quality-assurance operations would use the thermal-resistance tester to maintain an independent check on manufacturing and to insure conformity with high-reliability requirements.

The thermal-resistance tester can be equally well applied by semiconductor users. Once a satisfactory value of thermal resistance for an IC package in an actual module or subsystem has been established, the tester can be used to select suitable devices to meet the desired parameter range and to evaluate alternative vendors. Once specifications are set and a vendor or vendors are chosen, incoming inspection is required to monitor vendor performance. There is insufficient standardization among vendors, so users must select vendors and monitor them carefully to be sure of getting the thermal-resistance specification they want.

Instrument improvements

Efforts are already underway to provide more accurate, more flexible, and more versatile laboratory instruments. Ultimately an instrument accuracy of $\pm 5\%$ of reading should be possible, more than enough except in the most demanding device applications. For some semiconductor devices, a single heating voltage supply may not be adequate, necessitating an instrument capable of providing more supplies. Also, the problem of testing static memory devices can be overcome by clocking the inputs of the device under test. Versatility can be improved by building a single instrument with operator-controlled heating time to allow for package characterization, die-attachment evaluation, and paper-tape printout of sequential data for time plots of increasing thermal resistance and/or junction temperature.

8. Temperature vs time. This curve displays junction-temperature change of a packaged IC as a function of time, assuming constant power dissipation. Differing time constants in the thermal circuitry cause junction temperature to vary as a function of time.
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Circle 127 on reader service card
Engineer's notebook

Adapting the M6800 processor for automatic telephone dialing

by Moshe Bram
Allied Chemical Corp., Automotive Products Division, Mount Clemens, Mich.

A short program and a simple interface for a rotary-dial telephone enables the well-known M6800 microprocessor to dial stored telephone numbers on command. The versatile microprocessor thus becomes a viable alternative to commercial automatic dialers, which essentially perform only one function and are expensive—chiefly because they are in great demand.

The program for the M6800 is divided into two sections, as shown in the table. The phone numbers are stored in the lower locations of memory, the dialing subroutine in the upper sections. The only limit to the number of phone numbers that can be stored is the amount of memory available to the system. The operation of the entire program is explained by the comments column of the table.

To access any number, the user (or a subroutine) simply initiates the program at, or routes the program to,

<table>
<thead>
<tr>
<th>Location</th>
<th>Object code</th>
<th>Source statement</th>
<th>Comments</th>
</tr>
</thead>
<tbody>
<tr>
<td>0000</td>
<td>C6 X1</td>
<td>LDA A X1</td>
<td>Load accumulator B with the first digit of phone number (X1)</td>
</tr>
<tr>
<td>0002</td>
<td>BD 01C8</td>
<td>JSR 01C8</td>
<td>Jump to dial subroutine located at address 01C8</td>
</tr>
<tr>
<td>0005</td>
<td>C6 X2</td>
<td>LDA B X2</td>
<td>Load accumulator B with the second digit X2</td>
</tr>
<tr>
<td>0007</td>
<td>BD 01C8</td>
<td>JSR 01C8</td>
<td>Jump to dial subroutine located at address 01C8</td>
</tr>
<tr>
<td>000A</td>
<td>C6 X3</td>
<td>LDA B X3</td>
<td>Load accumulator B with the third digit X3</td>
</tr>
<tr>
<td>000C</td>
<td>BD 01C8</td>
<td>JSR 01C8</td>
<td>Jump to dial subroutine located at address 01C8</td>
</tr>
<tr>
<td>000F</td>
<td>C6 X4</td>
<td>LDA B X4</td>
<td>Load accumulator B with the fourth digit X4</td>
</tr>
<tr>
<td>0011</td>
<td>BD 01C8</td>
<td>JSR 01C8</td>
<td>Jump to dial subroutine located at address 01C8</td>
</tr>
<tr>
<td>0014</td>
<td>C6 X5</td>
<td>LDA B X5</td>
<td>Load accumulator B with the fifth digit X5</td>
</tr>
<tr>
<td>0016</td>
<td>BD 01C8</td>
<td>JSR 01C8</td>
<td>Jump to dial subroutine located at address 01C8</td>
</tr>
<tr>
<td>0019</td>
<td>C6 X6</td>
<td>LDA B X6</td>
<td>Load accumulator B with the sixth digit X6</td>
</tr>
<tr>
<td>001B</td>
<td>BD 01C8</td>
<td>JSR 01C8</td>
<td>Jump to dial subroutine located at address 01C8</td>
</tr>
<tr>
<td>001E</td>
<td>C6 X7</td>
<td>LDA B X7</td>
<td>Load accumulator B with the seventh digit X7</td>
</tr>
<tr>
<td>0020</td>
<td>BD 01C8</td>
<td>JSR 01C8</td>
<td>Jump to dial subroutine located at address 01C8</td>
</tr>
<tr>
<td>0023</td>
<td>3F</td>
<td>SWI 01C8</td>
<td>End of dial number</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>01C8</td>
<td>86 FF</td>
<td>LDA A FF</td>
<td>Other numbers stored as required</td>
</tr>
<tr>
<td>01CA</td>
<td>B7 8004</td>
<td>STA A 8004</td>
<td>Initial clearing of data direction and control registers of the PIA.</td>
</tr>
<tr>
<td>01CD</td>
<td>B7 8005</td>
<td>STA A 8005</td>
<td></td>
</tr>
<tr>
<td>01D0</td>
<td>B7 8006</td>
<td>STA A 8006</td>
<td></td>
</tr>
<tr>
<td>01D3</td>
<td>B7 8007</td>
<td>STA A 8007</td>
<td></td>
</tr>
<tr>
<td>01D6</td>
<td>86 01</td>
<td>LDA A 01</td>
<td></td>
</tr>
<tr>
<td>01D8</td>
<td>B7 8006</td>
<td>STA A 8006</td>
<td></td>
</tr>
<tr>
<td>01DB</td>
<td>B7 8004</td>
<td>STA A 8004</td>
<td></td>
</tr>
<tr>
<td>01DE</td>
<td>CE 18FF</td>
<td>LDX 09FF</td>
<td>A &quot;HIGH&quot; (1) is loaded into A0 &amp; B0 of PIA</td>
</tr>
<tr>
<td>01E1</td>
<td>09</td>
<td>DEX</td>
<td>A counter is set allowing A0 &amp; B0 to be high (1) during the count down.</td>
</tr>
<tr>
<td>01E2</td>
<td>26 FD</td>
<td>BNE FD</td>
<td>Data line A0 goes low (0).</td>
</tr>
<tr>
<td>01E4</td>
<td>4F</td>
<td>CLR A</td>
<td>A counter is set allowing A0 to be low (0) during the count down.</td>
</tr>
<tr>
<td>01E5</td>
<td>B7 8004</td>
<td>STA A 8004</td>
<td>One cycle of pulse generation has been completed.</td>
</tr>
<tr>
<td>01E8</td>
<td>CE 18FF</td>
<td>LDX 09FF</td>
<td>A branch instruction to generate the next pulse cycle is executed. Line B0 goes low (0) at the end.</td>
</tr>
<tr>
<td>01EA</td>
<td>09</td>
<td>DEX</td>
<td>A counter is set allowing a time interval between dialed digits.</td>
</tr>
<tr>
<td>01EC</td>
<td>26 FD</td>
<td>BNE FD</td>
<td>A return from subroutine instruction is executed to load the next digit for dialing.</td>
</tr>
<tr>
<td>01EE</td>
<td>5A</td>
<td>DEC B</td>
<td></td>
</tr>
<tr>
<td>01EF</td>
<td>26 E5</td>
<td>BNE E5</td>
<td></td>
</tr>
<tr>
<td>01F1</td>
<td>B7 8006</td>
<td>STA A 8006</td>
<td></td>
</tr>
<tr>
<td>01F4</td>
<td>CE 02</td>
<td>LDA B 02</td>
<td></td>
</tr>
<tr>
<td>01F6</td>
<td>CE FFFF</td>
<td>LDX FFFF</td>
<td></td>
</tr>
<tr>
<td>01F9</td>
<td>09</td>
<td>DEX</td>
<td></td>
</tr>
<tr>
<td>01FA</td>
<td>26 FD</td>
<td>BNE FD</td>
<td></td>
</tr>
<tr>
<td>01FC</td>
<td>5A</td>
<td>DEC B</td>
<td></td>
</tr>
<tr>
<td>01FD</td>
<td>26 F7</td>
<td>BNE F7</td>
<td></td>
</tr>
<tr>
<td>01FF</td>
<td>39</td>
<td>RTS</td>
<td></td>
</tr>
</tbody>
</table>
Improved processor program boosts a-d conversion efficiency

by Tomasz R. Tarłski
Warsaw, Poland

Systems that use a comparator, a d-a converter, and a microprocessor-based successive-approximation algorithm for analog-to-digital conversion [Electronics, June 23, 1977, p. 133] may be speeded up by the use of a more efficient program. Specifically, the 8080 microprocessor program reviewed in the article mentioned can be shortened by 40% if one minor hardware change in the system is made.

The new subroutine performs the same 8-bit a-d successive-approximation as the former program implemented by Burr-Brown. In this technique, an analog input is compared with the known outputs of a d-a converter, as shown in part a of the figure. Under microprocessor control, the most significant bit of a repeating 8-bit data stream whose value steps from 0 to 256 is introduced to the comparator through one half of an MP10 analog-output unit. This unit contains a d-a converter, an address decoder, and control logic. The output of the MP10 and the comparator are allowed to settle, and then the microprocessor reads the latter's status.

If the comparator indicates that the MSB input voltage at its inverting input—an analog signal—is smaller than the analog input to the noninverting port of the comparator, the MSB input to the d-a converter will remain on while the microprocessor turns on the next MSB. Next, a new comparison is made. If the comparator indicates that the converter's newly generated voltage is larger than the analog input, the microprocessor will turn this last bit off and the next MSB of the data input on. The cycle repeats until all 8 bits of the d-a converter have been tested. Thus the output of the comparator represents an 8-bit equivalent of the analog input signal.

This program utilizes the microprocessor's resources more effectively than the original program. For instance,
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the initialization of the result-of-conversion bit and the tested-bit pointer is done by one instruction, as shown in the flow chart (b). But in the Burr-Brown program, three instructions are required because the intermediate results of an a-d conversion are stored in a random-access memory, so that two extra program steps are required to fetch the intermediate data.

Another step-saving measure is the fact that restoring the bit pointer (MOV A,E) is done only once before rotating it. It happens at the beginning of LOOP 1, as shown in the program in (c). In the Burr-Brown routine this instruction is executed after each jump to LOOP 1.

In this new program, also, the result of a given bit test is stored temporarily in register B of the 8080's central processing unit instead of a random-access memory as in the original system, and the previous test value is stored in register D. In the Burr-Brown program, only the latest test result is stored and in RAM, too. Thus any values stored must be fetched from memory, and the previous value derived, for the system to determine which MSB to turn on or off so that an a-d conversion can be performed. Also, the new program saves time, because test results do not have to be fetched from RAM.

Tying the comparator's output to line PC7 of the 8255 programmable peripheral interface, instead of the PC0 port, is the only hardware change required. This modification, in combination with program modifications that place the 8-bit data stream's MSB in an optimum register position for testing, enables the 8-bit test to be performed more quickly.

The 30-byte program requires a total of 497 to 557 microseconds to perform a single a-d conversion (depending on the measured voltage level), which is considerably less than the 833 to 933 µs it takes to run Burr-Brown's 51-byte program. Further run-time reductions may be achieved by using an isolated input/output instruction scheme for addressing the MP10.

Software trimming. Well-known technique for performing a-d conversion with comparator, d-a converter, and microprocessor-based program (a) can be optimized for greater efficiency (see text). Flow chart (b) results in derivation of 30-byte program (c) having a running time only 80% that of its predecessor's.
Engineer's newsletter

Keep it clean for fault-free tests, says Analog Devices

There's more to successful board checking with in-circuit automatic test equipment than just buying the tester and its special bed-of-nails fixture. So reports John Lang of Analog Devices Inc. in describing the Norwood, Mass., firm's teething troubles with its in-circuit ATE system. In the initial stages of the test program, apparently good boards were being rejected by the new Fault-Finder 101 in-circuit tester. The trouble was soon traced to airborne solder flux from a nearby wave soldering line, which was being sucked into the test fixture by the vacuum hold-down that presses boards against the test pins in the bed of nails. The flux caused high-resistance contacts on the plunger pins of the fixture, resulting in the false failures. Analog Devices solved this problem by building a separate air-conditioned and filtered room for the tester and its fixture. Lang reported on the troubleshooting at a recent Boston ATE seminar sponsored by Circuits Manufacturing magazine.

A reliable course, that's what Rome promises

Who isn't interested in designing reliability into equipment? The Reliability Analysis Center of the Rome Air Force Development Center expects a lot of interest in its $375 four-day course on "Guidelines to Reliable Design." To be given in Arlington, Va., on Nov. 13-16 and in San Diego on Feb. 15-18, 1979, the course uses the Reliability Design Handbook (RHD-376) as its basic text. Topics covered include: introduction to reliability methodology, part selection and control, reliability evaluation tools, derating and redundancy for reliability, production and reliability, design simplification and electrostatic discharge, design to cost, and reliability data sources. For more information, write to the Reliability Analysis Center, RADC/RBRAC, Griffiss AFB, N. Y. 13441.

Hybrid society is pushing standardization

The International Society for Hybrid Microelectronics is organizing its members into technology groups to improve the society's standardization efforts. The seven areas are thick-film, thin-film, and hybrid technology, packaging, trim and test, reliability, and components—both active and passive. In addition, the society is pushing final acceptance of hybrid-package standards reflecting the three basic packages: 0.04-in. center-leaded and leadless types, 0.05-in. center-leaded and leadless types, and minipaks. Daniel I. Amey, chairman of the JEDEC JC 11.3.1 committee on hybrids, is coordinating the standardization activities to reflect the majority of hybrid-packaging techniques used by the society's members.

C-MOS phase-locked loops get their due in application note

The phase-locked loop, a versatile building block for many digital and analog applications, is the subject of a new application note, AN 112. The note describes the theory and application of micropower complementary-MOS monolithic PLLs. It has an extremely thorough section on PLL fundamentals and design considerations, as well as a circuit description of the ICs. AN 112 is offered free of charge by Solid State Scientific Inc., Montgomeryville, Pa. 18936.

Jerry Lyman
Control Data offers a complete line of semiconductor and core memory. Enclosures, too. And all are precision-engineered and built with the same concern for quality that goes into every product we manufacture.

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This automatic machine produces up to 50 coreless coils per minute including stripping of both shanks

<table>
<thead>
<tr>
<th>wire diameter</th>
<th>FTU 0-97</th>
<th>FTU 1-97</th>
</tr>
</thead>
<tbody>
<tr>
<td>inside diam. of coil</td>
<td>0,2-1,0 mm</td>
<td>0,3-2,0 mm</td>
</tr>
<tr>
<td>coil length</td>
<td>10 mm</td>
<td>15 mm</td>
</tr>
<tr>
<td>shank length</td>
<td>35 mm</td>
<td>45 mm</td>
</tr>
<tr>
<td>number of coils</td>
<td>30 x 30 mm</td>
<td>48 x 50 mm</td>
</tr>
<tr>
<td>maximum output</td>
<td>55</td>
<td>70</td>
</tr>
<tr>
<td></td>
<td>50 coils/min.</td>
<td>40 coils/min.</td>
</tr>
</tbody>
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New products

Hybrid circuit includes transformer

Isolation amplifier measures only 1.1 inch on a side, yet can withstand 8 kV; maximum nonlinearity is 0.1%.

by Richard W. Comerford, Assistant New Products Editor

Isolation-amplifier modules were first fairly large components, measuring as much as 2 1/2 by 3 1/2 inches and relying on wound-wire transformers to provide isolation. Although bulky, these early units proved to be quite linear. Then various techniques including optical isolation were used to reduce module size—but in reducing size, performance was lost.

For the design engineer, this meant a choice between quality and size: a tradeoff that no one likes to make. But by using a novel approach to transformer design and operation, Burr-Brown Research Corp. “has been able to bring it all back together, giving users large-module performance in a very small package,” according to Bill Olschewski, group leader for isolation products.

The model 3656 isolation amplifier is a hybrid-circuit module that measures about 1.1 in. on each side. Yet it contains two operational amplifiers, a 750-kHz pulse generator, a modulator, input and output demodulators, and separate rectifying and filtering circuits that can provide isolated power to each of the op amps. These individual circuits can be interconnected using external pins, allowing users to design configurations to match their applications. Furthermore, internal op-amp powering can be overridden by simply adding external supplies; isolation of supplies is maintained.

With its single, uniquely configured transformer, the model 3656 is able to operate with up to three completely independent grounds; one for the pulse-generation circuitry, one for the input, and one for the output. With the pulse-generation circuit connected to output ground, input-to-output isolation is rated at 3.5 kV continuous and 8 kV for 10 s.

This kind of isolation capability is something that the medical profession has wanted in operating rooms, where defibrillators—the machines used to administer electric shock in the event of heart failure—can expose isolation amplifiers to very high voltages. “In the past,” says Olschewski, “those in the profession had to be satisfied with amplifiers that had lower ratings, but they kept telling us, ‘we’d really like to have 8 kilovolts.’”

Part of the secret in achieving that level of isolation is the use of a conformal-coating process developed for the aerospace and military industries. It employs parylene C, which has a dielectric strength of 5.6 kV per mil. Olschewski explains that to ensure a uniform coating of the thickness needed, parylene C must be applied to the units in a vacuum for a two-hour period. “It’s an expensive step,” Olschewski admits, “but we feel we’re buying a much larger market.”

The module’s specifications suit it to industrial as well as medical applications. Gain nonlinearity is a maximum of 0.1% for unipolar output and 0.05% for bipolar output when external supplies are used. Leakage current at 120 V, 60 Hz, is a maximum of 0.5 μA. For small-signal conditions, ±3-dB frequency response is typically 30 kHz; settling time to 0.05% is typically 500 μs.

In quantities of 100 or more, prices for the 3656 begin at $33.80. Delivery for large quantities takes from 6 to 8 weeks.

Burr-Brown Research Corp., International Airport Park, P. O. Box 11400, Tucson, Ariz. 85734. Phone (602) 746-1111 [338]
New products

Packaging & production

**Ion implanters get more reliable**

Vibratory end station eliminates breakage and dust of inclined-plane units

The least-reliable parts of most ion-implantation systems are the automatic end stations that load and unload the semiconductor wafers. With the advent of 4-inch wafers, this problem is becoming more pronounced and has prompted GCA Corp. to develop a new type of end station that promises to improve overall system reliability.

There have been two generations of ion-implanter end stations: the first, a complex mechanical, marginally reliable system gave way to the second, a simple and more reliable gravity-feed, inclined-plane type. “These inclined-plane systems worked fine for the 2-in. and even the 3-in. wafers,” Arthur A. Noeth, GCA’s ion-product-line manager says, “but the 4-in. wafers present new problems.”

As the wafers slide down the inclined track, they must be stopped at the ion-implant process site, processed, and then sent out again. A metal pin or rubber bumper is used to stop the wafer’s descent. But 4-in. wafers have enough mass to be damaged by the impact. “The edges are being chipped, and dust, resulting from pulverization of the wafer fragments, is settling on the surfaces and contaminating them,” Noeth explains.

Instead of gravity, GCA’s solution uses a 60-hz vibratory motion to move the wafers gently along within the high-vacuum area. Before and after the high-vacuum chamber, the wafers are moved by a conventional air-bearing technique. “The advantage of vibratory motion is that we can stop the wafer by simply stopping the vibration. There’s no impact with a pin and therefore no edge damage or dust produced,” Noeth says. A 60-tz oscillating coil, built by FMC Corp., provides the vibration. Because it is situated outside the vacuum chamber, it presents no reliability constraint.

“It is difficult to design moving parts within a vacuum area,” Noeth points out. “Lubrication is out because it would simply evaporate, and the parts should be low-speed and low-load rotating types to ensure seal integrity.” There are only five moving parts within the new system’s vacuum chamber, and all fit those criteria.

Recently, there have been problems with the positive photo-resist coating on some wafers. As they slide down the plane, the coating would cause drag, and the wafer would stop short of the stop pin, sometimes causing the system to malfunction.

“Theoretically, the vibratory system should eliminate this problem,” Noeth says. “When a wave passes across the boundary between two materials with different transmission properties, there is reflection produced that tends to tear apart the junction formed by the materials. In this case, the silicon wafer is vibrating along an aluminum track, and any tendency for the wafers to stick together should be prevented by the vibrations.” Operators—the “dirtiest part of the system,” he says—need never touch the wafers because the end station is set up to accept the IBM and GCA standard wafer cassettes.

He admits that anyone could do an effective job of end-station design if they could charge $75,000 to $100,000 for that portion of the system. “The industry, however, will only tolerate an end-station price of about $25,000,” he declares. With that limit in mind, GCA’s design team sought to develop an end station that would remain competitive while improving the system’s reliability.

At $179,500, the ion-implantation system compares favorably in price with inclined-plane systems, costing upwards of $195,000. Noeth says one of the first systems will be installed soon, at Zilog’s Cupertino, Calif., production line.

GCA Corp., 1050 Kifer Rd., Sunnyvale, Calif. 94086. Phone (408) 732-5300 [391]

Plasma reactor desmears printed-circuit boards

The model 4200-14536PCM can desmear printed-circuit boards in a single automatic step by using a low-temperature plasma to oxidize drill smear. This process is less hazardous, less expensive, and less complex than the acid-to-alkaline-to-wetting-agent process traditionally used to desmear pc boards, and it also simplifies waste disposal.

The system’s desmearing process takes place in a sealed reactor in which the plasma is formed by ionizing oxygen and freon gases. Smear that is on boards placed in the reactor is turned to gas by the plasma, and the gas is then removed from the
Set the world on its ear with a SuperPower Darlington.

Go ahead, break a convention. Set a new power circuit standard. You can do it with Motorola power Darlington.

There's no reason not to use them in place of discretes. They've proven themselves since we first introduced them 8 years ago. They're reliable. They don't require nearly as many associated components as discretes for the equivalent function. They have multiple sources. They're priced on the average only about 10% more than discretes.

You can achieve as high as 10,000 minimum gain with SuperPower* Darlington. Switch inductive loads as fast as 40 ns. Operate to 15 kVA RBSOA. Handle up to 50 amps or 300 watts of power. Design up to 50 amp complementary circuits. Select from 7 different packages. Pay 100-ups as little as 65¢.

And Motorola now offers 16 economical Switchmode* Darlington, including the new MJ10008/9 units with 20 A, 500 V capability, hot inductive crossover time of 1.6 µs and minimum gain of 30 at 10 A. Darlington for general-purpose amplifiers and motor controls with 100 amp pulse and minimum gain of 400 at 50 A are available in the new MJ11028 through MJ11033. 100-ups start at only $5. All state-of-the-art. All a bit earth-shaking.

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That's what you always wanted to do, isn't it?

*Trademark of Motorola Inc.
## Motorola SuperPower Darlington Transistors

### Characteristics

<table>
<thead>
<tr>
<th>Device Type</th>
<th>NPN/ PNP</th>
</tr>
</thead>
<tbody>
<tr>
<td>MJ1000</td>
<td>MJ900</td>
</tr>
<tr>
<td>MJ1001</td>
<td>MJ901</td>
</tr>
<tr>
<td>MJ1002</td>
<td>MJ902</td>
</tr>
<tr>
<td>MJ1003</td>
<td>MJ903</td>
</tr>
<tr>
<td>MJ1004</td>
<td>MJ904</td>
</tr>
<tr>
<td>MJ1005</td>
<td>MJ905</td>
</tr>
<tr>
<td>MJ1006</td>
<td>MJ906</td>
</tr>
<tr>
<td>MJ1007</td>
<td>MJ907</td>
</tr>
<tr>
<td>MJ1008</td>
<td>MJ908</td>
</tr>
<tr>
<td>MJ1009</td>
<td>MJ909</td>
</tr>
</tbody>
</table>

### Ratings

<table>
<thead>
<tr>
<th>Device Type</th>
<th>Volts</th>
<th>Current</th>
<th>Power</th>
<th>Case</th>
</tr>
</thead>
<tbody>
<tr>
<td>MJ1000</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1001</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1002</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1003</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1004</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1005</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1006</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1007</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1008</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1009</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
</tbody>
</table>

### Notes

- **Case** refers to the type of package in which the transistor is housed.
- **Volts** and **Current** specify the operating conditions under which the transistor can safely operate.
- **Power** indicates the maximum power dissipation allowed for the transistor.

### Table

<table>
<thead>
<tr>
<th>Device Type</th>
<th>Volts</th>
<th>Current</th>
<th>Power</th>
<th>Case</th>
</tr>
</thead>
<tbody>
<tr>
<td>MJ1000</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1001</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1002</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1003</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1004</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1005</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1006</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1007</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1008</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
<tr>
<td>MJ1009</td>
<td>150</td>
<td>5</td>
<td>100</td>
<td>TO-3-311</td>
</tr>
</tbody>
</table>

### Additional Notes

- **JEDEC/Motorola** refers to the standardization organization that has approved these transistors for use in electronic devices.
- **Min/Max** indicates the range of values for a particular parameter.

### References

- [Motorola SuperPower Darlinton Transistors](https://www.motorola.com)
- [Data Sheet](https://www.motorola.com/data-sheets)
- [Characterization](https://www.motorola.com/characterization)
reactor by a vacuum pump.

This commercial system is available in two versions: one with a reactor measuring 24 in. in diameter by 36 in. deep, and the other with a 45-in.-diameter reactor of the same depth. Typically, the smaller unit will hold 20 pc boards measuring 12 by 12 in., and the larger can accommodate 16 18-by-24-in. boards. Prices for the units are about $36,000 and $45,000, respectively, and delivery takes approximately 12 weeks.

International Plasma Corp., 31159 San Benito St., Hayward, Calif. 94544. Phone (415) 489-3030 [394]

Bus bar stiffens printed-circuit boards

The Stiffener-bus bar not only provides electrical distribution for two-sided circuit boards, but also eliminates the need to use multilayer boards for mechanical stiffness.

Available in 25- or 42-mil thicknesses, the bars are also offered with a selection of pin spacings between 0.250 and 2.000 in. and in bright
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It's also seagulls and beaches...and community leaders who recognize the importance of an industrial base for economic and cultural progress.

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New products

Cooling fixture increases
Wayflow wafer throughput

In the past, the throughput of Wayflow ion-implantation systems has been limited because the beam power had to be limited to less than 10 w to prevent appreciable wafer heating or degradation of the photoresist materials. With a new cooling fixture called Waycool, throughput can be boosted by as much as 500% to allow high doping levels.

In operation, the bottom of the wafer is held in intimate thermal contact with a heat-conducting substrate, or conformal heat sink, during implantation. Implant values of approximately 600 µA at 200 keV can thus be achieved.

Varian Associates, Blackburn Industrial Park, Gloucester, Mass. 01930. Phone Dr. Andrew Wittkower at (617) 281-2000 [395]

System positions panels precisely for wire wrapping

The Pin Finder is a precision X-Y positioning system for use when wrapping wire on connector panels. Pin-location coordinates from wire-run lists are used to position the X and Y slides. The user can then insert an appropriate wrapping tool in a notch on the Y slide to make a connection. The need to count out pin locations is thus eliminated.

The unit will accommodate panels up to 10 by 20 in. and features ball-bearing glide rollers, aluminum rails and slides, and a wooden base. It is priced at $91.95, including shipping and handling.

Ultima Electronics Ltd., 73 Sherwood Ct., Huntington, N.Y. 11743. Phone (516) 423-3770 [398]
Dialight is the first place to look. We can help you do more with LEDs... because we've done more with them.

Discrete LEDs come in a variety of sizes, shapes, colors (red, yellow, green in clear or diffused), with or without built-in resistors.

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Communications

Fiber-optics kit is versatile

Joint offering from Motorola and AMP sells for $285

Much has been discussed about fiber optics and its inherent features of electrical isolation, noise immunity, and transmission security, as well as freedom from short circuits, sparks, and fire. Thus, systems suppliers have been touting the performance and cost benefits of fiber optics for applications such as communications, medical electronics, point-of-sale terminals, and industrial control and security systems.

Needed, however, have been tools that allow designers of controllers and circuits to evaluate fiber optics and demonstrate how off-the-shelf components may be used to build dc control and communications systems. Now, AMP Inc. of Harrisburg, Pa., and Motorola Semiconductor Products Inc. of Phoenix, have joined to produce a kit that goes beyond the traditional capabilities of fiber-optic instructional materials. Called the AMP Optimate Fiber-Optic Experimental Kit, the joint offering contains all the necessary semiconductor devices and printed-circuit boards, along with optical connectors and cables, to enable users to build six prototypes of complete fiber-optic data links that are compatible with transistor-transistor logic and complementary metal oxide semiconductors.

“Typically, more expensive conventional kits are preassembled and limited to building one communications-link component, presumably to prove the point that fiber optics will work,” says William J. Hudson, manager of AMP’s Signal and Components division. Marketed exclusively by AMP, the kit is being offered at an introductory price of $285 until August 1, after which it will list for $350. Delivery time is four to six weeks.

Included in the Optimate kit are 72 devices from Motorola that represent the active components in the transmitter and receiver circuits. Among these semiconductors are comparators, inverters, operational amplifiers, transistors, emitters, and detectors. Also in the kit are drilled circuit boards, 3 meters of cable, connectors, tools, and instructions to build several different fiber-optic systems or as many as 10 optical-cable assemblies.

Experimenters can construct systems suitable for most low-frequency and short-length data links, Hudson notes. For example, links up to 20 m (for 1-megabit-per-second systems) and as long as 45 m (for 1-kilobit/s systems) can be produced.

“The kit will not produce salable systems, but it can bring an experimental fiber-optic link about 85% of the way to a final commercial design,” he adds. Still needed are environmental-protection details, such as temperature compensation, “and the obvious repackaging for production economy,” he says.

Six transmitter pc boards and six receiver boards are included as part of the package. The transmitter boards are all identical and provide a range from 1 kb/s to 1 Mb/s. The receiver-board configurations are necessarily more varied. Two receiver boards provide four-channel, 1-kb/s or 100-kb/s capacity. Two others provide one-channel, 10-kb/s capacity, and the final two offer one-channel, 1-Mb/s capacity.

According to Hudson, “All that the experimenter needs to learn fiber-optic systems design, in addition to the kit, is a selection of common capacitors and resistors, typical hand tools, and initiative.”

AMP Inc., Harrisburg, Pa., 17105. Phone (717) 564-0100 [401]

Quickly readied modem makes good use of channels

The MPS 9601, the fastest member of the new MPS series of modulator-demodulators, uses a microprocessor-controlled digital equalizer and a high-speed training capability to provide a quick request-to-send/clear-to-send response time of 30 ms, even on unconditioned lines. The unit operates at a data transmission speed of 9,600 bits per second and is available with one to four ports.

Multiple-port versions of the mod-
em are equipped with an automatic port-allocation feature that distributes the full 9,600-b/s capability among the active ports. The primary port operates at full transmission speed until a secondary port is activated by a request to send from a terminal. When this occurs, the primary port's transmission rate is reduced to 7,200 b/s and the secondary port operates at 2,400 b/s.

Activation of additional secondary ports similarly decreases the primary port's transmission rate. When a secondary port becomes inactive, its channel capacity is reassigned to the primary port.

Both single- and multiple-port modems can be integrally configured with a port-sharing system that lets as many as four terminals share a single port sequentially. In multiport versions, this permits the user to dedicate one port to a high-priority terminal, which will always be able to access a data channel.

Other members of the microprocessor-based series are: the MPS 9269, a CCITT-V.29–compatible version of the MPS 9601; the MPS 7201, a 7,200 b/s modem with up to three ports; and the MPS 4801, with a transmission rate of 4,800 b/s and one or two ports. Limited quantities are available for 45-day delivery, the company says.

Racal-Milgo Inc., 8600 N.W. 41st St., Miami, Fla. 33166. Phone (305) 592-8600 [404]

**Optical system**

transmits TTL signals

The solutions that fiber-optic data-communications systems can offer to the problems of external interference on transmission lines and retention of data security has attracted the attention of many companies. Oelektron Corp. has now introduced such a system for use with transistor-transistor-logic devices.

The system comprises a transmitter, an optical cable, and a receiver. The transmitter converts a TTL-level signal to a light pulse using a light-emitting diode. The cable consists of a jacketed fiber-optic bundle with

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New products

subminax-27-series connectors. The receiver uses a positive-intrinsic-negative photodiode to reconvert the signal.

With pulse repetition rates to 20 MHz, the system can handle pulse widths as narrow as 15 ns. Both the transmitter and the receiver require a 5-V power supply, and the receiver puts out signals with a logic low of less than 0.5 V and a logic high between 4.5 V and the supply voltage. Cables with losses of less than 5 dB/km are available.

As a pair, the transmitter and receiver are priced at $1,295. Cables are priced at $2/m in lengths over 300 m. Systems are available for delivery in four to six weeks.

Olektron Corp., 6 Chase Ave., Dudley, Mass. 01570. Phone Joseph Oleksiak at (617) 943-7440 [403]

2-kW klystron amplifier offers digital tuning

Intended for use in digital troposcatter communications systems, the 4k5SL-3 is a four-cavity klystron amplifier that operates between 1.7 and 2.4 GHz. The tube can be digitally tuned to any frequency within its operating range by adjusting each cavity to the corresponding value provided on the chart that accompanies each tube.

At a frequency of 1.7 GHz, typical output power, gain, and 1-dB bandwidth are 2.1 kW, 40.2 dB, and 9 MHz, respectively. For the upper frequency limit, the typical values are 2.05 kW, 40.1 dB, and 10 MHz. Required input drive power for the amplifier is 200 mW.

Palo Alto Microwave Tube Division, Varian Associates, 611 Hansen Way, Palo Alto, Calif. 94303. Phone (415) 493-4000 [406]
Semiconductors

**I^2L chip handles fast functions**

Controller lets user scroll dot-character display or switch line for line

Using a proprietary process that combines high-speed Schottky transistor-transistor logic, dense integrated-injection logic, and linear bipolar devices on the same chip, the DP8350 cathode-ray-tube controller replaces not only the control logic portions handled by metal-oxide-semiconductor devices, but also high-speed logic functions such as dot logic. The controller puts an oscillator and complete timing, refresh, logic, and video control circuits in a single package, thus reducing the number of components needed in standard or custom terminal designs.

The unit's system-control input and character random-access memory are handled by a 12-bit bidirectional three-state bus and three on-chip 12-bit registers. The top-of-page register permits both display scrolling without external memory address adders and sequential addressing of the CRT memory.

Using the row-start register, memory can be addressed nonsequentially on a row-by-row basis. By changing the first address in each row, rows of characters can be swapped without rewriting the memory address in CRT random-access memory. The cursor register holds the present cursor address during changes.

An 11-line bus furnishes video and system output, including horizontal and vertical synchronization, vertical blanking, cursor enable, and all control signals for dot-character-generation circuits. An internal dot-rate oscillator controlled by an external 10.92-MHz crystal gives a dot time of 91.6 ns; character time is 641 ns.

The DP8350 supplies buffered dot-rate clock output and accepts dot-rate frequencies from the CRT system. It also accommodates special video-display attributes, such as blinking and underlining, from external circuits, as well as two refresh frequencies: 60 Hz, which gives 260 scan lines per frame, and 50 Hz, which provides 312 lines per frame.

The unit can be purchased in a standard configuration or mask-programmed for special designs. The standard configuration has a 5-by-7-dot matrix in a 7-by-10 field. The overall display format is 80 characters wide with 24 rows per frame.

When mask-programmed, the unit's basic architecture remains the same; the major video characteristics are altered by changing information contained in read-only-memory blocks on the chip. The user may specify character and field size up to 16 by 16 dots, the number of characters per row from 5 to 110, and the number of rows from 1 to 64—within the constraints of the frame refresh rate. Horizontal and vertical synchronization pulses, cursor-enable output, and vertical blanking output are also programmable to meet special requirements.

Available now in sample quantities, the standard DP8350 is priced at $49.

National Semiconductor Corp., 2900 Semiconductor Dr., Santa Clara, Calif. 95051.

Phone Don Tarver at (408) 737-5873 [411]

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**8-bit a-d converter has low price tag**

The μA9708—a monolithic 8-bit, 6-channel analog-to-digital converter for microprocessor-based data systems—offers 300-μs conversion time, built-in auto-zeroing, and can be calibrated at full scale. In plastic dual in-line packages, quantities of 100 or more are priced at $3.50 each.

The converter relies on a microprocessor system to provide the addressing, timing, counting, and arithmetic operations needed to implement a full conversion system. The unit is also available in a ceramic DIP priced at $4.35 in 100-and-up quantities. In either package, delivery is from stock.

Semiconductor Components Division, Fairchild Camera and Instrument Corp., 464 Ellis St., Mountain View, Calif. 94042. Phone (415) 962-3816 [414]

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**Driver buffers MOS circuits and gas-discharge panels**

Designed to act as a buffer between the output of metal-oxide-semiconductor devices and the anodes of a gas-discharge panel, the XR-2272 is made up of seven independent digit-driver sections in a single monolithic package. The driver can be paired with the XR-2771 segment-driver for a two-chip display-driver system.

The XR-2272 operates with supply voltages of up to 60 V, can be interfaced with Panaplex II displays, and is available in both plastic and ceramic 16-pin dual in-line packages. In quantities of 100 or more, the plastic-packaged unit is priced at 86¢ apiece.

Exar Integrated Systems Inc., P. O. Box 62229, Sunnyvale, Calif. 94086. Phone Brooks Hamilton at (408) 732-7970 [415]

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**Switching transistors extend safe-operating limit**

Designed to extend the turnoff safe operating areas for inductive switching applications, the GSTR120 and GSTR80 series consists of high-speed, high-power transistors of the triple-diffused npn type. The units are...
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**New products**

The GSTR120 series comprises three transistors, designated GSTR12030, 35, and 40, which have peak collector-to-emitter voltages of 300, 350, and 400 V, respectively. The series is rated for a continuous collector current of 16 A and a peak current of 25 A. Collector saturation voltage is 0.8 V.

The three members of the GSTR80 series, the 35, 40, and 45, are offered with peak collector-to-emitter voltages of 350, 400, and 450 V, respectively. Their continuous collector current rating is 12 A, and their peak rating is 20 A. This series' collector saturation voltage is the same as that of the GSTR120 units.

The GSTR120 series is expected to replace 2N6546 and 2N6547 transistors; the GSTR80 series offers improved circuit performance in applications that have employed 2N6582, 83, and 84 units. In quantities of 100 or more the GSTR120 series ranges in price from $9.90 each for the 300-v device to $13.20 apiece for the 400-v unit. Price range for the GSTR80 in similar quantities is $7.90 (350 v) to $11.20 (450 v). Delivery is from stock to four weeks.

General Semiconductor Industries Inc., P.O. Box 3078, Tempe, Ariz. 85281. Phone Jim Williams at (602) 968-3101 [416]

**Bigger package brings transistor cost down**

The AT-4641, -4642, -4680, and -4690 are small-signal bipolar microwave transistors that provide the same specifications as earlier versions that were offered in 70-mil square ceramic-metal packages. But by placing these units in 100-mil² packages, the manufacturer is able to realize savings in assembly costs that result in prices 30% lower than...
those for the 70-mil² transistors.

The AT-4641 has a typical noise figure of 3.0 dB at 4 GHz, with an associated gain of 7.5 dB; its maximum available gain is 9.5 dB. The AT-4642 is a lower-cost version of the AT-4641.

For the AT-4680, the typical noise figure is 2.6 dB at 4 GHz, with 8.8 dB of associated gain; the maximum available gain is 12 dB. The AT-4690 has a noise figure of 2.8 dB, and over the collector-current range from 2.5 to 20 mA, that figure changes by only 0.8 dB.

The new microwave transistors can be purchased burned in and screened according to MIL-STD-750 procedures.

Avantek Inc., 3175 Bowers Ave., Santa Clara, Calif. 95051. Phone (408) 249-0700 [417]

Video output transistors withstand CRT arcing

The MDS20 and MDS21 high-voltage power transistors combine a 60-MHz current-gain-bandwidth product with the ability to withstand cathode-ray-tube arcing currents. Gain for the transistors at 30 mA is a minimum of 40 and is linear from 1 to 40 mA. The MDS20 is rated for a collector-emitter breakdown voltage of 250 V; the MDS21 is rated for 300 V. Collector-base capacitance is a maximum of 3.0 pF.

In quantities of 100 and up, the MDS20 is priced at 50¢ and the MDS21 at 55¢. Both are available from stock.

Motorola Semiconductor Products Inc., P. O. Box 20912, Phoenix, Ariz. 85036 [418]
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New products

Data handling
IQ rises for data terminals

Trio of stand-alone units built around LSI-11 can control other terminals

With data terminals increasingly incorporating microcomputers, their traditional input/output role is being redefined to include stand-alone computing capability. One of the latest examples of this trend is the PDT-11 terminal family that was a big attraction at last month's National Computer Conference [Electronics, June 8, p. 36]. All three entries in the Digital Equipment Corp. family are built around the 16-bit LSI-11 microcomputer. Two of them—the PDT-11/110 and PDT-11/130—incorporate a new video display announced with the family, the VT100. The third unit, the PDT-11/150, comes with a choice of video display or printer.

The 130 has twin magnetic-tape storage units; the 150 has single or dual floppy-disk storage. The 110 has the family's basic 16,384 bytes of local metal-oxide-semiconductor memory, but it is expandable to the 130's 32 kilobytes, and both are expandable to the 150's 60-kilobyte maximum.

The terminals are sold with RTT, a run-time version of DEC's RT-11 operating system. All three units use the instruction set of DEC's PDP-11 minicomputers, permitting programs developed for the terminals to run on a PDP-11, or vice versa. "Each terminal has the power to do stand-alone jobs that previously required full computer systems," says Andrew C. Knowles, DEC's corporate vice president for marketing, "and each has the ability to drive three other unintelligent terminals, forming a system of their own."

The VT100 cathode-ray tube display introduced with the family sells by itself as a video terminal for $1,900 singly or $1,230 in quantities of 100. It has a detachable keyboard with as much as 132 columns of double-width and double-height characters and includes reverse video, blinking, and underlining.

Knowles regards terminals like these—the first terminals designed to be compatible with the PDP-11 computer line—as representing the minicomputer packaging technology of the future. "They'll become almost like commodities, and a minimum entry into small-business systems," he predicts. He also looks for them to become central elements in word-processing systems.

The PDT-11/110's price is $3,900 singly or $2,890 each in quantities of 100. For the PDT-11/130, those same prices are $5,000 and $3,677, and the PDT-11/150 will sell for $6,325 singly or $4,322 in hundreds. Volume deliveries will begin this fall.


Level 6 line gets new top and bottom models

Minicomputer users are often concerned with the physical size of the
computers they buy and with the units' software compatibility with more powerful computers—concerns addressed by the model 23, the new entry-level unit in the Level 6 mini-computer line.

The rack-mountable model 23 has its central processing unit on a single full-width printed-circuit board, with 10 half-width card slots provided in the 5½-in.-high card cage for memory or input/output cards. A basic model 23 configuration that includes 64 kilobytes of main memory, a single diskette drive and a cathode-ray-tube terminal is priced at $13,500.

Main memory can be expanded to 128 kilobytes, and other peripherals such as matrix and line printers, are also available. The model 23 uses the same software that the larger model 33 uses and is software-compatible with the entire Level 6 line, Honeywell says.

On the other hand, the new top-of-the-line model 57 is a Cobol-oriented multiprocessor machine with 8 kilobytes of cache memory that can support 32 kilobytes to 2 megabytes of main memory. It comes with a commercial-instruction processor, and, for users who want it to handle Fortran programs, it can accept an optional scientific-instruction processor.

A basic model 57 configuration with 256 kilobytes of main memory, a 67-megabyte disk drive, a tape drive, and a cathode-ray-tube display is priced at $127,000. First deliveries of the model 57 are scheduled for September; the model 23 is available immediately.

Honeywell Information Systems, 200 Smith St., Waltham, Mass. 02154. Phone (617) 890-8400 [363]

32-bit mini priced and packaged for OEMs

Original-equipment manufacturers who have outgrown the performance of 16-bit minicomputers can now upgrade to the 32-bit performance of the SEL 32/30. Although similar in performance to the SEL 32/35, the new unit uses 16-K dynamic random-access memories instead of core memory and multilayer printed-circuit boards instead of wrapped-wire boards for packaging efficiencies that allow the computer and as much as 1 megabyte of main memory to fit into a rack-mountable cabinet that is 1¾ in. high.

Floating-point arithmetic firmware is standard, and the memory includes error-detection-and-correc-
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New products

Okidata Winchester disks available up to 80 megabytes

With the introduction of an 80-megabyte unit, Okidata has expanded the capacity of its 3300 series of Winchester disk drives. Starting with a 13.47-megabyte unit priced at $2,460 in OEM quantities, the 3300 series now includes units with 26.94, 40.39, 53.86, 67.33, and 80.80 megabytes of storage. Average access time is 38 ms, and
Operating system

The new Naked Mini operating system is a disk-based single-user program development system that employs a common real-time executive and file manager and is said to simplify software development for original-equipment manufacturers. Supplied in object-code format on diskettes, the operating system, including a source editor, macro assembler, Pascal compiler, and linking and debugging modules, is priced at $2,000. Deliveries have started.

Computer Automatic, 18651 Von Karman, Irvine, Calif. 92713. Phone (714) 833-9830 [366]

Microfloppy disk drives add dual sides and densities

The increased storage capacities afforded floppy-disk-drive makers through the use of modified frequency-modulated recording schemes and the use of both sides of the diskette are now being applied to the smaller members of the floppy-disk family. An example is Pertec's FD200 Microfloppy, which can store up to 437,500 bytes on a single 5.25-in. diskette.

Offering hard or soft sectoring and write protection as standard features, the drive is priced at $325 in quantities of 100 and up.
Pertec Computer Corp., Pertec Division, 9600 Irontdale Ave., Chatsworth, Calif. 91311. Phone (213) 882-9222 [367]

Wangco 5.25-in. floppy offers dual heads, densities

Using the dual-density, dual-sided techniques of its big-brother 8-in. floppy-disk drive, Wangco's 5.25-in. model 282 diskette drive can store 437.5 kilobytes of unformatted data at a rate of 125,000 bits per second.

In quantities of 1,000 or more, the model 282 is priced at $317.
Perkin-Elmer Corp., Wangco Division, 5404 Jandy Pl., Los Angeles, Calif. 90066. Phone Dave Andersen at (213) 390-8081 [368]
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Products newsletter

Semicustom bipolar chips due from MOS semicustom supplier

International Microcircuits Inc., a Santa Clara, Calif., complementary-MOS specialist, is offering a bipolar, semicustom analog integrated circuit. Called Omnichip I, the IC can be used for gain-control, analog-switching, and current-source applications. Built on an 85-by-114-mil die, the chip contains 400 components, including a pair of high-current npn transistors. The 24-pin chip design is developed by the user from a linear parts kit. Price for the first 50 prototypes is $3,150.

Probes added to logic analyzer

To support its new 532 intelligent logic-state analyzer, Paratronics Inc. is coming out with four probe accessories in the coming months. One is a dedicated probe for the 8085 and 8086 microprocessors that clips right onto the processor package. The San Jose, Calif., company will also offer a RS-232-C interface monitoring probe and a 10-ns glitch-capture probe capable of highlighting the word area following a glitch. In addition, there will be an IEEE-488 bus probe for monitoring bus transactions.

U. S. firm to sell power supplies from Japan

Semiconductor Circuits Inc., the Haverhill, Mass., manufacturer of power supplies, and Tohritz Tsushim Kogyo Co. of Japan have entered into an agreement that makes SCI the exclusive marketing agent for several series of Tohritsu's line of switching power supplies. Tohritsu, one of Japan's leading manufacturers of line switchers, will furnish SCI with 75- and 150-W supplies. The agreement enables SCI to broaden the power spectrum of its existing product line, which now reaches to 76 W for switchers. Meanwhile, the U. S. firm will continue to develop its own in-house products in the under-100-W category.

Data concentrator gets option to switch data rates

Autobaud, a feature that allows data-communications channel data rates to be established dynamically at the beginning of a dial-up call, is now available for the Micro800 Data Concentrator produced by Micom Systems Inc., Chatsworth, Calif. Since the feature eliminates the need to dedicate concentrator ports to a variety of different terminal speeds, it should have appeal for use in timesharing systems. Terminals equipped with the Bell 212 modem, for instance, will be able to dial in to any Micro800 port whether the concentrator is operating at 110, 300, or 1200 b/s. Price for a Micro800 with eight Autobaud channels is $3,900.

Option improves automatic testing

To provide a more efficient automatic test equipment system, Interstate Electronics Corp., Anaheim, Calif., has added a burst-count option to its SPG-800 programmable generator. The option allows a selected number of test cycles from 1 to 19,999 and is well suited for testing shift registers, memories, counters, and other logic circuits. Coupled with the SPG-800, the burst-count option is also useful for frequency-response testing of digital-to-analog converter circuits.

Siemens disk testers to get U. S. source

Three Phoenix Co. of Phoenix, and Siemens AG's U. S. subsidiary, Siemens Corp., Cherry Hill, N. J., have signed an agreement under which the Arizona firm will manufacture hard-disk memory testers for Siemens, including the West German company's own proprietary types. Siemens will serve as distributor in the U. S. and certain overseas countries.
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New literature

Standards. The Electronic Industries
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and a revised standard. RS-195-B,
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teristics for Terrestrial Microwave
Relay System Antennas and Passive
Reflectors," the new one, empha-
sizes devices operating above 890
megahertz. It includes antenna
windload data and Federal Commu-
nications Commission standards for
radiation patterns. The revised stan-
dard, "Measurement of Direct Inter-
electrode Capacitances of Electron
Tubes," RS-191-C, defines three
standard measurement methods for
use from 1 to 500 kilohertz. The
standards sell for $8 and $4.75 per
copy, respectively. Standards Sales
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quency, and frequency-to-voltage converters; sample-and-hold amplifiers; data-acquisition subsystems; and temperature transducers. Detailed specifications and prices are given. Analog Devices Inc., Route 1 Industrial Park, P.O. Box 280, Norwood, Mass. 02062. Circle reader service number 423.

Time-delay technology. For the experienced control designer, "Solid State Time-Delay Technology," a 48-page handbook, provides information on time-delay devices—both electronic and other. For engineers inexperienced in this technology, it explains what the devices are, how they work, and how to evaluate their performance. Several companies' solid-state time-delay techniques are explained. In addition, electromechanical, electrothermal, and electronic types of time-delay devices are reviewed. Other sections cover parameters and characteristics of time-delay relays. Several pages are devoted to solid-state time-delay relays, selection criteria, and illustrations. To obtain a free copy of this handbook, request it on company letterhead. Amerace Corp., Control Products Division, 2330 Vauxhall Rd., Union, N.J. 07083

Power devices. More than 1,200 solid-state power devices are covered in a 72-page catalog. It summarizes the characteristics of, and provides package information on, power transistors, power hybrid circuits, diacs, triacs, and silicon controlled rectifiers. It also lists the titles of all available application notes on RCA power devices. RCA Corp. Solid State Division, Box 3200, Somerville, N.J. 08876 [426]
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156 Electronics / July 6, 1978
Norden, at 50, is feisty again

New emphasis on systems, focus on military work only.
and exclusive minicomputer license lead to resurgence

by Bruce LeBoss, New York bureau manager

For Norden Systems Inc., life is beginning again at 50. The principal electronics subsidiary of United Technologies Corp., the once moribund firm is bursting with activity as it celebrates its golden jubilee year. And as you'll see, there are several reasons why. You can celebrate for yourself and your company.

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In February 1976, DEC licensed Norden to militarize a minicomputer. The company had developed a standard computer and license the hardware/software to the military. This led to the development of a new family of high-performance minicomputers, the PDP-11 series.

Norden is now a major player in the minicomputer market and is marketing its products through an extensive network of dealers and distributors. The company has also developed a line of microprocessor-based systems, which are being marketed to a wide variety of customers.

Norden is planning to expand its operations even further in the near future. The company is looking at new markets and is developing new products to meet the needs of its customers. Norden is also looking at ways to increase its production capabilities and to improve its existing systems.

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Electronics/July 6, 1978

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